

ST72104G, ST72215G, ST72216G, ST72254G

8-BIT MCU WITH SINGLE VOLTAGE FLASH MEMORY, ADC, 16-BIT TIMERS, SPI, I²C INTERFACES

PRELIMINARY DATA

Memories

- 4K or 8K bytes Program memory (ROM and single voltage FLASH) with read-out protection and in-situ programming (remote ISP)
- 256 bytes RAM

■ Clock, Reset and Supply Management

- Enhanced reset system
- Enhanced low voltage supply supervisor with 3 programmable levels
- Clock sources: crystal/ceramic resonator oscillators or RC oscillators, external clock, backup Clock Security System
- Clock-out capability
- 3 Power Saving Modes: Halt, Wait and Slow

■ Interrupt Management

- 7 interrupt vectors plus TRAP and RESET
- 22 external interrupt lines (on 2 vectors)

22 I/O Ports

- 22 multifunctional bidirectional I/O lines
- 14 alternate function lines
- 8 high sink outputs

■ 3 Timers

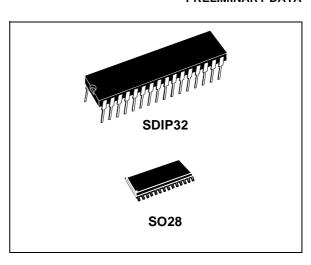
- Configurable watchdog timer
- Two 16-bit timers with: 2 input captures, 2 output compares, external clock input on one timer, PWM and Pulse generator modes (one only on ST72104Gx and ST72216G1)

■ 2 Communications Interfaces

- SPI synchronous serial interface
- I2C multimaster interface (only on ST72254Gx)

1 Analog peripheral

 8-bit ADC with 6 input channels (except on ST72104Gx)



■ Instruction Set

- 8-bit data manipulation
- 63 basic instructions
- 17 main addressing modes
- 8 x 8 unsigned multiply instruction
- True bit manipulation

■ Development Tools

- Full hardware/software development package

Device Summary

Features	ST72104G1	ST72104G2	ST72216G1	ST72215G2	ST72254G1	ST72254G2			
Program memory - bytes	4K	8K	4K	8K	4K	8K			
RAM (stack) - bytes			256	(128)	<u> </u>				
Peripherals	Watchdog timer, One 16-bit timer, SPI		Watchdog timer, One 16-bit timer, SPI, ADC	One 16-bit timer, Two 16-bit timers,		Watchdog timer, Two 16-bit timers, SPI, I ² C, ADC			
Operating Supply			3.2V t	o 5.5 V					
CPU Frequency				cillator up to 16 MH	,				
Operating Temperature	0°C to	70°C / -10°C to +8	35°C (-40°C to +85°	°C / -40°C to105°C /	-40°C to 125°C o	otional)			
Packages			SO28 /	SDIP32					

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1 INTRODUCTION

The ST72104G, ST72215G, ST72216G and ST72254G devices are members of the ST7 microcontroller family. They can be grouped as follows:

- ST72254G devices are designed for mid-range applications with ADC and I²C interface capabilities.
- ST72215/6G devices target the same range of applications but without I²C interface.
- ST72104G devices are for applications that do not need ADC and I²C peripherals.

All devices are based on a common industrystandard 8-bit core, featuring an enhanced instruction set.

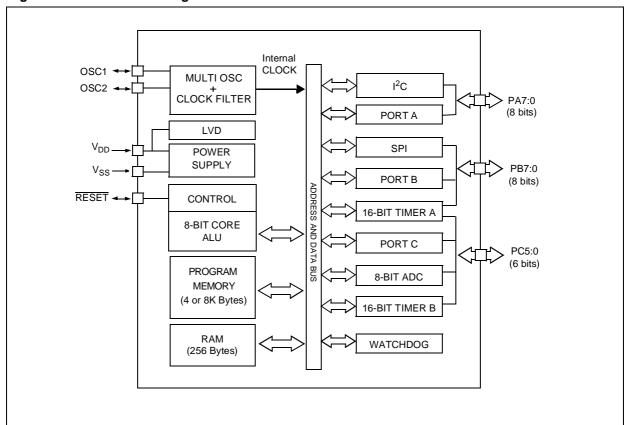
The ST72C104G, ST72C215G, ST72C216G and ST72C254G versions feature single-voltage FLASH memory with byte-by-byte In-Situ Programming (ISP) capability.

Under software control, all devices can be placed in WAIT, SLOW, or HALT mode, reducing power consumption when the application is in idle or stand-by state.

The enhanced instruction set and addressing modes of the ST7 offer both power and flexibility to software developers, enabling the design of highly efficient and compact application code. In addition to standard 8-bit data management, all ST7 microcontrollers feature true bit manipulation, 8x8 unsigned multiplication and indirect addressing modes.

For easy reference, all parametric data are located in Section 14 on page 96.

Figure 1. General Block Diagram



2 PIN DESCRIPTION

Figure 2. 28-Pin SO Package Pinout

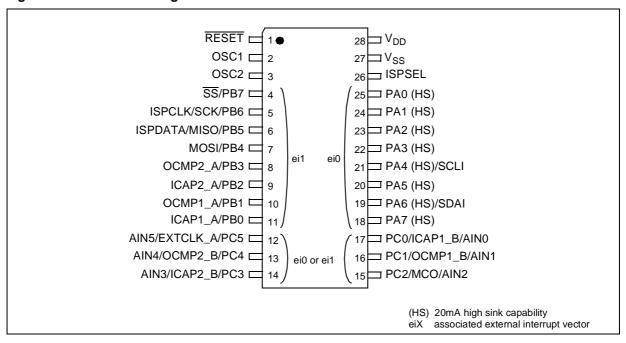
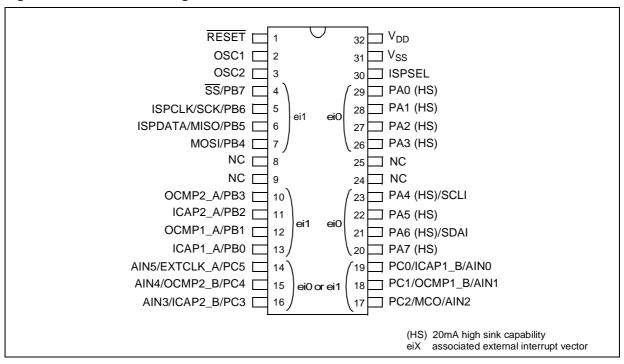


Figure 3. 32-Pin SDIP Package Pinout



PIN DESCRIPTION (Cont'd)

For external pin connection guidelines, refer to Section 14 "ELECTRICAL CHARACTERISTICS" on page 96.

Legend / Abbreviations for Table 1:

Type: I = input, O = output, S = supplyInput level: A = Dedicated analog input In/Output level: $C = CMOS \ 0.3V_{DD}/0.7V_{DD}$, $C_{T} = CMOS \ 0.3V_{DD}/0.7V_{DD}$ with input trigger

HS = 20mA high sink (on N-buffer only) Output level:

Port and control configuration:

float = floating, wpu = weak pull-up, int = interrupt 1), ana = analog – Input:

 $OD = open drain^{2}$, PP = push-pull- Output:

Refer to Section 10 "I/O PORTS" on page 30 for more details on the software configuration of the I/O ports.

The RESET configuration of each pin is shown in bold. This configuration is valid as long as the device is in reset state.

Table 1. Device Pin Description

Pin	n°			Le	vel		Por	rt / C	Cont	rol		Main	
32	28	Pin Name	Туре	Ħ	out		Inp	ut		Out	put	Function	Alternate Function
SDIP32	8028		-	Input	Output	float	ndw	int	ana	ОО	Ъ	(after reset)	
1	1	RESET	I/O	C_T			Х			Х		Top priority no	n maskable interrupt (active low)
2	2	OSC1 3)	I										input or Resonator oscillator in- resistor input for RC oscillator
3	3	OSC2 ³⁾	0									Resonator oso tor input for RO	cillator inverter output or capaci- C oscillator
4	4	PB7/SS	I/O	0	T	X	ei	1		Х	Х	Port B7	SPI Slave Select (active low)
5	5	PB6/SCK/ISPCLK	I/O	(C _T	Х	ei	1		Х	Х	Port B6	SPI Serial Clock or ISP Clock
6	6	PB5/MISO/ISPDATA	I/O	C	C _T X		X ei1			Х	Х	Port B5	SPI Master In/ Slave Out Data or ISP Data
7	7	PB4/MOSI	I/O	(C _T	Х	ei	1		Х	Х	Port B4	SPI Master Out / Slave In Data
8		NC		•		•					Not	Connected	
9		NC									1401	Connected	
10	8	PB3/OCMP2_A	I/O	C	C _T	Х	ei	1		Х	Х	Port B3	Timer A Output Compare 2
11	9	PB2/ICAP2_A	I/O	C	Σ _T	Х	ei	1		Х	Х	Port B2	Timer A Input Capture 2
12	10	PB1 /OCMP1_A	I/O	C	Σ _T	Х	ei	1		Х	Х	Port B1	Timer A Output Compare 1
13	11	PB0 /ICAP1_A	I/O	C	C _T	Х	ei	1		Х	Х	Port B0	Timer A Input Capture 1
14	12	PC5/EXTCLK_A/AIN5	I/O	C	Ç _T	Х	ei0/	ei1		Х	Х	Port C5 Timer A Input Clock or ADC Analog Input 5	
15	13	PC4/OCMP2_B/AIN4	I/O	C	Ç _T	Х	ei0/	ei1		Х	Х	Port C4 Timer B Output Compare 2 ADC Analog Input 4	
16	14	PC3/ ICAP2_B/AIN3	I/O	C	Ъτ	Х	ei0/	ei1	X	Х	Х	Port C3	Timer B Input Capture 2 or ADC Analog Input 3

Pin	n°			Le	vel		Ро	rt / C	ont	rol		B# - !			
32	8	Pin Name	Туре	Ħ	ut		Inj	out		Out	tput	Main Function	Alternate Function		
SDIP32	SO28		F	Input	Output	float	mdw	int	ana	ОО	ЬР	(after reset)			
17	15	PC2/MCO/AIN2	I/O	C	Ст	Х	ei0	/ei1	Χ	Х	Х	Port C2	Main clock output (f _{CPU}) or ADC Analog Input 2		
18	16	PC1/OCMP1_B/AIN1	I/O	C	Ç _T	Х	ei0	/ei1	Χ	Х	Х	Port C1	Timer B Output Compare 1 or ADC Analog Input 1		
19	17	PC0/ICAP1_B/AIN0	I/O	C	C _T	X	ei0	/ei1	Χ	Х	Х	Port C0	Timer B Input Capture 1 or ADC Analog Input 0		
20	18	PA7	I/O	Ст	HS	Х	е	i0		Χ	Х	Port A7			
21	19	PA6 /SDAI	I/O	C_{T}	HS	Х		ei0		Т		Port A6	I ² C Data		
22	20	PA5	I/O	Ст	HS	Х	е	i0		Χ	Х	Port A5			
23	21	PA4 /SCLI	I/O	C_T	HS	Х		ei0		Т		Port A4	I ² C Clock		
24		NC				ı					No	t Connected			
25		NC									INO	Connected			
26	22	PA3	I/O	C_T	HS	Х	е	i0		Χ	Х	Port A3			
27	23	PA2	I/O	C_{T}	HS	Х	е	i0		Χ	Χ	Port A2			
28	24	PA1	I/O	C_T	HS	Х	е	i0		Х	Χ	Port A1			
29	25	PA0	I/O	C_T	HS	Х	е	i0		Х	Х	Port A0			
30	26	ISPSEL	I	С		х						In situ programming selection (Should be tied low in standard user mode).			
31	27	V _{SS}	S									Ground			
32	28	V_{DD}	S									Main power su	ıpply		

Notes:

- 1. In the interrupt input column, "eiX" defines the associated external interrupt vector. If the weak pull-up column (wpu) is merged with the interrupt column (int), then the I/O configuration is pull-up interrupt input, else the configuration is floating interrupt input.
- 2. In the open drain output column, "T" defines a true open drain I/O (P-Buffer and protection diode to V_{DD} are not implemented). See Section 10 "I/O PORTS" on page 30 and Section 14.8 "I/O PORT PIN CHARACTERISTICS" on page 118 for more details.
- 3. OSC1 and OSC2 pins connect a crystal or ceramic resonator, an external RC, or an external source to the on-chip oscillator see Section 2 "PIN DESCRIPTION" on page 7 and Section 14.5 "CLOCK AND TIMING CHARACTERISTICS" on page 105 for more details.

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3 REGISTER & MEMORY MAP

As shown in the Figure 4, the MCU is capable of addressing 64K bytes of memories and I/O registers.

The available memory locations consist of 128 bytes of register location, 256 bytes of RAM and up to 8Kbytes of user program memory. The RAM space includes up to 128 bytes for the stack from 0100h to 017Fh.

The highest address bytes contain the user reset and interrupt vectors.

IMPORTANT: Memory locations marked as "Reserved" must never be accessed. Accessing a reserved area can have unpredictable effects on the device.

Figure 4. Memory Map

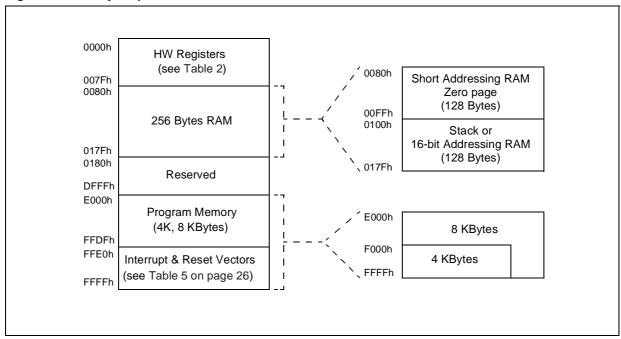


Table 2. Hardware Register Map

Address	Block	Register Label	Register Name	Reset Status	Remarks		
0000h 0001h 0002h	Port C	PCDR PCDDR PCOR	Port C Data Register Port C Data Direction Register Port C Option Register	00h ¹⁾ 00h 00h	R/W ²⁾ R/W ²⁾ R/W ²⁾		
0003h			Reserved (1 Byte)				
0004h 0005h 0006h	Port B	PBDR PBDDR PBOR	Port B Data Register Port B Data Direction Register Port B Option Register	00h ¹⁾ 00h 00h	R/W R/W R/W.		
0007h		1	Reserved (1 Byte)				
0008h 0009h 000Ah	Port A	PADR PADDR PAOR	Port A Data Register Port A Data Direction Register Port A Option Register		R/W R/W R/W		
000Bh to 001Fh	Reserved (21 Bytes)						
0020h		MISCR1	Miscellaneous Register 1	00h	R/W		
0021h 0022h 0023h	SPI	SPIDR SPICR SPISR	SPI Data I/O Register SPI Control Register SPI Status Register	xxh 0xh 00h	R/W R/W Read Only		
0024h	WATCHDOG	WDGCR	Watchdog Control Register	7Fh	R/W		
0025h		CRSR	Clock, Reset, Supply Control / Status Register	000x 000x	R/W		
0026h 0027h			Reserved (2 bytes)				
0028h 0029h 002Ah 002Bh 002Ch 002Dh 002Eh	l ² C	I2CCR I2CSR1 I2CSR2 I2CCCR I2COAR1 I2COAR2 I2CDR	Control Register Status Register 1 Status Register 2 Clock Control Register Own Address Register 1 Own Address Register 2 Data Register	00h 00h 00h 00h 00h 00h	R/W Read Only Read Only R/W R/W R/W		
002Fh to 0030h		1	Reserved (4 Bytes)				

Address	Block	Register Label	Register Name	Reset Status	Remarks
0031h		TACR2	Timer A Control Register 2	00h	R/W
0032h		TACR1	Timer A Control Register 1	00h	R/W
0033h		TASR	Timer A Status Register	xxh	Read Only
0034h		TAIC1HR	Timer A Input Capture 1 High Register	xxh	Read Only
0035h		TAIC1LR	Timer A Input Capture 1 Low Register	xxh	Read Only
0036h		TAOC1HR	Timer A Output Compare 1 High Register	80h	R/W
0037h		TAOC1LR	Timer A Output Compare 1 Low Register	00h	R/W
0038h	TIMER A	TACHR	Timer A Counter High Register	FFh	Read Only
0039h		TACLR	Timer A Counter Low Register	FCh	Read Only
003Ah		TAACHR	Timer A Alternate Counter High Register	FFh	Read Only
003Bh		TAACLR	Timer A Alternate Counter Low Register	FCh	Read Only
003Ch		TAIC2HR	Timer A Input Capture 2 High Register	xxh	Read Only
003Dh		TAIC2LR	Timer A Input Capture 2 Low Register	xxh	Read Only
003Eh		TAOC2HR	Timer A Output Compare 2 High Register	80h	R/W
003Fh		TAOC2LR	Timer A Output Compare 2 Low Register	00h	R/W
0040h		MISCR2	Miscellaneous Register 2	00h	R/W
0041h		TBCR2	Timer B Control Register 2	00h	R/W
0042h		TBCR1	Timer B Control Register 1	00h	R/W
0043h		TBSR	Timer B Status Register	xxh	Read Only
0044h		TBIC1HR	Timer B Input Capture 1 High Register	xxh	Read Only
0045h		TBIC1LR	Timer B Input Capture 1 Low Register	xxh	Read Only
0046h		TBOC1HR	Timer B Output Compare 1 High Register	80h	R/W
0047h	TIMED D	TBOC1LR	Timer B Output Compare 1 Low Register	00h	R/W
0048h	TIMER B	TBCHR	Timer B Counter High Register	FFh	Read Only
0049h		TBCLR	Timer B Counter Low Register	FCh FFh	Read Only
004Ah		TBACHR TBACLR	Timer B Alternate Counter High Register Timer B Alternate Counter Low Register	FFN FCh	Read Only Read Only
004Bh 004Ch		TBIC2HR		_	
004Ch 004Dh		TBIC2HR	Timer B Input Capture 2 High Register Timer B Input Capture 2 Low Register	xxh xxh	Read Only Read Only
004Dh 004Eh		TBOC2HR	Timer B Output Compare 2 High Register	80h	R/W
004E11		TBOC2HR TBOC2LR	Timer B Output Compare 2 Low Register	00h	R/W
0050h					
to			Reserved (32 Bytes)		
006Fh					
0070h	ADC	ADCDR	Data Register	00h	Read Only
0071h	ADC	ADCCSR	Control/Status Register	00h	R/W
0072h to 007Fh		•	Reserved (14 Bytes)		•

Legend: x=undefined, R/W=read/write

Notes:

^{1.} The contents of the I/O port DR registers are readable only in output configuration. In input configuration, the values of the I/O pins are returned instead of the DR register contents.

^{2.} The bits associated with unavailable pins must always keep their reset value.

4 FLASH PROGRAM MEMORY

4.1 INTRODUCTION

FLASH devices have a single voltage non-volatile FLASH memory that may be programmed in-situ (or plugged in a programming tool) on a byte-bybyte basis.

4.2 MAIN FEATURES

- Remote In-Situ Programming (ISP) mode
- Up to 16 bytes programmed in the same cycle
- MTP memory (Multiple Time Programmable)
- Read-out memory protection against piracy

4.3 STRUCTURAL ORGANISATION

The FLASH program memory is organised in a single 8-bit wide memory block which can be used for storing both code and data constants.

The FLASH program memory is mapped in the upper part of the ST7 addressing space and includes the reset and interrupt user vector area.

4.4 IN-SITU PROGRAMMING (ISP) MODE

The FLASH program memory can be programmed using Remote ISP mode. This ISP mode allows the contents of the ST7 program memory to be updated using a standard ST7 programming tools after the device is mounted on the application board. This feature can be implemented with a minimum number of added components and board area impact.

An example Remote ISP hardware interface to the standard ST7 programming tool is described below. For more details on ISP programming, refer to the ST7 Programming Specification.

Remote ISP Overview

The Remote ISP mode is initiated by a specific sequence on the dedicated ISPSEL pin.

The Remote ISP is performed in three steps:

- Selection of the RAM execution mode
- Download of Remote ISP code in RAM
- Execution of Remote ISP code in RAM to program the user program into the FLASH

Remote ISP hardware configuration

In Remote ISP mode, the ST7 has to be supplied with power (V_{DD} and V_{SS}) and a clock signal (oscillator and application crystal circuit for example).

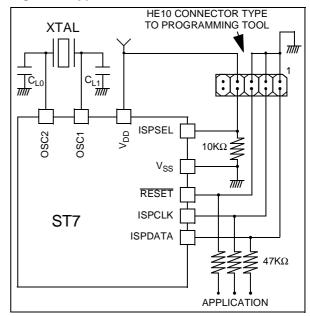
This mode needs five signals (plus the V_{DD} signal if necessary) to be connected to the programming tool. This signals are:

- RESET: device reset
- V_{SS}: device ground power supply
- ISPCLK: ISP output serial clock pin
- ISPDATA: ISP input serial data pin
- ISPSEL: Remote ISP mode selection. This pin must be connected to $\rm V_{SS}$ on the application board through a pull-down resistor.

If any of these pins are used for other purposes on the application, a serial resistor has to be implemented to avoid a conflict if the other device forces the signal level.

Figure 5 shows a typical hardware interface to a standard ST7 programming tool. For more details on the pin locations, refer to the device pinout description.

Figure 5. Typical Remote ISP Interface



4.5 MEMORY READ-OUT PROTECTION

The read-out protection is enabled through an option bit.

For FLASH devices, when this option is selected, the program and data stored in the FLASH memory are protected against read-out piracy (including a re-write protection). When this protection option is removed the entire FLASH program memory is first automatically erased. However, the E²PROM data memory (when available) can be protected only with ROM devices.

5 CENTRAL PROCESSING UNIT

5.1 INTRODUCTION

This CPU has a full 8-bit architecture and contains six internal registers allowing efficient 8-bit data manipulation.

5.2 MAIN FEATURES

- 63 basic instructions
- Fast 8-bit by 8-bit multiply
- 17 main addressing modes
- Two 8-bit index registers
- 16-bit stack pointer
- Low power modes
- Maskable hardware interrupts
- Non-maskable software interrupt

5.3 CPU REGISTERS

The 6 CPU registers shown in Figure 1 are not present in the memory mapping and are accessed by specific instructions.

Accumulator (A)

The Accumulator is an 8-bit general purpose register used to hold operands and the results of the arithmetic and logic calculations and to manipulate data

Index Registers (X and Y)

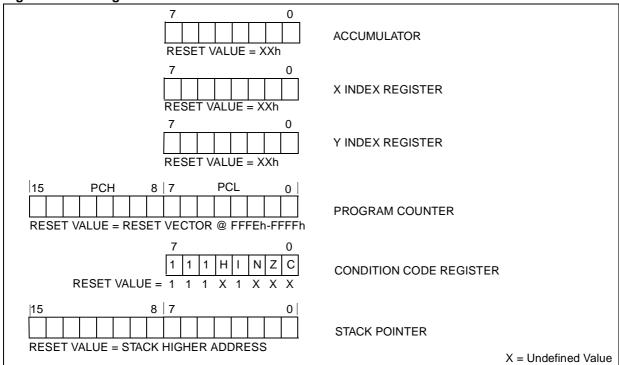
In indexed addressing modes, these 8-bit registers are used to create either effective addresses or temporary storage areas for data manipulation. (The Cross-Assembler generates a precede instruction (PRE) to indicate that the following instruction refers to the Y register.)

The Y register is not affected by the interrupt automatic procedures (not pushed to and popped from the stack).

Program Counter (PC)

The program counter is a 16-bit register containing the address of the next instruction to be executed by the CPU. It is made of two 8-bit registers PCL (Program Counter Low which is the LSB) and PCH (Program Counter High which is the MSB).

Figure 6. CPU Registers



CPU REGISTERS (Cont'd) CONDITION CODE REGISTER (CC)

Read/Write

Reset Value: 111x1xxx

7							0
1	1	1	н	Ι	Ν	Z	С

The 8-bit Condition Code register contains the interrupt mask and four flags representative of the result of the instruction just executed. This register can also be handled by the PUSH and POP instructions.

These bits can be individually tested and/or controlled by specific instructions.

Bit 4 = **H** Half carry.

This bit is set by hardware when a carry occurs between bits 3 and 4 of the ALU during an ADD or ADC instruction. It is reset by hardware during the same instructions.

- 0: No half carry has occurred.
- 1: A half carry has occurred.

This bit is tested using the JRH or JRNH instruction. The H bit is useful in BCD arithmetic subroutines.

Bit 3 = I Interrupt mask.

This bit is set by hardware when entering in interrupt or by software to disable all interrupts except the TRAP software interrupt. This bit is cleared by software.

- 0: Interrupts are enabled.
- 1: Interrupts are disabled.

This bit is controlled by the RIM, SIM and IRET instructions and is tested by the JRM and JRNM instructions.

Note: Interrupts requested while I is set are latched and can be processed when I is cleared. By default an interrupt routine is not interruptable

because the I bit is set by hardware at the start of the routine and reset by the IRET instruction at the end of the routine. If the I bit is cleared by software in the interrupt routine, pending interrupts are serviced regardless of the priority level of the current interrupt routine.

Bit 2 = N Negative.

This bit is set and cleared by hardware. It is representative of the result sign of the last arithmetic, logical or data manipulation. It is a copy of the 7th bit of the result.

- 0: The result of the last operation is positive or null.
- 1: The result of the last operation is negative (i.e. the most significant bit is a logic 1).

This bit is accessed by the JRMI and JRPL instructions.

Bit $1 = \mathbf{Z} Zero$.

This bit is set and cleared by hardware. This bit indicates that the result of the last arithmetic, logical or data manipulation is zero.

- 0: The result of the last operation is different from zero.
- 1: The result of the last operation is zero.

This bit is accessed by the JREQ and JRNE test instructions.

Bit 0 = **C** Carry/borrow.

This bit is set and cleared by hardware and software. It indicates an overflow or an underflow has occurred during the last arithmetic operation.

- 0: No overflow or underflow has occurred.
- 1: An overflow or underflow has occurred.

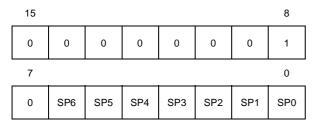
This bit is driven by the SCF and RCF instructions and tested by the JRC and JRNC instructions. It is also affected by the "bit test and branch", shift and rotate instructions.

6 CENTRAL PROCESSING UNIT (Cont'd)

Stack Pointer (SP)

Read/Write

Reset Value: 01 7Fh



The Stack Pointer is a 16-bit register which is always pointing to the next free location in the stack. It is then decremented after data has been pushed onto the stack and incremented before data is popped from the stack (see Figure 7).

Since the stack is 128 bytes deep, the 9 most significant bits are forced by hardware. Following an MCU Reset, or after a Reset Stack Pointer instruction (RSP), the Stack Pointer contains its reset value (the SP6 to SP0 bits are set) which is the stack higher address.

The least significant byte of the Stack Pointer (called S) can be directly accessed by a LD instruction.

Note: When the lower limit is exceeded, the Stack Pointer wraps around to the stack upper limit, without indicating the stack overflow. The previously stored information is then overwritten and therefore lost. The stack also wraps in case of an underflow

The stack is used to save the return address during a subroutine call and the CPU context during an interrupt. The user may also directly manipulate the stack by means of the PUSH and POP instructions. In the case of an interrupt, the PCL is stored at the first location pointed to by the SP. Then the other registers are stored in the next locations as shown in Figure 7.

- When an interrupt is received, the SP is decremented and the context is pushed on the stack.
- On return from interrupt, the SP is incremented and the context is popped from the stack.

A subroutine call occupies two locations and an interrupt five locations in the stack area.

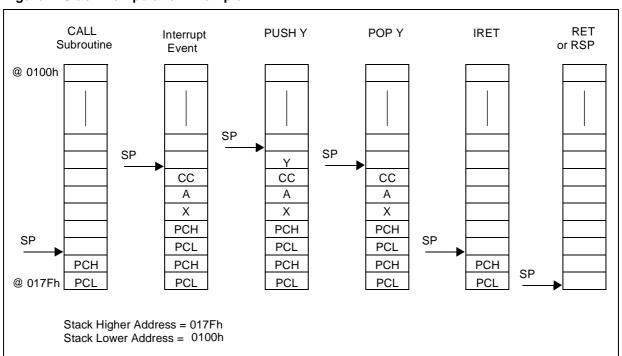


Figure 7. Stack Manipulation Example

7 SUPPLY, RESET AND CLOCK MANAGEMENT

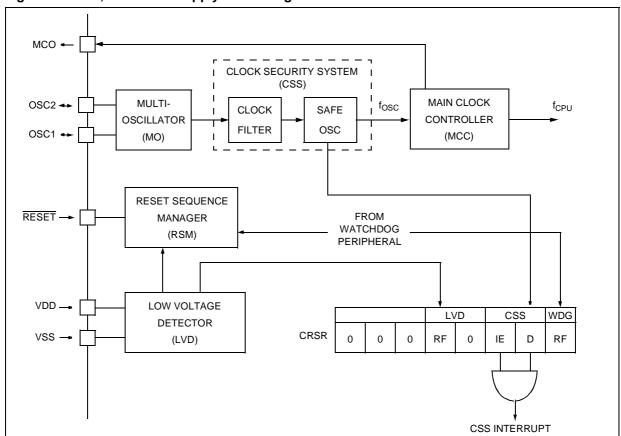
The ST72104G, ST72215G, ST72216G and ST72254G microcontrollers include a range of utility features for securing the application in critical situations (for example in case of a power brownout), and reducing the number of external components. An overview is shown in Figure 8.

See Section 14 "ELECTRICAL CHARACTERISTICS" on page 96 for more details.

Main Features

- Supply Manager with main supply low voltage detection (LVD)
- Reset Sequence Manager (RSM)
- Multi-Oscillator (MO)
 - 4 Crystal/Ceramic resonator oscillators
 - 1 External RC oscillator
 - 1 Internal RC oscillator
- Clock Security System (CSS)
 - Clock Filter
 - Backup Safe Oscillator

Figure 8. Clock, Reset and Supply Block Diagram



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7.1 LOW VOLTAGE DETECTOR (LVD)

To allow the integration of power management features in the application, the Low Voltage Detector function (LVD) generates a static reset when the V_{DD} supply voltage is below a V_{IT} reference value. This means that it secures the power-up as well as the power-down keeping the ST7 in reset.

The V_{IT-} reference value for a voltage drop is lower than the V_{IT+} reference value for power-on in order to avoid a parasitic reset when the MCU starts running and sinks current on the supply (hysteresis).

The LVD Reset circuitry generates a reset when V_{DD} is below:

- V_{IT+} when V_{DD} is rising
- V_{IT-} when V_{DD} is falling

The LVD function is illustrated in the Figure 9.

Provided the minimum V_{DD} value (guaranteed for the oscillator frequency) is above $V_{\text{IT-}}$, the MCU can only be in two modes:

- under full software control
- in static safe reset

In these conditions, secure operation is always ensured for the application without the need for external reset hardware.

During a Low Voltage Detector Reset, the $\overline{\text{RESET}}$ pin is held low, thus permitting the MCU to reset other devices.

Notes:

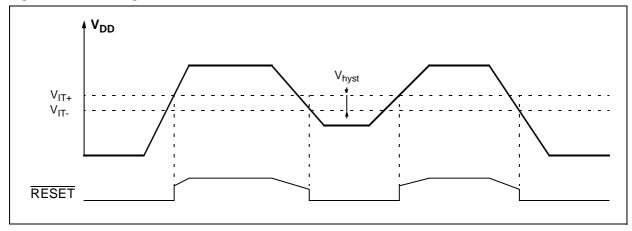
- 1. The LVD allows the device to be used without any external RESET circuitry.
- 2. Three different reference levels are selectable through the option byte according to the application requirement.

LVD application note

Application software can detect a reset caused by the LVD by reading the LVDRF bit in the CRSR register.

This bit is set by hardware when a LVD reset is generated and cleared by software (writing zero).





7.2 RESET SEQUENCE MANAGER (RSM)

7.2.1 Introduction

The reset sequence manager includes three RE-SET sources as shown in Figure 11:

- External RESET source pulse
- Internal LVD RESET (Low Voltage Detection)
- Internal WATCHDOG RESET

These sources act on the $\overline{\text{RESET}}$ pin and it is always kept low during the delay phase.

The RESET service routine vector is fixed at addresses FFFEh-FFFFh in the ST7 memory map.

The basic RESET sequence consists of 3 phases as shown in Figure 10:

- Delay depending on the RESET source
- 4096 CPU clock cycle delay
- RESET vector fetch

The 4096 CPU clock cycle delay allows the oscillator to stabilise and ensures that recovery has taken place from the Reset state.

The RESET vector fetch phase duration is 2 clock cycles.

Figure 10. RESET Sequence Phases

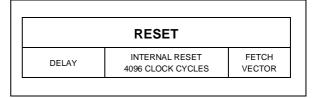
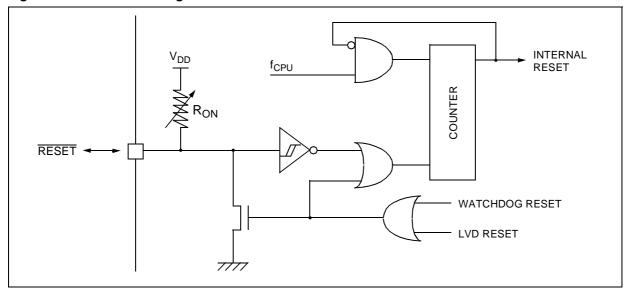


Figure 11. Reset Block Diagram



RESET SEQUENCE MANAGER (Cont'd)

7.2.2 Asynchronous External RESET pin

The $\overline{\text{RESET}}$ pin is both an input and an open-drain output with integrated R_{ON} weak pull-up resistor. This pull-up has no fixed value but varies in accordance with the input voltage. It can be pulled low by external circuitry to reset the device. See electrical characteristics section for more details.

A RESET signal originating from an external source must have a duration of at least $t_{h(RSTL)in}$ in order to be recognized. This detection is asynchronous and therefore the MCU can enter reset state even in HALT mode.

The RESET pin is an asynchronous signal which plays a major role in EMS performance. In a noisy environment, it is recommended to follow the guidelines mentioned in the electrical characteristics section.

Two RESET sequences can be associated with this RESET source: short or long external reset pulse (see Figure 12).

Starting from the external RESET pulse recognition, the device $\overline{\text{RESET}}$ pin acts as an output that is pulled low during at least $t_{w(RSTL)out}$.

7.2.3 Internal Low Voltage Detection RESET

Two different RESET sequences caused by the internal LVD circuitry can be distinguished:

- Power-On RESET
- Voltage Drop RESET

The device \overline{RESET} pin acts as an output that is pulled low when $V_{DD} < V_{IT+}$ (rising edge) or $V_{DD} < V_{IT-}$ (falling edge) as shown in Figure 12.

The LVD filters spikes on V_{DD} larger than $t_{g(VDD)}$ to avoid parasitic resets.

7.2.4 Internal Watchdog RESET

The RESET sequence generated by a internal Watchdog counter overflow is shown in Figure 12.

Starting from the Watchdog counter underflow, the device \overline{RESET} pin acts as an output that is pulled low during at least $t_{w(RSTL)out}$.

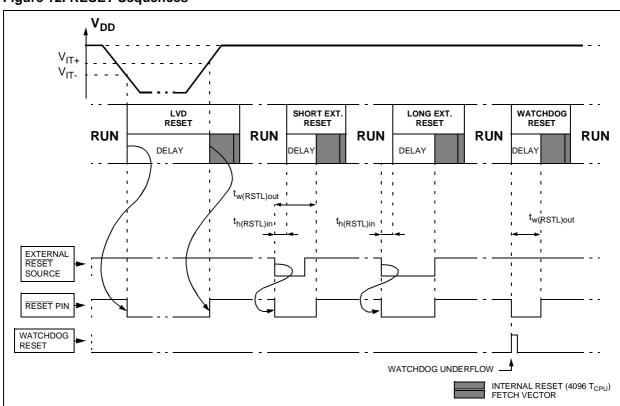


Figure 12. RESET Sequences

7.3 MULTI-OSCILLATOR (MO)

The main clock of the ST7 can be generated by four different source types coming from the multi-oscillator block:

- an external source
- 4 crystal or ceramic resonator oscillators
- an external RC oscillator
- an internal high frequency RC oscillator

Each oscillator is optimized for a given frequency range in terms of consumption and is selectable through the option byte. The associated hardware configuration are shown in Table 3. Refer to the electrical characteristics section for more details.

External Clock Source

In this external clock mode, a clock signal (square, sinus or triangle) with ~50% duty cycle has to drive the OSC1 pin while the OSC2 pin is tied to ground.

Crystal/Ceramic Oscillators

This family of oscillators has the advantage of producing a very accurate rate on the main clock of the ST7. The selection within a list of 4 oscillators with different frequency ranges has to be done by option byte in order to reduce consumption. In this mode of the multi-oscillator, the resonator and the load capacitors have to be placed as close as possible to the oscillator pins in order to minimize output distortion and start-up stabilization time. The loading capacitance values must be adjusted according to the selected oscillator.

These oscillators are not stopped during the RESET phase to avoid losing time in the oscillator start-up phase.

External RC Oscillator

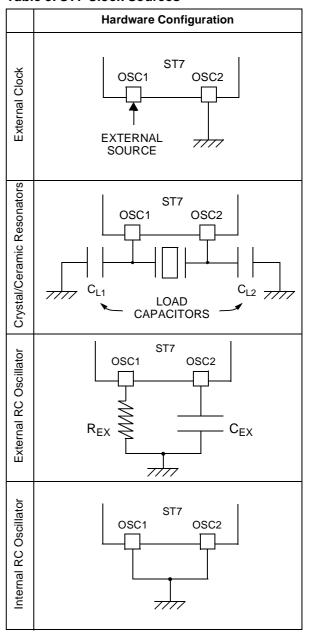
This oscillator allows a low cost solution for the main clock of the ST7 using only an external resistor and an external capacitor. The frequency of the external RC oscillator (in the range of some MHz.) is fixed by the resistor and the capacitor values. Consequently in this MO mode, the accuracy of the clock is directly linked to the accuracy of the discrete components.

Internal RC Oscillator

The internal RC oscillator mode is based on the same principle as the external RC oscillator including the resistance and the capacitance of the device. This mode is the most cost effective one with the drawback of a lower frequency accuracy. Its frequency is in the range of several MHz.

In this mode, the two oscillator pins have to be tied to ground.

Table 3. ST7 Clock Sources



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7.4 CLOCK SECURITY SYSTEM (CSS)

The Clock Security System (CSS) protects the ST7 against main clock problems. To allow the integration of the security features in the applications, it is based on a clock filter control and an Internal safe oscillator. The CSS can be enabled or disabled by option byte.

7.4.1 Clock Filter Control

The clock filter is based on a clock frequency limitation function.

This filter function is able to detect and filter high frequency spikes on the ST7 main clock.

If the oscillator is not working properly (e.g. working at a harmonic frequency of the resonator), the current active oscillator clock can be totally filtered, and then no clock signal is available for the ST7 from this oscillator anymore. If the original clock source recovers, the filtering is stopped automatically and the oscillator supplies the ST7 clock.

7.4.2 Safe Oscillator Control

The safe oscillator of the CSS block is a low frequency back-up clock source (see Figure 13).

If the clock signal disappears (due to a broken or disconnected resonator...) during a safe oscillator period, the safe oscillator delivers a low frequency clock signal which allows the ST7 to perform some rescue operations.

Automatically, the ST7 clock source switches back from the safe oscillator if the original clock source recovers.

Limitation detection

The automatic safe oscillator selection is notified by hardware setting the CSSD bit of the CRSR register. An interrupt can be generated if the CS-SIE bit has been previously set.

These two bits are described in the CRSR register description.

7.4.3 Low Power Modes

Mode	Description
WAIT	No effect on CSS. CSS interrupt cause the device to exit from Wait mode.
HALT	The CRSR register is frozen. The CSS (including the safe oscillator) is disabled until HALT mode is exited. The previous CSS configuration resumes when the MCU is woken up by an interrupt with "exit from HALT mode" capability or from the counter reset value when the MCU is woken up by a RESET.

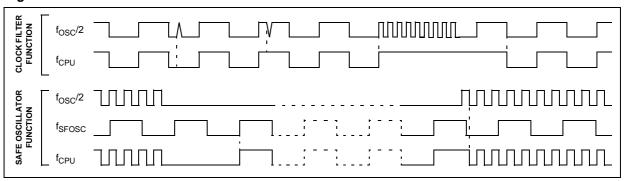
7.4.4 Interrupts

The CSS interrupt event generates an interrupt if the corresponding Enable Control Bit (CSSIE) is set and the interrupt mask in the CC register is reset (RIM instruction).

Interrupt Event	Event Flag	Enable Control Bit	Exit from Wait	Exit from Halt ¹⁾
CSS event detection (safe oscillator activated as main clock)	CSSD	CSSIE	Yes	No

Note 1: This interrupt allows to exit from active-halt mode if this mode is available in the MCU.

Figure 13. Clock Filter Function and Safe Oscillator Function



7.5 CLOCK RESET AND SUPPLY REGISTER DESCRIPTION (CRSR)

Read/Write

Reset Value: 000x 000x (XXh)

7							0
0	0	0	LVD RF	0	CSS IE	CSS D	WDG RF

Bit 7:5 =**Reserved**, always read as 0.

Bit 4 = **LVDRF** *LVD* reset flag

This bit indicates that the last RESET was generated by the LVD block. It is set by hardware (LVD reset) and cleared by software (writing zero). See WDGRF flag description for more details. When the LVD is disabled by option byte, the LVDRF bit value is undefined.

Bit 3 =**Reserved**, always read as 0.

Bit 2 = **CSSIE** Clock security syst interrupt enable This bit enables the interrupt when a disturbance is detected by the clock security system (CSSD bit set). It is set and cleared by software.

- 0: Clock security system interrupt disabled
- 1: Clock security system interrupt enabled

Refer to Table 5, "Interrupt Mapping," on page 26 for more details on the CSS interrupt vector. When the CSS is disabled by option byte, the CSSIE bit has no effect.

Bit 1 = **CSSD** Clock security system detection

This bit indicates that the safe oscillator of the clock security system block has been selected by hardware due to a disturbance on the main clock signal (f_{OSC}). It is set by hardware and cleared by reading the CRSR register when the original oscillator recovers.

- 0: Safe oscillator is not active
- 1: Safe oscillator has been activated

When the CSS is disabled by option byte, the CSSD bit value is forced to 0.

Bit 0 = WDGRF Watchdog reset flag

This bit indicates that the last RESET was generated by the watchdog peripheral. It is set by hardware (Watchdog RESET) and cleared by software (writing zero) or an LVD RESET (to ensure a stable cleared state of the WDGRF flag when the CPU starts).

Combined with the LVDRF flag information, the flag description is given by the following table.

RESET Sources	LVDRF	WDGRF
External RESET pin	0	0
Watchdog	0	1
LVD	1	Х

Application notes

The LVDRF flag is not cleared when another RE-SET type occurs (external or watchdog), the LVDRF flag remains set to keep trace of the original failure.

In this case, a watchdog reset can be detected by software while an external reset can not.

Table 4. Clock, Reset and Supply Register Map and Reset Values

Address (Hex.)	Register Label	7	6	5	4	3	2	1	0
0025h	CRSR Reset Value	0	0	0	LVDRF x	0	CSSIE 0	CSSD 0	WDGRF x

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7.6 MAIN CLOCK CONTROLLER (MCC)

The Main Clock Controller (MCC) supplies the clock for the ST7 CPU and its internal peripherals. It allows SLOW power saving mode to be managed by the application.

All functions are managed by the Miscellaneous register 1 (MISCR1).

The MCC block consists of:

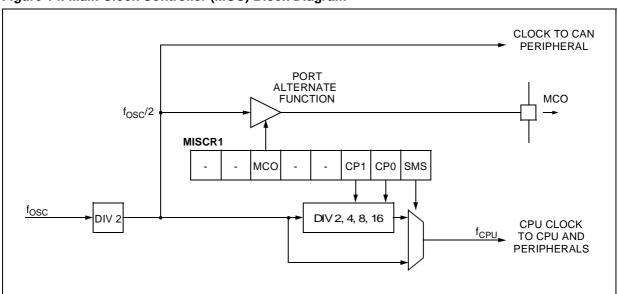
- A programmable CPU clock prescaler
- A clock-out signal to supply external devices

The prescaler allows the selection of the main clock frequency and is controlled by three bits of the MISCR1: CP1, CP0 and SMS.

The clock-out capability consists of a dedicated I/O port pin configurable as an f_{CPU} clock output to drive external devices. It is controlled by the MCO bit in the MISCR1 register.

See Section 11 "MISCELLANEOUS REGISTERS" on page 36 for more details.

Figure 14. Main Clock Controller (MCC) Block Diagram



8 INTERRUPTS

The ST7 core may be interrupted by one of two different methods: maskable hardware interrupts as listed in the Interrupt Mapping Table and a non-maskable software interrupt (TRAP). The Interrupt processing flowchart is shown in Figure 1.

The maskable interrupts must be enabled clearing the I bit in order to be serviced. However, disabled interrupts may be latched and processed when they are enabled (see external interrupts subsection).

When an interrupt has to be serviced:

- Normal processing is suspended at the end of the current instruction execution.
- The PC, X, A and CC registers are saved onto the stack.
- The I bit of the CC register is set to prevent additional interrupts.
- The PC is then loaded with the interrupt vector of the interrupt to service and the first instruction of the interrupt service routine is fetched (refer to the Interrupt Mapping Table for vector addresses).

The interrupt service routine should finish with the IRET instruction which causes the contents of the saved registers to be recovered from the stack.

Note: As a consequence of the IRET instruction, the I bit will be cleared and the main program will resume.

Priority Management

By default, a servicing interrupt cannot be interrupted because the I bit is set by hardware entering in interrupt routine.

In the case when several interrupts are simultaneously pending, an hardware priority defines which one will be serviced first (see the Interrupt Mapping Table).

Interrupts and Low Power Mode

All interrupts allow the processor to leave the WAIT low power mode. Only external and specifically mentioned interrupts allow the processor to leave the HALT low power mode (refer to the "Exit from HALT" column in the Interrupt Mapping Table).

8.1 NON MASKABLE SOFTWARE INTERRUPT

This interrupt is entered when the TRAP instruction is executed regardless of the state of the I bit.

It will be serviced according to the flowchart on Figure 1.

8.2 EXTERNAL INTERRUPTS

External interrupt vectors can be loaded into the PC register if the corresponding external interrupt occurred and if the I bit is cleared. These interrupts allow the processor to leave the Halt low power mode.

The external interrupt polarity is selected through the miscellaneous register or interrupt register (if available).

An external interrupt triggered on edge will be latched and the interrupt request automatically cleared upon entering the interrupt service routine.

If several input pins, connected to the same interrupt vector, are configured as interrupts, their signals are logically ANDed before entering the edge/level detection block.

Caution: The type of sensitivity defined in the Miscellaneous or Interrupt register (if available) applies to the ei source. In case of an ANDed source (as described on the I/O ports section), a low level on an I/O pin configured as input with interrupt, masks the interrupt request even in case of risingedge sensitivity.

8.3 PERIPHERAL INTERRUPTS

Different peripheral interrupt flags in the status register are able to cause an interrupt when they are active if both:

- The I bit of the CC register is cleared.
- The corresponding enable bit is set in the control register.

If any of these two conditions is false, the interrupt is latched and thus remains pending.

Clearing an interrupt request is done by:

- Writing "0" to the corresponding bit in the status register or
- Access to the status register while the flag is set followed by a read or write of an associated register.

Note: the clearing sequence resets the internal latch. A pending interrupt (i.e. waiting for being enabled) will therefore be lost if the clear sequence is executed.

INTERRUPTS (Cont'd)

Figure 15. Interrupt Processing Flowchart

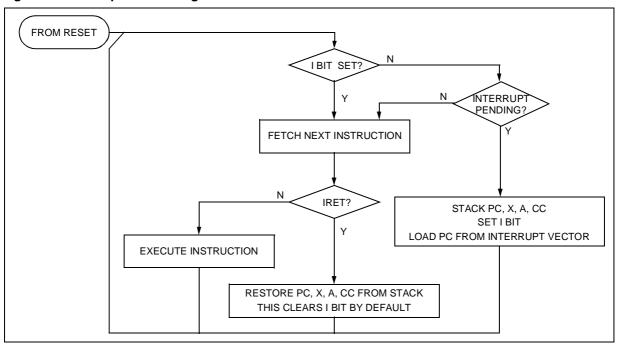


Table 5. Interrupt Mapping

N°	Source Block	Description	Register Label	Priority Order	Exit from HALT	Address Vector
	RESET	Reset		Highest	yes	FFFEh-FFFFh
	TRAP	Software Interrupt	N/A	Priority	no	FFFCh-FFFDh
0	ei0	External Interrupt Port A70 (C50 ¹)	IN/A		VOS	FFFAh-FFFBh
1	ei1	External Interrupt Port B70 (C50 ¹)			yes	FFF8h-FFF9h
2	CSS	Clock Security System Interrupt	CRSR			FFF6h-FFF7h
3	SPI	SPI Peripheral Interrupts	SPISR		no	FFF4h-FFF5h
4	TIMER A	TIMER A Peripheral Interrupts	TASR	TASR		FFF2h-FFF3h
5		Not used				FFF0h-FFF1h
6	TIMER B	TIMER B Peripheral Interrupts	TBSR		no	FFEEh-FFEFh
7		Not used				FFECh-FFEDh
8		Not used				FFEAh-FFEBh
9		Not used				FFE8h-FFE9h
10		Not used				FFE6h-FFE7h
11	I ² C	I ² C Peripheral Interrupt	I2CSRx	 	no	FFE4h-FFE5h
12		Not Used		Lowest		FFE2h-FFE3h
13		Not Used		Priority		FFE0h-FFE1h

Note

1. Configurable by option byte.

9 POWER SAVING MODES

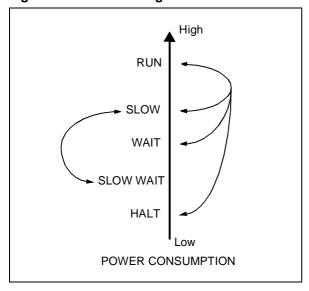
9.1 INTRODUCTION

To give a large measure of flexibility to the application in terms of power consumption, three main power saving modes are implemented in the ST7 (see Figure 16).

After a RESET the normal operating mode is selected by default (RUN mode). This mode drives the device (CPU and embedded peripherals) by means of a master clock which is based on the main oscillator frequency divided by 2 (f_{CPLI}).

From Run mode, the different power saving modes may be selected by setting the relevant register bits or by calling the specific ST7 software instruction whose action depends on the oscillator status.

Figure 16. Power Saving Mode Transitions



9.2 SLOW MODE

This mode has two targets:

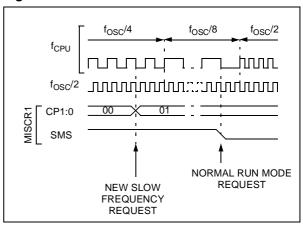
- To reduce power consumption by decreasing the internal clock in the device,
- To adapt the internal clock frequency (f_{CPU}) to the available supply voltage.

SLOW mode is controlled by three bits in the MISCR1 register: the SMS bit which enables or disables Slow mode and two CPx bits which select the internal slow frequency (f_{CPU}).

In this mode, the oscillator frequency can be divided by 4, 8, 16 or 32 instead of 2 in normal operating mode. The CPU and peripherals are clocked at this lower frequency.

Note: SLOW-WAIT mode is activated when entering WAIT mode while the device is already in SLOW mode.

Figure 17. SLOW Mode Clock Transitions



POWER SAVING MODES (Cont'd)

9.3 WAIT MODE

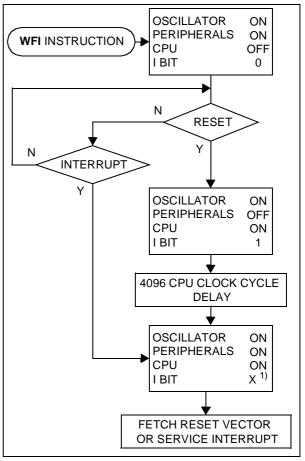
WAIT mode places the MCU in a low power consumption mode by stopping the CPU.

This power saving mode is selected by calling the "WFI" ST7 software instruction.

All peripherals remain active. During WAIT mode, the I bit of the CC register is forced to 0, to enable all interrupts. All other registers and memory remain unchanged. The MCU remains in WAIT mode until an interrupt or Reset occurs, whereupon the Program Counter branches to the starting address of the interrupt or Reset service routine. The MCU will remain in WAIT mode until a Reset or an Interrupt occurs, causing it to wake up.

Refer to Figure 18.

Figure 18. WAIT Mode Flow-chart



Note:

1. Before servicing an interrupt, the CC register is pushed on the stack. The I bit of the CC register is set during the interrupt routine and cleared when the CC register is popped.

POWER SAVING MODES (Cont'd)

9.4 HALT MODE

The HALT mode is the lowest power consumption mode of the MCU. It is entered by executing the ST7 HALT instruction (see Figure 20).

The MCU can exit HALT mode on reception of either a specific interrupt (see Table 5, "Interrupt Mapping," on page 26) or a RESET. When exiting HALT mode by means of a RESET or an interrupt, the oscillator is immediately turned on and the 4096 CPU cycle delay is used to stabilize the oscillator. After the start up delay, the CPU resumes operation by servicing the interrupt or by fetching the reset vector which woke it up (see Figure 19). When entering HALT mode, the I bit in the CC register is forced to 0 to enable interrupts. Therefore, if an interrupt is pending, the MCU wakes immediately.

In the HALT mode the main oscillator is turned off causing all internal processing to be stopped, including the operation of the on-chip peripherals. All peripherals are not clocked except the ones which get their clock supply from another clock generator (such as an external or auxiliary oscillator).

The compatibility of Watchdog operation with HALT mode is configured by the "WDGHALT" option bit of the option byte. The HALT instruction when executed while the Watchdog system is enabled, can generate a Watchdog RESET (see Section 16.1 "OPTION BYTES" on page 133 for more details).

Figure 19. HALT Mode Timing Overview

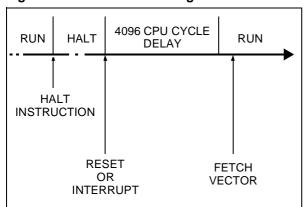
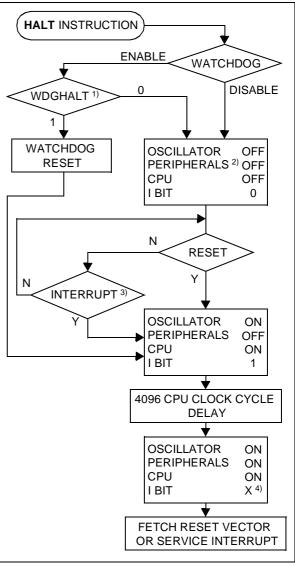


Figure 20. HALT Mode Flow-chart



Notes:

- 1. WDGHALT is an option bit. See option byte section for more details.
- 2. Peripheral clocked with an external clock source can still be active.
- 3. Only some specific interrupts can exit the MCU from HALT mode (such as external interrupt). Refer to Table 5, "Interrupt Mapping," on page 26 for more details.
- 4. Before servicing an interrupt, the CC register is pushed on the stack. The I bit of the CC register is set during the interrupt routine and cleared when the CC register is popped.

10 I/O PORTS

10.1 INTRODUCTION

The I/O ports offer different functional modes:

- transfer of data through digital inputs and outputs and for specific pins:
- external interrupt generation
- alternate signal input/output for the on-chip peripherals.

An I/O port contains up to 8 pins. Each pin can be programmed independently as digital input (with or without interrupt generation) or digital output.

10.2 FUNCTIONAL DESCRIPTION

Each port has 2 main registers:

- Data Register (DR)
- Data Direction Register (DDR)

and one optional register:

Option Register (OR)

Each I/O pin may be programmed using the corresponding register bits in the DDR and OR registers: bit X corresponding to pin X of the port. The same correspondence is used for the DR register.

The following description takes into account the OR register, (for specific ports which do not provide this register refer to the I/O Port Implementation section). The generic I/O block diagram is shown in Figure 21

10.2.1 Input Modes

The input configuration is selected by clearing the corresponding DDR register bit.

In this case, reading the DR register returns the digital value applied to the external I/O pin.

Different input modes can be selected by software through the OR register.

Notes:

- 1. Writing the DR register modifies the latch value but does not affect the pin status.
- 2. When switching from input to output mode, the DR register has to be written first to drive the correct level on the pin as soon as the port is configured as an output.

External interrupt function

When an I/O is configured as Input with Interrupt, an event on this I/O can generate an external interrupt request to the CPU.

Each pin can independently generate an interrupt request. The interrupt sensitivity is independently programmable using the sensitivity bits in the Miscellaneous register.

Each external interrupt vector is linked to a dedicated group of I/O port pins (see pinout description and interrupt section). If several input pins are selected simultaneously as interrupt source, these are logically ANDed. For this reason if one of the interrupt pins is tied low, it masks the other ones.

In case of a floating input with interrupt configuration, special care must be taken when changing the configuration (see Figure 22).

The external interrupts are hardware interrupts, which means that the request latch (not accessible directly by the application) is automatically cleared when the corresponding interrupt vector is fetched. To clear an unwanted pending interrupt by software, the sensitivity bits in the Miscellaneous register must be modified.

10.2.2 Output Modes

The output configuration is selected by setting the corresponding DDR register bit. In this case, writing the DR register applies this digital value to the I/O pin through the latch. Then reading the DR register returns the previously stored value.

Two different output modes can be selected by software through the OR register: Output push-pull and open-drain.

DR register value and output pin status:

DR	Push-pull	Open-drain
0	V_{SS}	Vss
1	V_{DD}	Floating

10.2.3 Alternate Functions

When an on-chip peripheral is configured to use a pin, the alternate function is automatically selected. This alternate function takes priority over the standard I/O programming.

When the signal is coming from an on-chip peripheral, the I/O pin is automatically configured in output mode (push-pull or open drain according to the peripheral).

When the signal is going to an on-chip peripheral, the I/O pin must be configured in input mode. In this case, the pin state is also digitally readable by addressing the DR register.

Note: Input pull-up configuration can cause unexpected value at the input of the alternate peripheral input. When an on-chip peripheral use a pin as input and output, this pin has to be configured in input floating mode.

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Figure 21. I/O Port General Block Diagram

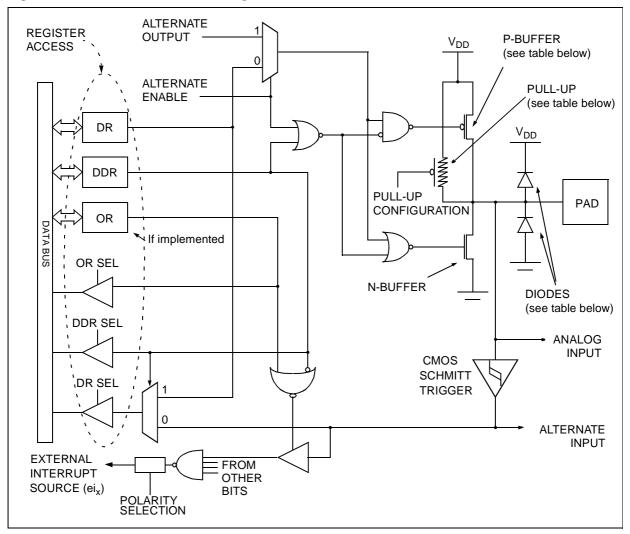


Table 6. I/O Port Mode Options

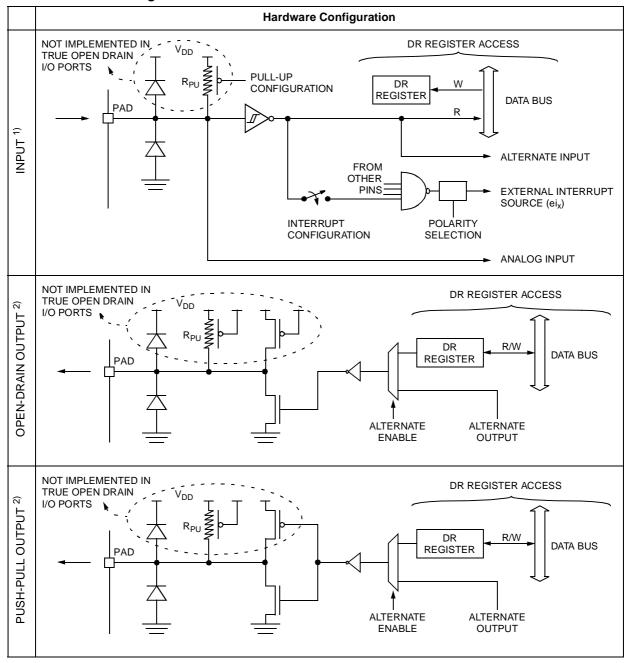
Configuration Mode		Pull-Up	P-Buffer	Diodes		
	Comiguration wode	Full-Op	r-Builei	to V _{DD}	to V _{SS}	
Input	Floating with/without Interrupt	Off	Off		On	
	Pull-up with/without Interrupt	On	- 011	On		
	Push-pull	Off	On			
Output	Open Drain (logic level)	Oii	Off			
	True Open Drain	NI	NI	NI (see note)		

Legend: NI - not implemented

Off - implemented not activated On - implemented and activated

Note: The diode to V_{DD} is not implemented in the true open drain pads. A local protection between the pad and V_{SS} is implemented to protect the device against positive stress.

Table 7. I/O Port Configurations



Notes:

- 1. When the I/O port is in input configuration and the associated alternate function is enabled as an output, reading the DR register will read the alternate function output status.
- 2. When the I/O port is in output configuration and the associated alternate function is enabled as an input, the alternate function reads the pin status given by the DR register content.

CAUTION: The alternate function must not be activated as long as the pin is configured as input with interrupt, in order to avoid generating spurious interrupts.

Analog alternate function

When the pin is used as an ADC input, the I/O must be configured as floating input. The analog multiplexer (controlled by the ADC registers) switches the analog voltage present on the selected pin to the common analog rail which is connected to the ADC input.

It is recommended not to change the voltage level or loading on any port pin while conversion is in progress. Furthermore it is recommended not to have clocking pins located close to a selected analog pin.

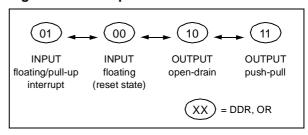
WARNING: The analog input voltage level must be within the limits stated in the absolute maximum ratings.

10.3 I/O PORT IMPLEMENTATION

The hardware implementation on each I/O port depends on the settings in the DDR and OR registers and specific feature of the I/O port such as ADC Input or true open drain.

Switching these I/O ports from one state to another should be done in a sequence that prevents unwanted side effects. Recommended safe transitions are illustrated in Figure 22 Other transitions are potentially risky and should be avoided, since they are likely to present unwanted side-effects such as spurious interrupt generation.

Figure 22. Interrupt I/O Port State Transitions



The I/O port register configurations are summarized as follows.

Interrupt Ports

PA7, PA5, PA3:0, PB7:0, PC5:0 (with pull-up)

MODE	DDR	OR
floating input	0	0
pull-up interrupt input	0	1
open drain output	1	0
push-pull output	1	1

True Open Drain Interrupt Ports

PA6, PA4 (without pull-up)

MODE	DDR	OR
floating input	0	0
floating interrupt input	0	1
open drain (high sink ports)	1	Х

Table 8. Port Configuration

Port	Pin name	Input (I	DDR = 0)	Output (DDR = 1)			
Port	Fili lialile	OR = 0	OR = 1	OR = 0	OR = 1	High-Sink	
	PA7	floating	pull-up interrupt	open drain push-pull			
	PA6	floating	floating interrupt	upt true open-drain			
Port A	PA5	floating	pull-up interrupt	open drain	push-pull	Yes	
	PA4	floating	floating interrupt	true open-drain			
	PA3:0	floating	pull-up interrupt	open drain	push-pull		
Port B	PB7:0	floating	pull-up interrupt	open drain	push-pull	No	
Port C	PC7:0	floating	pull-up interrupt	open drain	push-pull	INO	

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10.4 LOW POWER MODES

Mode	Description
WAIT	No effect on I/O ports. External interrupts cause the device to exit from WAIT mode.
HALT	No effect on I/O ports. External interrupts cause the device to exit from HALT mode.

10.5 INTERRUPTS

The external interrupt event generates an interrupt if the corresponding configuration is selected with DDR and OR registers and the I-bit in the CC register is reset (RIM instruction).

Interrupt Event	Event Flag	Enable Control Bit	Exit from Wait	Exit from Halt	
External interrupt on selected external event	-	DDRx ORx	Yes	Yes	

10.6 REGISTER DESCRIPTION

DATA REGISTER (DR)

Port x Data Register PxDR with x = A, B or C.

Read/Write

Reset Value: 0000 0000 (00h)

7							0
D7	D6	D5	D4	D3	D2	D1	D0

Bit 7:0 = **D[7:0]** *Data register 8 bits.*

The DR register has a specific behaviour according to the selected input/output configuration. Writing the DR register is always taken into account even if the pin is configured as an input; this allows always having the expected level on the pin when toggling to output mode. Reading the DR register returns either the DR register latch content (pin configured as output) or the digital value applied to the I/O pin (pin configured as input).

DATA DIRECTION REGISTER (DDR)

Port x Data Direction Register PxDDR with x = A, B or C.

Read/Write

Reset Value: 0000 0000 (00h)

/							0
DD7	DD6	DD5	DD4	DD3	DD2	DD1	DD0

Bit 7:0 = DD[7:0] Data direction register 8 bits.

The DDR register gives the input/output direction configuration of the pins. Each bit is set and cleared by software.

0: Input mode

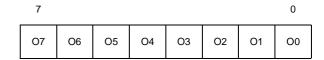
1: Output mode

OPTION REGISTER (OR)

Port x Option Register PxOR with x = A, B or C.

Read/Write

Reset Value: 0000 0000 (00h)



Bit 7:0 = O[7:0] Option register 8 bits.

For specific I/O pins, this register is not implemented. In this case the DDR register is enough to select the I/O pin configuration.

The OR register allows to distinguish: in input mode if the pull-up with interrupt capability or the basic pull-up configuration is selected, in output mode if the push-pull or open drain configuration is selected.

Each bit is set and cleared by software.

Input mode:

- 0: Floating input
- 1: Pull-up input with or without interrupt

Output mode:

- 0: Output open drain (with P-Buffer deactivated)
- 1: Output push-pull (when available)

Table 9. I/O Port Register Map and Reset Values

Address (Hex.)	Register Label	7	6	5	4	3	2	1	0
Reset Value of all I/O port registers		0	0	0	0	0	0	0	0
0000h	PCDR								
0001h	PCDDR	MSB							LSB
0002h	PCOR								
0004h	PBDR	MSB							LSB
0005h	PBDDR								
0006h	PBOR								
0008h	PADR	MSB							LSB
0009h	PADDR								
000Ah	PAOR								

11 MISCELLANEOUS REGISTERS

The miscellaneous registers allow control over several different features such as the external interrupts or the I/O alternate functions.

11.1 I/O PORT INTERRUPT SENSITIVITY

The external interrupt sensitivity is controlled by the ISxx bits of the Miscellaneous register and the OPTION BYTE. This control allows having two fully independent external interrupt source sensitivities with configurable sources (using EXTIT option bit) as shown in Figure 23 and Figure 24.

Each external interrupt source can be generated on four different events on the pin:

- Falling edge
- Rising edge
- Falling and rising edge
- Falling edge and low level

To guarantee correct functionality, the sensitivity bits in the MISCR1 register must be modified only when the I bit of the CC register is set to 1 (interrupt masked). See I/O port register and Miscellaneous register descriptions for more details on the programming.

11.2 I/O PORT ALTERNATE FUNCTIONS

The MISCR registers manage four I/O port miscellaneous alternate functions:

- Main clock signal (f_{CPU}) output on PC2
- SPI pin configuration:
 - SS pin internal control to use the PB7 I/O port function while the SPI is active.
 - Master output capability on MOSI pin (PB4) deactivated while the SPI is active.
 - Slave output capability on MISO pin (PB5) deactivated while the SPI is active.

These functions are described in detail in the Section 11.3 "MISCELLANEOUS REGISTER DESCRIPTION" on page 37.

Figure 23. Ext. Interrupt Sensitivity (EXTIT=0)

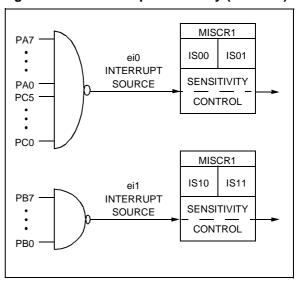
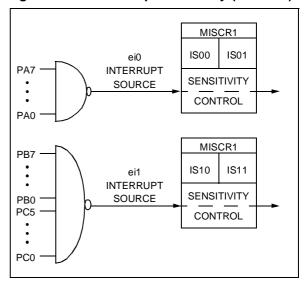


Figure 24. Ext. Interrupt Sensitivity (EXTIT=1)



MISCELLANEOUS REGISTERS (Cont'd)

11.3 MISCELLANEOUS REGISTER DESCRIPTION

MISCELLANEOUS REGISTER 1 (MISCR1)

Read/Write

Reset Value: 0000 0000 (00h)

7 0

IS11	IS10	МСО	IS01	IS00	CP1	CP0	SMS

Bit 7:6 = **IS1[1:0]** *ei1 sensitivity*

The interrupt sensitivity, defined using the IS1[1:0] bits, is applied to the ei1 external interrupts. These two bits can be written only when the I bit of the CC register is set to 1 (interrupt masked).

ei1: Port B (C optional)

External Interrupt Sensitivity	IS11	IS10
Falling edge & low level	0	0
Rising edge only	0	1
Falling edge only	1	0
Rising and falling edge	1	1

Bit 5 = MCO Main clock out selection

This bit enables the MCO alternate function on the PC2 I/O port. It is set and cleared by software.

- 0: MCO alternate function disabled (I/O pin free for general-purpose I/O)
- MCO alternate function enabled (f_{CPU} on I/O port)

Bit 4:3 = **IS0[1:0]** *ei0 sensitivity*

The interrupt sensitivity, defined using the IS0[1:0] bits, is applied to the ei0 external interrupts. These two bits can be written only when the I bit of the CC register is set to 1 (interrupt masked).

ei0: Port A (C optional)

External Interrupt Sensitivity	IS01	IS00
Falling edge & low level	0	0
Rising edge only	0	1
Falling edge only	1	0
Rising and falling edge	1	1

Bit 2:1 = CP[1:0] CPU clock prescaler

These bits select the CPU clock prescaler which is applied in the different slow modes. Their action is conditioned by the setting of the SMS bit. These two bits are set and cleared by software

f _{CPU} in SLOW mode	CP1	CP0
f _{OSC} / 4	0	0
f _{OSC} / 8	1	0
f _{OSC} / 16	0	1
f _{OSC} / 32	1	1

Bit 0 = **SMS** Slow mode select

This bit is set and cleared by software.

- 0: Normal mode. $f_{CPU} = f_{OSC} / 2$
- 1: Slow mode. f_{CPU} is given by CP1, CP0

See low power consumption mode and MCC chapters for more details.

MISCELLANEOUS REGISTERS (Cont'd)

MISCELLANEOUS REGISTER 2 (MISCR2)

Read/Write

Reset Value: 0000 0000 (00h)

7							0
0	0	0	0	MOD	SOD	SSM	SSI

Bit 7:4 = **Reserved** always read as 0

Bit 3 = **MOD** SPI Master Output Disable
This bit is set and cleared by software. When set, it disables the SPI Master (MOSI) output signal.

0: SPI Master Output enabled.

1: SPI Master Output disabled.

Bit 2 = **SOD** SPI Slave Output Disable

This bit is set and cleared by software. When set it disable the SPI Slave (MISO) output signal.

0: SPI Slave Output enabled.

1: SPI Slave Output disabled.

Bit $1 = SSM \overline{SS}$ mode selection

This bit is set and cleared by software.

- 0: Normal mode the level of the SPI SS signal is input from the external SS pin.
- 1: I/O mode, the level of the SPI SS signal is read from the SSI bit.

Bit $0 = SSI \overline{SS}$ internal mode

This bit replaces the \overline{SS} pin of the SPI when the SSM bit is set to 1. (see SPI description). It is set and cleared by software.

Table 10. Miscellaneous Register Map and Reset Values

Address (Hex.)	Register Label	7	6	5	4	3	2	1	0
0020h	MISCR1 Reset Value	IS11 0	IS10 0	MCO 0	IS01 0	IS00 0	CP1 0	CP0 0	SMS 0
0040h	MISCR2 Reset Value	0	0	0	0	MOD 0	SOD 0	SSM 0	SSI 0

12 ON-CHIP PERIPHERALS

12.1 WATCHDOG TIMER (WDG)

12.1.1 Introduction

The Watchdog timer is used to detect the occurrence of a software fault, usually generated by external interference or by unforeseen logical conditions, which causes the application program to abandon its normal sequence. The Watchdog circuit generates an MCU reset on expiry of a programmed time period, unless the program refreshes the counter's contents before the T6 bit becomes cleared.

12.1.2 Main Features

- Programmable timer (64 increments of 12288 CPU cycles)
- Programmable reset
- Reset (if watchdog activated) when the T6 bit reaches zero
- Optional reset on HALT instruction (configurable by option byte)
- Hardware Watchdog selectable by option byte.

12.1.3 Functional Description

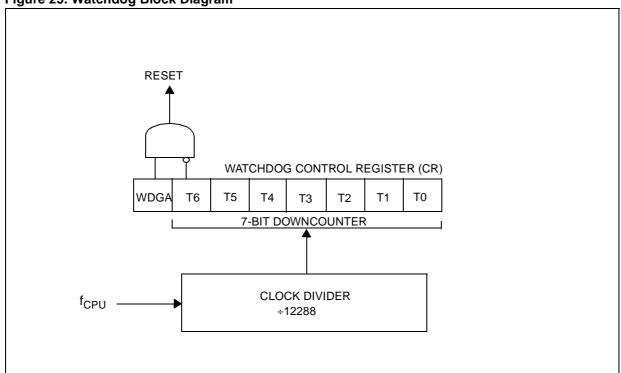
The counter value stored in the CR register (bits T6:T0), is decremented every 12,288 machine cycles, and the length of the timeout period can be programmed by the user in 64 increments.

If the watchdog is activated (the WDGA bit is set) and when the 7-bit timer (bits T6:T0) rolls over from 40h to 3Fh (T6 becomes cleared), it initiates a reset cycle pulling low the reset pin for typically 500ns.

The application program must write in the CR register at regular intervals during normal operation to prevent an MCU reset. The value to be stored in the CR register must be between FFh and C0h (see Table 11 . Watchdog Timing (fCPU = 8 MHz)):

- The WDGA bit is set (watchdog enabled)
- The T6 bit is set to prevent generating an immediate reset
- The T5:T0 bits contain the number of increments which represents the time delay before the watchdog produces a reset.

Figure 25. Watchdog Block Diagram



WATCHDOG TIMER (Cont'd)

Table 11. Watchdog Timing (f_{CPU} = 8 MHz)

	CR Register initial value	WDG timeout period (ms)
Max	FFh	98.304
Min	C0h	1.536

Notes: Following a reset, the watchdog is disabled. Once activated it cannot be disabled, except by a reset.

The T6 bit can be used to generate a software reset (the WDGA bit is set and the T6 bit is cleared).

12.1.4 Hardware Watchdog Option

If Hardware Watchdog is selected by option byte, the watchdog is always active and the WDGA bit in the CR is not used.

Refer to the device-specific Option Byte description.

12.1.5 Low Power Modes

WAIT Instruction

No effect on Watchdog.

HALT Instruction

If the Watchdog reset on HALT option is selected by option byte, a HALT instruction causes an immediate reset generation if the Watchdog is activated (WDGA bit is set).

12.1.5.1 Using Halt Mode with the WDG (option)

If the Watchdog reset on HALT option is not selected by option byte, the Halt mode can be used when the watchdog is enabled.

In this case, the HALT instruction stops the oscillator. When the oscillator is stopped, the WDG stops counting and is no longer able to generate a reset until the microcontroller receives an external interrupt or a reset.

If an external interrupt is received, the WDG restarts counting after 4096 CPU clocks. If a reset is generated, the WDG is disabled (reset state).

Recommendations

- Make sure that an external event is available to wake up the microcontroller from Halt mode.
- Before executing the HALT instruction, refresh the WDG counter, to avoid an unexpected WDG

- reset immediately after waking up the microcontroller.
- When using an external interrupt to wake up the microcontroller, reinitialize the corresponding I/O as "Input Pull-up with Interrupt" before executing the HALT instruction. The main reason for this is that the I/O may be wrongly configured due to external interference or by an unforeseen logical condition.
- For the same reason, reinitialize the level sensitiveness of each external interrupt as a precautionary measure.
- The opcode for the HALT instruction is 0x8E. To avoid an unexpected HALT instruction due to a program counter failure, it is advised to clear all occurrences of the data value 0x8E from memory. For example, avoid defining a constant in ROM with the value 0x8E.
- As the HALT instruction clears the I bit in the CC register to allow interrupts, the user may choose to clear all pending interrupt bits before executing the HALT instruction. This avoids entering other peripheral interrupt routines after executing the external interrupt routine corresponding to the wake-up event (reset or external interrupt).

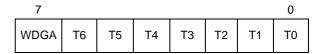
12.1.6 Interrupts

None.

12.1.7 Register Description CONTROL REGISTER (CR)

Read/Write

Reset Value: 0111 1111 (7Fh)



Bit 7 = **WDGA** *Activation bit.*

This bit is set by software and only cleared by hardware after a reset. When WDGA = 1, the watchdog can generate a reset.

0: Watchdog disabled

1: Watchdog enabled

Bit 6:0 = T[6:0] 7-bit timer (MSB to LSB).

These bits contain the decremented value. A reset is produced when it rolls over from 40h to 3Fh (T6 becomes cleared).

WATCHDOG TIMER (Cont'd)

Table 12. Watchdog Timer Register Map and Reset Values

Address (Hex.)	Register Label	7	6	5	4	3	2	1	0
0024h	WDGCR	WDGA	T6	T5	T4	T3	T2	T1	T0
	Reset Value	0	1	1	1	1	1	1	1

12.2 16-BIT TIMER

12.2.1 Introduction

The timer consists of a 16-bit free-running counter driven by a programmable prescaler.

It may be used for a variety of purposes, including measuring the pulse lengths of up to two input signals (*input capture*) or generating up to two output waveforms (*output compare* and *PWM*).

Pulse lengths and waveform periods can be modulated from a few microseconds to several milliseconds using the timer prescaler and the CPU clock prescaler.

Some ST7 devices have two on-chip 16-bit timers. They are completely independent, and do not share any resources. They are synchronized after a MCU reset as long as the timer clock frequencies are not modified.

This description covers one or two 16-bit timers. In ST7 devices with two timers, register names are prefixed with TA (Timer A) or TB (Timer B).

12.2.2 Main Features

- Programmable prescaler: f_{CPU} divided by 2, 4 or 8.
- Overflow status flag and maskable interrupt
- External clock input (must be at least 4 times slower than the CPU clock speed) with the choice of active edge
- Output compare functions with:
 - 2 dedicated 16-bit registers
 - 2 dedicated programmable signals
 - 2 dedicated status flags
 - 1 dedicated maskable interrupt
- Input capture functions with:
 - 2 dedicated 16-bit registers
 - 2 dedicated active edge selection signals
 - 2 dedicated status flags
 - 1 dedicated maskable interrupt
- Pulse Width Modulation mode (PWM)
- One Pulse mode
- 5 alternate functions on I/O ports (ICAP1, ICAP2, OCMP1, OCMP2, EXTCLK)*

The Block Diagram is shown in Figure 26.

*Note: Some timer pins may not be available (not bonded) in some ST7 devices. Refer to the device pin out description.

When reading an input signal on a non-bonded pin, the value will always be '1'.

12.2.3 Functional Description

12.2.3.1 Counter

The main block of the Programmable Timer is a 16-bit free running upcounter and its associated 16-bit registers. The 16-bit registers are made up of two 8-bit registers called high & low.

Counter Register (CR):

- Counter High Register (CHR) is the most significant byte (MS Byte).
- Counter Low Register (CLR) is the least significant byte (LS Byte).

Alternate Counter Register (ACR)

- Alternate Counter High Register (ACHR) is the most significant byte (MS Byte).
- Alternate Counter Low Register (ACLR) is the least significant byte (LS Byte).

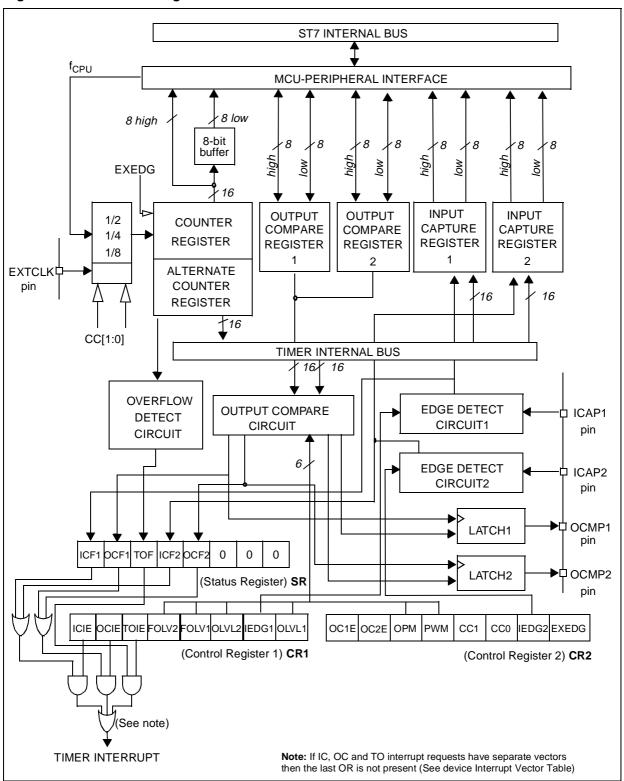
These two read-only 16-bit registers contain the same value but with the difference that reading the ACLR register does not clear the TOF bit (Timer overflow flag), located in the Status register (SR). (See note at the end of paragraph titled 16-bit read sequence).

Writing in the CLR register or ACLR register resets the free running counter to the FFFCh value. Both counters have a reset value of FFFCh (this is the only value which is reloaded in the 16-bit timer). The reset value of both counters is also FFFCh in One Pulse mode and PWM mode.

The timer clock depends on the clock control bits of the CR2 register, as illustrated in Table 13 Clock Control Bits. The value in the counter register repeats every 131.072, 262.144 or 524.288 CPU clock cycles depending on the CC[1:0] bits.

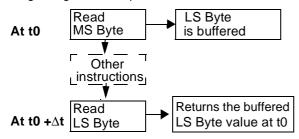
The timer frequency can be f_{CPU}/2, f_{CPU}/4, f_{CPU}/8 or an external frequency.

Figure 26. Timer Block Diagram



16-bit Read Sequence: (from either the Counter Register or the Alternate Counter Register).

Beginning of the sequence



Sequence completed

The user must read the MS Byte first, then the LS Byte value is buffered automatically.

This buffered value remains unchanged until the 16-bit read sequence is completed, even if the user reads the MS Byte several times.

After a complete reading sequence, if only the CLR register or ACLR register are read, they return the LS Byte of the count value at the time of the read.

Whatever the timer mode used (input capture, output compare, One Pulse mode or PWM mode) an overflow occurs when the counter rolls over from FFFFh to 0000h then:

- The TOF bit of the SR register is set.
- A timer interrupt is generated if:
 - TOIE bit of the CR1 register is set and
 - I bit of the CC register is cleared.

If one of these conditions is false, the interrupt remains pending to be issued as soon as they are both true.

Clearing the overflow interrupt request is done in two steps:

- 1. Reading the SR register while the TOF bit is set.
- 2. An access (read or write) to the CLR register.

Note: The TOF bit is not cleared by accessing the ACLR register. The advantage of accessing the ACLR register rather than the CLR register is that it allows simultaneous use of the overflow function and reading the free running counter at random times (for example, to measure elapsed time) without the risk of clearing the TOF bit erroneously.

The timer is not affected by WAIT mode.

In HALT mode, the counter stops counting until the mode is exited. Counting then resumes from the previous count (MCU awakened by an interrupt) or from the reset count (MCU awakened by a Reset).

12.2.3.2 External Clock

The external clock (where available) is selected if CC0=1 and CC1=1 in the CR2 register.

The status of the EXEDG bit in the CR2 register determines the type of level transition on the external clock pin EXTCLK that will trigger the free running counter.

The counter is synchronised with the falling edge of the internal CPU clock.

A minimum of four falling edges of the CPU clock must occur between two consecutive active edges of the external clock; thus the external clock frequency must be less than a quarter of the CPU clock frequency.

Figure 27. Counter Timing Diagram, internal clock divided by 2

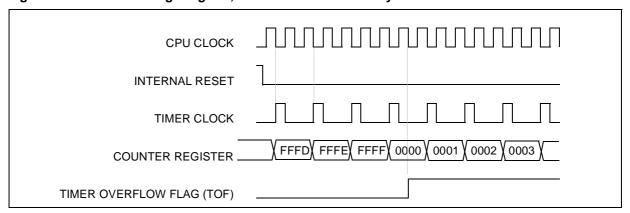


Figure 28. Counter Timing Diagram, internal clock divided by 4

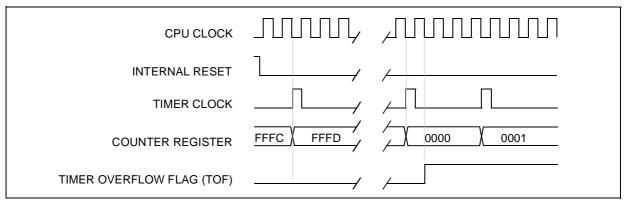
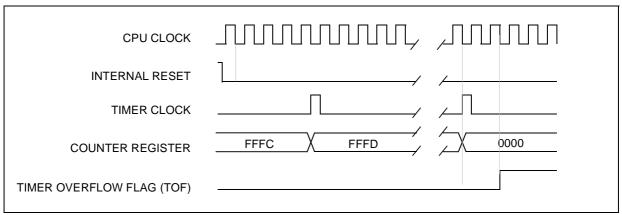


Figure 29. Counter Timing Diagram, internal clock divided by 8



Note: The MCU is in reset state when the internal reset signal is high. When it is low, the MCU is running.

12.2.3.3 Input Capture

In this section, the index, *i*, may be 1 or 2 because there are 2 input capture functions in the 16-bit timer.

The two input capture 16-bit registers (IC1R and IC2R) are used to latch the value of the free running counter after a transition is detected by the ICAP *i* pin (see figure 5).

	MS Byte	LS Byte
ICiR	IC <i>i</i> HR	IC <i>i</i> LR

The ICiR register is a read-only register.

The active transition is software programmable through the IEDG*i* bit of Control Registers (CR*i*).

Timing resolution is one count of the free running counter: $(f_{CPL}/CC[1:0])$.

Procedure:

To use the input capture function, select the following in the CR2 register:

- Select the timer clock (CC[1:0]) (see Table 13 Clock Control Bits).
- Select the edge of the active transition on the ICAP2 pin with the IEDG2 bit (the ICAP2 pin must be configured as a floating input).

And select the following in the CR1 register:

- Set the ICIE bit to generate an interrupt after an input capture coming from either the ICAP1 pin or the ICAP2 pin
- Select the edge of the active transition on the ICAP1 pin with the IEDG1 bit (the ICAP1pin must be configured as a floating input).

When an input capture occurs:

- The ICFi bit is set.
- The ICiR register contains the value of the free running counter on the active transition on the ICAPi pin (see Figure 31).
- A timer interrupt is generated if the ICIE bit is set and the I bit is cleared in the CC register. Otherwise, the interrupt remains pending until both conditions become true.

Clearing the Input Capture interrupt request (i.e. clearing the ICF*i* bit) is done in two steps:

- 1. Reading the SR register while the ICF*i* bit is set.
- 2. An access (read or write) to the ICiLR register.

Notes:

- After reading the ICiHR register, the transfer of input capture data is inhibited and ICFi will never be set until the ICiLR register is also read.
- 2. The ICiR register contains the free running counter value which corresponds to the most recent input capture.
- The 2 input capture functions can be used together even if the timer also uses the 2 output compare functions.
- 4. In One Pulse mode and PWM mode only the input capture 2 function can be used.
- The alternate inputs (ICAP1 & ICAP2) are always directly connected to the timer. So any transitions on these pins activate the input capture function.
 - Moreover if one of the ICAP*i* pin is configured as an input and the second one as an output, an interrupt can be generated if the user toggles the output pin and if the ICIE bit is set.
 - This can be avoided if the input capture function *i* is disabled by reading the IC *i*HR (see note 1).
- The TOF bit can be used with an interrupt in order to measure events that exceed the timer range (FFFFh).

Figure 30. Input Capture Block Diagram

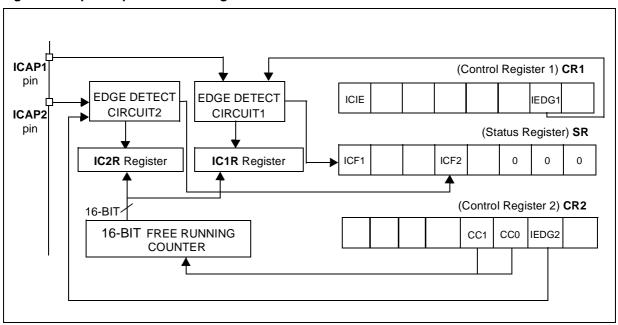
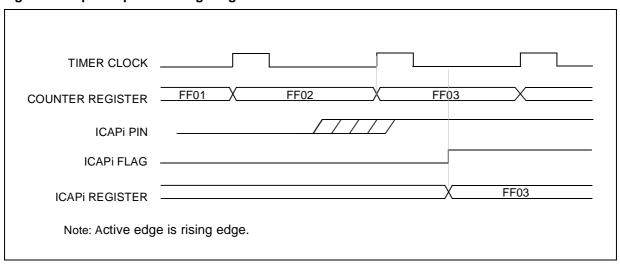


Figure 31. Input Capture Timing Diagram



12.2.3.4 Output Compare

In this section, the index, *i*, may be 1 or 2 because there are 2 output compare functions in the 16-bit timer.

This function can be used to control an output waveform or indicate when a period of time has elapsed.

When a match is found between the Output Compare register and the free running counter, the output compare function:

- Assigns pins with a programmable value if the OCIE bit is set
- Sets a flag in the status register
- Generates an interrupt if enabled

Two 16-bit registers Output Compare Register 1 (OC1R) and Output Compare Register 2 (OC2R) contain the value to be compared to the counter register each timer clock cycle.

	MS Byte	LS Byte
OC <i>i</i> R	OC <i>i</i> HR	OC <i>i</i> LR

These registers are readable and writable and are not affected by the timer hardware. A reset event changes the OCiR value to 8000h.

Timing resolution is one count of the free running counter: $(f_{CPLI/CC[1:0]})$.

Procedure:

To use the output compare function, select the following in the CR2 register:

- Set the OCiE bit if an output is needed then the OCMPi pin is dedicated to the output compare i signal.
- Select the timer clock (CC[1:0]) (see Table 13 Clock Control Bits).

And select the following in the CR1 register:

- Select the OLVLibit to applied to the OCMPipins after the match occurs.
- Set the OCIE bit to generate an interrupt if it is needed.

When a match is found between OCRi register and CR register:

- OCFi bit is set.

- The OCMPi pin takes OLVLi bit value (OCMPi pin latch is forced low during reset).
- A timer interrupt is generated if the OCIE bit is set in the CR2 register and the I bit is cleared in the CC register (CC).

The OCiR register value required for a specific timing application can be calculated using the following formula:

$$\Delta \text{ OC} iR = \frac{\Delta t * f_{CPU}}{\text{PRESC}}$$

Where:

 Δt = Output compare period (in seconds)

 f_{CPU} = CPU clock frequency (in hertz)

PRESC = Timer prescaler factor (2, 4 or 8 depending on CC[1:0] bits, see Table 13

Clock Control Bits)

If the timer clock is an external clock, the formula is:

$$\Delta \text{ OC} iR = \Delta t * f_{\text{FXT}}$$

Where:

 Δt = Output compare period (in seconds)

f_{EXT} = External timer clock frequency (in hertz)

Clearing the output compare interrupt request (i.e. clearing the OCF*i* bit) is done by:

- 1. Reading the SR register while the OCF*i* bit is set.
- 2. An access (read or write) to the OCiLR register.

The following procedure is recommended to prevent the OCF*i* bit from being set between the time it is read and the write to the OC*i*R register:

- Write to the OCiHR register (further compares are inhibited).
- Read the SR register (first step of the clearance of the OCFi bit, which may be already set).
- Write to the OCiLR register (enables the output compare function and clears the OCFi bit).

Notes:

- After a processor write cycle to the OCiHR register, the output compare function is inhibited until the OCiLR register is also written.
- 2. If the OCiE bit is not set, the OCMPi pin is a general I/O port and the OLVLi bit will not appear when a match is found but an interrupt could be generated if the OCIE bit is set.
- 3. When the timer clock is f_{CPU}/2, OCF*i* and OCMP*i* are set while the counter value equals the OC*i*R register value (see Figure 33 on page 53). This behaviour is the same in OPM or PWM mode.
 - When the timer clock is f_{CPU}/4, f_{CPU}/8 or in external clock mode, OCF*i* and OCMP*i* are set while the counter value equals the OC*i*R register value plus 1 (see Figure 34 on page 53).
- The output compare functions can be used both for generating external events on the OCMPi pins even if the input capture mode is also used.
- 5. The value in the 16-bit OC*i*R register and the OLV*i* bit should be changed after each successful comparison in order to control an output waveform or establish a new elapsed timeout.

Forced Compare Output capability

When the FOLVi bit is set by software, the OLVLi bit is copied to the OCMPi pin. The OLVi bit has to be toggled in order to toggle the OCMPi pin when it is enabled (OCiE bit=1). The OCFi bit is then not set by hardware, and thus no interrupt request is generated.

FOLVL*i* bits have no effect in either One-Pulse mode or PWM mode.

Figure 32. Output Compare Block Diagram

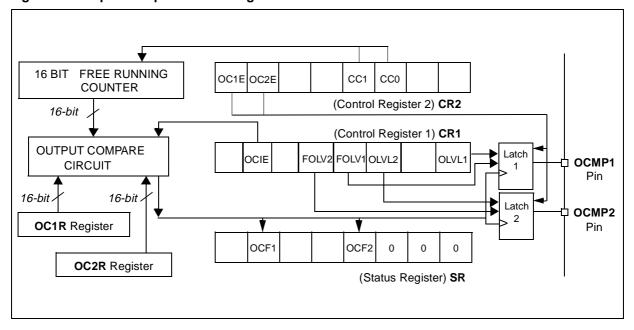


Figure 33. Output Compare Timing Diagram, $f_{TIMER} = f_{CPU}/2$

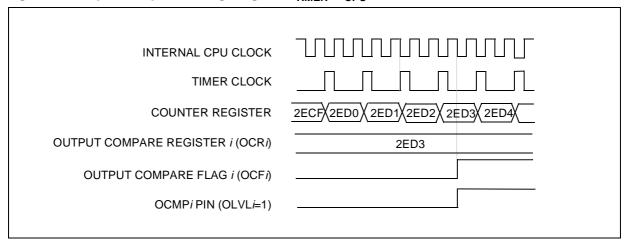
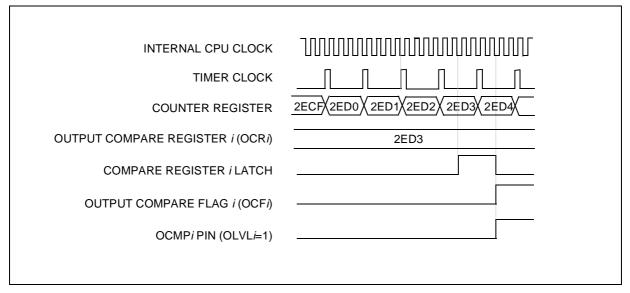


Figure 34. Output Compare Timing Diagram, f_{TIMER} =f_{CPU}/4



12.2.3.5 One Pulse Mode

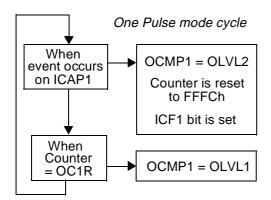
One Pulse mode enables the generation of a pulse when an external event occurs. This mode is selected via the OPM bit in the CR2 register.

The One Pulse mode uses the Input Capture1 function and the Output Compare1 function.

Procedure:

To use One Pulse mode:

- Load the OC1R register with the value corresponding to the length of the pulse (see the formula in the opposite column).
- 2. Select the following in the CR1 register:
 - Using the OLVL1 bit, select the level to be applied to the OCMP1 pin after the pulse.
 - Using the OLVL2 bit, select the level to be applied to the OCMP1 pin during the pulse.
 - Select the edge of the active transition on the ICAP1 pin with the IEDG1 bit (the ICAP1 pin must be configured as floating input).
- 3. Select the following in the CR2 register:
 - Set the OC1E bit, the OCMP1 pin is then dedicated to the Output Compare 1 function.
 - Set the OPM bit.
 - Select the timer clock CC[1:0] (see Table 13 Clock Control Bits).



Then, on a valid event on the ICAP1 pin, the counter is initialized to FFFCh and the OLVL2 bit is loaded on the OCMP1 pin, the ICF1 bit is set and the value FFFDh is loaded in the IC1R register.

Because the ICF1 bit is set when an active edge occurs, an interrupt can be generated if the ICIE bit is set.

Clearing the Input Capture interrupt request (i.e. clearing the ICF*i* bit) is done in two steps:

- 1. Reading the SR register while the ICF*i* bit is set.
- 2. An access (read or write) to the ICiLR register.

The OC1R register value required for a specific timing application can be calculated using the following formula:

OC/R Value =
$$\frac{t \cdot f_{CPU}}{PRESC} - 5$$

Where:

= Pulse period (in seconds)

 f_{CPII} = CPU clock frequency (in hertz)

PRESC = Timer prescaler factor (2, 4 or 8 depending on the CC[1:0] bits, see Table 13 Clock Control Bits)

If the timer clock is an external clock the formula is:

$$OCiR = t * f_{EXT} - 5$$

Where:

t = Pulse period (in seconds)

f_{EXT} = External timer clock frequency (in hertz)

When the value of the counter is equal to the value of the contents of the OC1R register, the OLVL1 bit is output on the OCMP1 pin (see Figure 35).

Notes:

- 1. The OCF1 bit cannot be set by hardware in One Pulse mode but the OCF2 bit can generate an Output Compare interrupt.
- 2. When the Pulse Width Modulation (PWM) and One Pulse mode (OPM) bits are both set, the PWM mode is the only active one.
- 3. If OLVL1=OLVL2 a continuous signal will be seen on the OCMP1 pin.
- 4. The ICAP1 pin can not be used to perform input capture. The ICAP2 pin can be used to perform input capture (ICF2 can be set and IC2R can be loaded) but the user must take care that the counter is reset each time a valid edge occurs on the ICAP1 pin and ICF1 can also generates interrupt if ICIE is set.
- 5. When One Pulse mode is used OC1R is dedicated to this mode. Nevertheless OC2R and OCF2 can be used to indicate that a period of time has elapsed but cannot generate an output waveform because the OLVL2 level is dedicated to One Pulse mode.

Figure 35. One Pulse Mode Timing Example

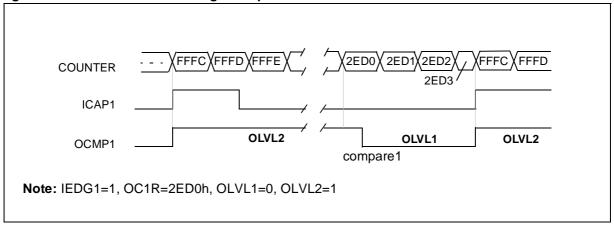
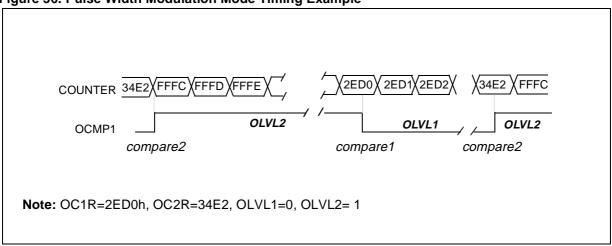


Figure 36. Pulse Width Modulation Mode Timing Example



12.2.3.6 Pulse Width Modulation Mode

Pulse Width Modulation (PWM) mode enables the generation of a signal with a frequency and pulse length determined by the value of the OC1R and OC2R registers.

The Pulse Width Modulation mode uses the complete Output Compare 1 function plus the OC2R register, and so these functions cannot be used when the PWM mode is activated.

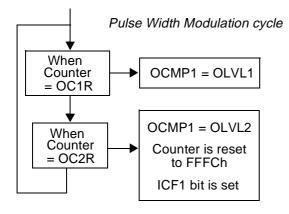
Procedure

To use Pulse Width Modulation mode:

- 1. Load the OC2R register with the value corresponding to the period of the signal using the formula in the opposite column.
- Load the OC1R register with the value corresponding to the period of the pulse if OLVL1=0 and OLVL2=1, using the formula in the opposite column.
- 3. Select the following in the CR1 register:
 - Using the OLVL1 bit, select the level to be applied to the OCMP1 pin after a successful comparison with OC1R register.
 - Using the OLVL2 bit, select the level to be applied to the OCMP1 pin after a successful comparison with OC2R register.
- 4. Select the following in the CR2 register:
 - Set OC1E bit: the OCMP1 pin is then dedicated to the output compare 1 function.
 - Set the PWM bit.
 - Select the timer clock (CC[1:0]) (see Table 13 Clock Control Bits).

If OLVL1=1 and OLVL2=0, the length of the positive pulse is the difference between the OC2R and OC1R registers.

If OLVL1=OLVL2 a continuous signal will be seen on the OCMP1 pin.



The OCiR register value required for a specific timing application can be calculated using the following formula:

$$OC_{iR} Value = \frac{t * f_{CPU}}{PRESC} - 5$$

Where:

= Signal or pulse period (in seconds)

f_{CPU} = CPU clock frequency (in hertz)

PRESC = Timer prescaler factor (2, 4 or 8 depending on CC[1:0] bits, see Table 13 Clock Control Bits)

If the timer clock is an external clock the formula is:

$$OCiR = t * f_{FXT} - 5$$

Where:

t = Signal or pulse period (in seconds)

f_{EXT} = External timer clock frequency (in hertz)

The Output Compare 2 event causes the counter to be initialized to FFFCh (See Figure 36)

Notes:

- After a write instruction to the OCiHR register, the output compare function is inhibited until the OCiLR register is also written.
- The OCF1 and OCF2 bits cannot be set by hardware in PWM mode, therefore the Output Compare interrupt is inhibited.
- The ICF1 bit is set by hardware when the counter reaches the OC2R value and can produce a timer interrupt if the ICIE bit is set and the I bit is cleared.
- 4. In PWM mode the ICAP1 pin can not be used to perform input capture because it is disconnected from the timer. The ICAP2 pin can be used to perform input capture (ICF2 can be set and IC2R can be loaded) but the user must take care that the counter is reset after each period and ICF1 can also generate an interrupt if ICIE is set.
- When the Pulse Width Modulation (PWM) and One Pulse mode (OPM) bits are both set, the PWM mode is the only active one.

12.2.4 Low Power Modes

Mode	Description
WAIT	No effect on 16-bit Timer. Timer interrupts cause the device to exit from WAIT mode.
	16-bit Timer registers are frozen.
HALT	In HALT mode, the counter stops counting until Halt mode is exited. Counting resumes from the previous count when the MCU is woken up by an interrupt with "exit from HALT mode" capability or from the counter reset value when the MCU is woken up by a RESET.
	If an input capture event occurs on the ICAP <i>i</i> pin, the input capture detection circuitry is armed. Consequently, when the MCU is woken up by an interrupt with "exit from HALT mode" capability, the ICF <i>i</i> bit is set, and the counter value present when exiting from HALT mode is captured into the IC <i>i</i> R register.

12.2.5 Interrupts

Interrupt Event	Event Flag	Enable Control Bit	Exit from Wait	Exit from Halt
Input Capture 1 event/Counter reset in PWM mode	ICF1	ICIE	Yes	No
Input Capture 2 event	ICF2	ICIE	Yes	No
Output Compare 1 event (not available in PWM mode)	OCF1	OCIE	Yes	No
Output Compare 2 event (not available in PWM mode)	OCF2	JOOIE	Yes	No
Timer Overflow event	TOF	TOIE	Yes	No

Note: The 16-bit Timer interrupt events are connected to the same interrupt vector (see Interrupts chapter). These events generate an interrupt if the corresponding Enable Control Bit is set and the interrupt mask in the CC register is reset (RIM instruction).

12.2.6 Summary of Timer modes

MODES	AVAILABLE RESOURCES								
MODES	Input Capture 1	Input Capture 2	Output Compare 1	Output Compare 2					
Input Capture (1 and/or 2)	Yes	Yes	Yes	Yes					
Output Compare (1 and/or 2)	Yes	Yes	Yes	Yes					
One Pulse mode	No	Not Recommended ¹⁾	No	Partially ²⁾					
PWM Mode	No	Not Recommended ³⁾	No	No					

¹⁾ See note 4 in Section 12.2.3.5 "One Pulse Mode" on page 54

A7/

²⁾ See note 5 in Section 12.2.3.5 "One Pulse Mode" on page 54

³⁾ See note 4 in Section 12.2.3.6 "Pulse Width Modulation Mode" on page 56

12.2.7 Register Description

Each Timer is associated with three control and status registers, and with six pairs of data registers (16-bit values) relating to the two input captures, the two output compares, the counter and the alternate counter.

CONTROL REGISTER 1 (CR1)

Read/Write

Reset Value: 0000 0000 (00h)

7							0	_
ICIE	OCIE	TOIE	FOLV2	FOLV1	OLVL2	IEDG1	OLVL1	

Bit 7 = ICIE Input Capture Interrupt Enable.

0: Interrupt is inhibited.

1: A timer interrupt is generated whenever the ICF1 or ICF2 bit of the SR register is set.

Bit 6 = **OCIE** *Output Compare Interrupt Enable.* 0: Interrupt is inhibited.

1: A timer interrupt is generated whenever the OCF1 or OCF2 bit of the SR register is set.

Bit 5 = **TOIE** *Timer Overflow Interrupt Enable*. 0: Interrupt is inhibited.

 A timer interrupt is enabled whenever the TOF bit of the SR register is set. Bit 4 = **FOLV2** Forced Output Compare 2.

This bit is set and cleared by software.

- 0: No effect on the OCMP2 pin.
- 1: Forces the OLVL2 bit to be copied to the OCMP2 pin, if the OC2E bit is set and even if there is no successful comparison.

Bit 3 = **FOLV1** Forced Output Compare 1.

This bit is set and cleared by software.

- 0: No effect on the OCMP1 pin.
- Forces OLVL1 to be copied to the OCMP1 pin, if the OC1E bit is set and even if there is no successful comparison.

Bit 2 = **OLVL2** Output Level 2.

This bit is copied to the OCMP2 pin whenever a successful comparison occurs with the OC2R register and OCxE is set in the CR2 register. This value is copied to the OCMP1 pin in One Pulse mode and Pulse Width Modulation mode.

Bit 1 = **IEDG1** Input Edge 1.

This bit determines which type of level transition on the ICAP1 pin will trigger the capture.

- 0: A falling edge triggers the capture.
- 1: A rising edge triggers the capture.

Bit 0 = **OLVL1** Output Level 1.

The OLVL1 bit is copied to the OCMP1 pin whenever a successful comparison occurs with the OC1R register and the OC1E bit is set in the CR2 register.

CONTROL REGISTER 2 (CR2)

Read/Write

Reset Value: 0000 0000 (00h)

7 0
OC1E OC2E OPM PWM CC1 CC0 IEDG2 EXEDG

Bit 7 = **OC1E** Output Compare 1 Pin Enable.

This bit is used only to output the signal from the timer on the OCMP1 pin (OLV1 in Output Compare mode, both OLV1 and OLV2 in PWM and one-pulse mode). Whatever the value of the OC1E bit, the internal Output Compare 1 function of the timer remains active.

- 0: OCMP1 pin alternate function disabled (I/O pin free for general-purpose I/O).
- 1: OCMP1 pin alternate function enabled.

Bit 6 = **OC2E** Output Compare 2 Pin Enable.

This bit is used only to output the signal from the timer on the OCMP2 pin (OLV2 in Output Compare mode). Whatever the value of the OC2E bit, the internal Output Compare 2 function of the timer remains active.

- 0: OCMP2 pin alternate function disabled (I/O pin free for general-purpose I/O).
- 1: OCMP2 pin alternate function enabled.

Bit 5 = **OPM** One Pulse mode.

- 0: One Pulse mode is not active.
- 1: One Pulse mode is active, the ICAP1 pin can be used to trigger one pulse on the OCMP1 pin; the active transition is given by the IEDG1 bit. The length of the generated pulse depends on the contents of the OC1R register.

Bit 4 = **PWM** Pulse Width Modulation.

- 0: PWM mode is not active.
- 1: PWM mode is active, the OCMP1 pin outputs a programmable cyclic signal; the length of the pulse depends on the value of OC1R register; the period depends on the value of OC2R register

Bits 3:2 = CC[1:0] Clock Control.

The timer clock mode depends on these bits:

Table 13. Clock Control Bits

Timer Clock	CC1	CC0
f _{CPU} / 4	0	0
f _{CPU} / 2	0	1
f _{CPU} / 8	1	0
External Clock (where available)	1	1

Note: If the external clock pin is not available, programming the external clock configuration stops the counter.

Bit 1 = **IEDG2** Input Edge 2.

This bit determines which type of level transition on the ICAP2 pin will trigger the capture.

- 0: A falling edge triggers the capture.
- 1: A rising edge triggers the capture.

Bit 0 = **EXEDG** External Clock Edge.

This bit determines which type of level transition on the external clock pin (EXTCLK) will trigger the counter register.

- 0: A falling edge triggers the counter register.
- 1: A rising edge triggers the counter register.

16-BIT TIMER (Cont'd) STATUS REGISTER (SR)

Read Only

Reset Value: 0000 0000 (00h)

The three least significant bits are not used.

7						_	0
ICF1	OCF1	TOF	ICF2	OCF2	0	0	0

Bit 7 = ICF1 Input Capture Flag 1.

- 0: No input capture (reset value).
- 1: An input capture has occurred on the ICAP1 pin or the counter has reached the OC2R value in PWM mode. To clear this bit, first read the SR register, then read or write the low byte of the IC1R (IC1LR) register.

Bit 6 = **OCF1** Output Compare Flag 1.

0: No match (reset value).

1: The content of the free running counter matches the content of the OC1R register. To clear this bit, first read the SR register, then read or write the low byte of the OC1R (OC1LR) register.

Bit 5 = **TOF** *Timer Overflow Flag.*

0: No timer overflow (reset value).

1: The free running counter has rolled over from FFFFh to 0000h. To clear this bit, first read the SR register, then read or write the low byte of the CR (CLR) register.

Note: Reading or writing the ACLR register does not clear TOF.

Bit 4 = ICF2 Input Capture Flag 2.

0: No input capture (reset value).

1: An input capture has occurred on the ICAP2 pin. To clear this bit, first read the SR register, then read or write the low byte of the IC2R (IC2LR) register.

Bit 3 = OCF2 Output Compare Flag 2.

0: No match (reset value).

1: The content of the free running counter matches the content of the OC2R register. To clear this bit, first read the SR register, then read or write the low byte of the OC2R (OC2LR) register.

Bit 2-0 = Reserved, forced by hardware to 0.

INPUT CAPTURE 1 HIGH REGISTER (IC1HR)

Read Only

Reset Value: Undefined

This is an 8-bit read only register that contains the high part of the counter value (transferred by the input capture 1 event).

7				0
MSB				LSB

INPUT CAPTURE 1 LOW REGISTER (IC1LR)

Read Only

Reset Value: Undefined

This is an 8-bit read only register that contains the low part of the counter value (transferred by the input capture 1 event).

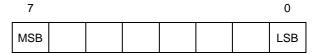
7				0
MSB				LSB

OUTPUT COMPARE 1 HIGH REGISTER (OC1HR)

Read/Write

Reset Value: 1000 0000 (80h)

This is an 8-bit register that contains the high part of the value to be compared to the CHR register.



OUTPUT COMPARE 1 LOW REGISTER (OC1LR)

Read/Write

Reset Value: 0000 0000 (00h)

This is an 8-bit register that contains the low part of the value to be compared to the CLR register.

7				0
MSB				LSB

OUTPUT COMPARE 2 HIGH REGISTER (OC2HR)

Read/Write

Reset Value: 1000 0000 (80h)

This is an 8-bit register that contains the high part of the value to be compared to the CHR register.

7	_	_	_	_	_	0
MSB						LSB

OUTPUT COMPARE 2 LOW REGISTER

(OC2LR) Read/Write

Reset Value: 0000 0000 (00h)

This is an 8-bit register that contains the low part of the value to be compared to the CLR register.

7				0
MSB				LSB

COUNTER HIGH REGISTER (CHR)

Reset Value: 1111 1111 (FFh)

This is an 8-bit register that contains the high part of the counter value.

7				0
MSB				LSB

COUNTER LOW REGISTER (CLR)

Read Only

Reset Value: 1111 1100 (FCh)

This is an 8-bit register that contains the low part of the counter value. A write to this register resets the counter. An access to this register after accessing the SR register clears the TOF bit.

7				0
MSB				LSB

ALTERNATE COUNTER HIGH REGISTER (ACHR)

Read Only

Reset Value: 1111 1111 (FFh)

This is an 8-bit register that contains the high part of the counter value.

7	_	_	_	_	_	_	0
MSB							LSB

ALTERNATE COUNTER LOW REGISTER (ACLR)

Read Only

Reset Value: 1111 1100 (FCh)

This is an 8-bit register that contains the low part of the counter value. A write to this register resets the counter. An access to this register after an access to SR register does not clear the TOF bit in SR register.

7				0
MSB				LSB

INPUT CAPTURE 2 HIGH REGISTER (IC2HR)

Read Only

Reset Value: Undefined

This is an 8-bit read only register that contains the high part of the counter value (transferred by the

Input Capture 2 event).

7				0
MSB				LSB

INPUT CAPTURE 2 LOW REGISTER (IC2LR)

Read Only

Reset Value: Undefined

This is an 8-bit read only register that contains the low part of the counter value (transferred by the Input Capture 2 event).

7				0
MSB				LSB

Table 14. 16-Bit Timer Register Map and Reset Values

Address (Hex.)	Register Label	7	6	5	4	3	2	1	0
Timer A: 32	CR1	ICIE	OCIE	TOIE	FOLV2	FOLV1	OLVL2	IEDG1	OLVL1
Timer B: 42	Reset Value	0	0	0	0	0	0	0	0
Timer A: 31	CR2	OC1E	OC2E	ОРМ	PWM	CC1	CC0	IEDG2	EXEDG
Timer B: 41	Reset Value	0	0	0	0	0	0	0	0
Timer A: 33	SR	ICF1	OCF1	TOF	ICF2	OCF2	-	-	-
Timer B: 43	Reset Value	0	0	0	0	0	0	0	0
Timer A: 34 Timer B: 44		MSB -	-	-	-	-	-	-	LSB -
Timer A: 35 Timer B: 45		MSB -	-	-	-	-	-	-	LSB -
Timer A: 36 Timer B: 46		MSB -	-	-	-	-	-	-	LSB -
Timer A: 37 Timer B: 47	OCLR1 Reset Value	MSB -	-	-	-	-	-	-	LSB -
Timer A: 3E Timer B: 4E		MSB -	1	1	-	-	-	-	LSB -
Timer A: 3F Timer B: 4F	OCLR2 Reset Value	MSB -	1	1	1	-	-	-	LSB -
Timer A: 38 Timer B: 48	CHR Reset Value	MSB 1	1	1	1	1	1	1	LSB 1
Timer A: 39 Timer B: 49	CLR Reset Value	MSB 1	1	1	1	1	1	0	LSB 0
Timer A: 3A Timer B: 4A		MSB 1	1	1	1	1	1	1	LSB 1
Timer A: 3B Timer B: 4B		MSB 1	1	1	1	1	1	0	LSB 0
Timer A: 3C Timer B: 4C		MSB -	-	-	-	-	-	-	LSB -
Timer A: 3D Timer B: 4D	ICLR2 Reset Value	MSB -	-	-	-	-	-	-	LSB -

12.3 SERIAL PERIPHERAL INTERFACE (SPI)

12.3.1 Introduction

The Serial Peripheral Interface (SPI) allows fullduplex, synchronous, serial communication with external devices. An SPI system may consist of a master and one or more slaves or a system in which devices may be either masters or slaves.

The SPI is normally used for communication between the microcontroller and external peripherals or another microcontroller.

Refer to the Pin Description chapter for the devicespecific pin-out.

12.3.2 Main Features

- Full duplex, three-wire synchronous transfers
- Master or slave operation
- Four master mode frequencies
- Maximum slave mode frequency = fCPU/2.
- Four programmable master bit rates
- Programmable clock polarity and phase
- End of transfer interrupt flag
- Write collision flag protection
- Master mode fault protection capability.

12.3.3 General description

The SPI is connected to external devices through 4 alternate pins:

- MISO: Master In Slave Out pin - MOSI: Master Out Slave In pin

- SCK: Serial Clock pin - SS: Slave select pin

A basic example of interconnections between a single master and a single slave is illustrated on Figure 37.

The MOSI pins are connected together as are MISO pins. In this way data is transferred serially between master and slave (most significant bit

When the master device transmits data to a slave device via MOSI pin, the slave device responds by sending data to the master device via the MISO pin. This implies full duplex transmission with both data out and data in synchronized with the same clock signal (which is provided by the master device via the SCK pin).

Thus, the byte transmitted is replaced by the byte received and eliminates the need for separate transmit-empty and receiver-full bits. A status flag is used to indicate that the I/O operation is complete.

Four possible data/clock timing relationships may be chosen (see Figure 40) but master and slave must be programmed with the same timing mode.

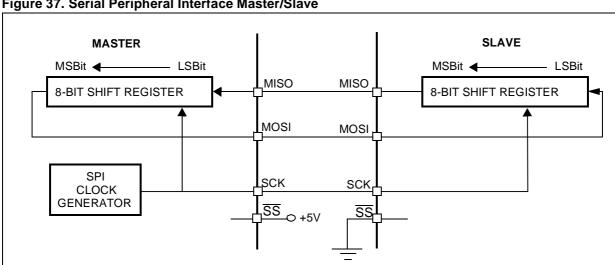
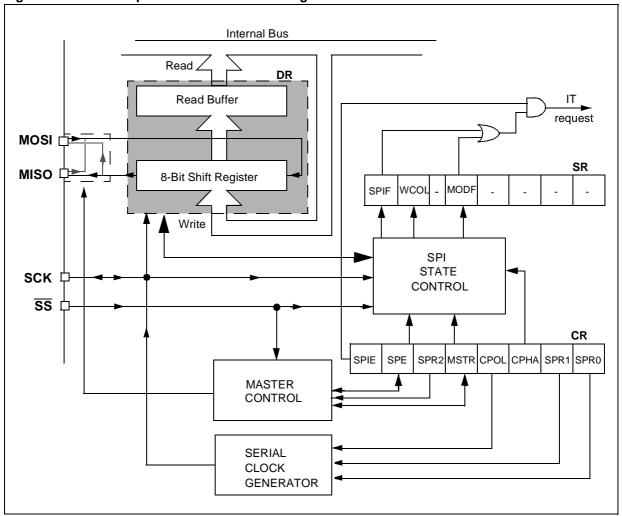


Figure 37. Serial Peripheral Interface Master/Slave

Figure 38. Serial Peripheral Interface Block Diagram



12.3.4 Functional Description

Figure 37 shows the serial peripheral interface (SPI) block diagram.

This interface contains 3 dedicated registers:

- A Control Register (CR)
- A Status Register (SR)
- A Data Register (DR)

Refer to the CR, SR and DR registers in Section 12.3.7for the bit definitions.

12.3.4.1 Master Configuration

In a master configuration, the serial clock is generated on the SCK pin.

Procedure

- Select the SPR0 & SPR1 bits to define the serial clock baud rate (see CR register).
- Select the CPOL and CPHA bits to define one of the four relationships between the data transfer and the serial clock (see Figure 40).
- The SS pin must be connected to a high level signal during the complete byte transmit sequence.
- The MSTR and SPE <u>bits</u> must be set (they remain set only if the SS pin is connected to a high level signal).

In this configuration the MOSI pin is a data output and to the MISO pin is a data input.

Transmit sequence

The transmit sequence begins when a byte is written the DR register.

The data byte is parallel loaded into the 8-bit shift register (from the internal bus) during a write cycle and then shifted out serially to the MOSI pin most significant bit first.

When data transfer is complete:

- The SPIF bit is set by hardware
- An interrupt is generated if the SPIE bit is set and the I bit in the CCR register is cleared.

During the last clock cycle the SPIF bit is set, a copy of the data byte received in the shift register is moved to a buffer. When the DR register is read, the SPI peripheral returns this buffered value.

Clearing the SPIF bit is performed by the following software sequence:

- An access to the SR register while the SPIF bit is set
- 2. A read to the DR register.

Note: While the SPIF bit is set, all writes to the DR register are inhibited until the SR register is read.

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SERIAL PERIPHERAL INTERFACE (Cont'd) 12.3.4.2 Slave Configuration

In slave configuration, the serial clock is received on the SCK pin from the master device.

The value of the SPR0 & SPR1 bits is not used for the data transfer.

Procedure

- For correct data transfer, the slave device must be in the same timing mode as the master device (CPOL and CPHA bits). See Figure 40.
- The SS pin must be connected to a low level signal during the complete byte transmit sequence.
- Clear the MSTR bit and set the SPE bit to assign the pins to alternate function.

In this configuration the MOSI pin is a data input and the MISO pin is a data output.

Transmit Sequence

The data byte is parallel loaded into the 8-bit shift register (from the internal bus) during a write cycle and then shifted out serially to the MISO pin most significant bit first.

The transmit sequence begins when the slave device receives the clock signal and the most significant bit of the data on its MOSI pin.

When data transfer is complete:

- The SPIF bit is set by hardware
- An interrupt is generated if SPIE bit is set and I bit in CCR register is cleared.

During the last clock cycle the SPIF bit is set, a copy of the data byte received in the shift register is moved to a buffer. When the DR register is read, the SPI peripheral returns this buffered value.

Clearing the SPIF bit is performed by the following software sequence:

- An access to the SR register while the SPIF bit is set.
- 2.A read to the DR register.

Notes: While the SPIF bit is set, all writes to the DR register are inhibited until the SR register is read.

The SPIF bit can be cleared during a second transmission; however, it must be cleared before the second SPIF bit in order to prevent an overrun condition (see Section 12.3.4.6).

Depending on the CPHA bit, the \overline{SS} pin has to be set to write to the DR register between each data byte transfer to avoid a write collision (see Section 12.3.4.4).

SERIAL PERIPHERAL INTERFACE (Cont'd) 12.3.4.3 Data Transfer Format

During an SPI transfer, data is simultaneously transmitted (shifted out serially) and received (shifted in serially). The serial clock is used to synchronize the data transfer during a sequence of eight clock pulses.

The \overline{SS} pin allows individual selection of a slave device; the other slave devices that are not selected do not interfere with the SPI transfer.

Clock Phase and Clock Polarity

Four possible timing relationships may be chosen by software, using the CPOL and CPHA bits.

The CPOL (clock polarity) bit controls the steady state value of the clock when no data is being transferred. This bit affects both master and slave modes.

The combination between the CPOL and CPHA (clock phase) bits selects the data capture clock edge.

Figure 40, shows an SPI transfer with the four combinations of the CPHA and CPOL bits. The diagram may be interpreted as a master or slave timing diagram where the SCK pin, the MISO pin, the MOSI pin are directly connected between the master and the slave device.

The SS pin is the slave device select input and can be driven by the master device.

The master device applies data to its MOSI pinclock edge before the capture clock edge.

CPHA bit is set

The second edge on the SCK pin (falling edge if the CPOL bit is reset, rising edge if the CPOL bit is set) is the MSBit capture strobe. Data is latched on the occurrence of the second clock transition.

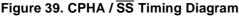
No write collision should occur even if the \overline{SS} pin stays low during a transfer of several bytes (see Figure 39).

CPHA bit is reset

The first edge on the SCK pin (falling edge if CPOL bit is set, rising edge if CPOL bit is reset) is the MSBit capture strobe. Data is latched on the occurrence of the first clock transition.

The \overline{SS} pin must be toggled high and low between each byte transmitted (see Figure 39).

To protect the transmission from a write collision a low value on the \overline{SS} pin of a slave device freezes the data in its DR register and does not allow it to be altered. Therefore the \overline{SS} pin must be high to write a new data byte in the DR without producing a write collision.



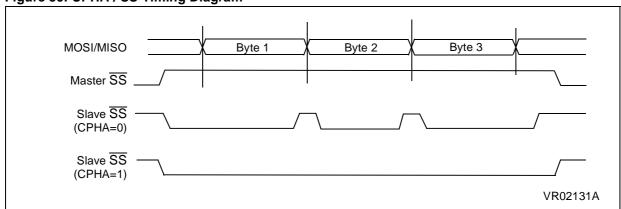
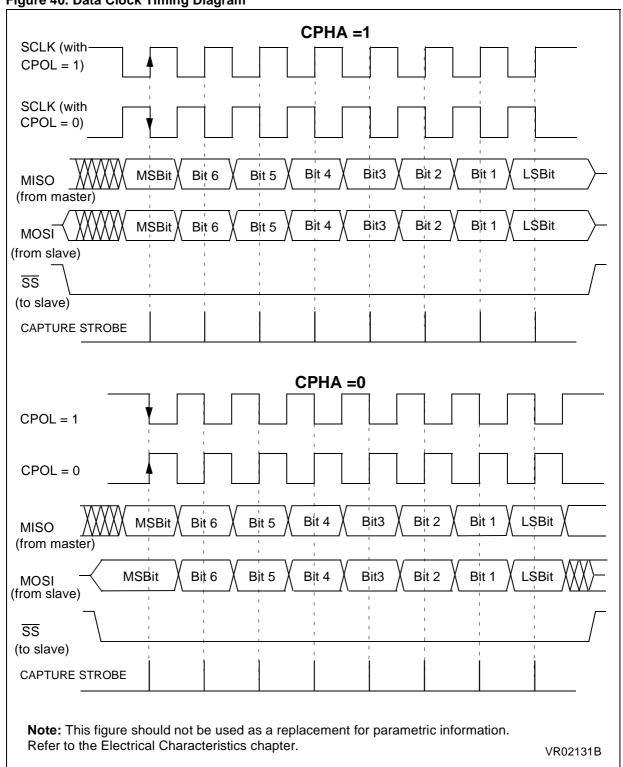


Figure 40. Data Clock Timing Diagram



12.3.4.4 Write Collision Error

A write collision occurs when the software tries to write to the DR register while a data transfer is taking place with an external device. When this happens, the transfer continues uninterrupted; and the software write will be unsuccessful.

Write collisions can occur both in master and slave mode.

Note: a "read collision" will never occur since the received data byte is placed in a buffer in which access is always synchronous with the MCU operation.

In Slave mode

When the CPHA bit is set:

The slave device will receive a clock (SCK) edge prior to the latch of the first data transfer. This first clock edge will freeze the data in the slave device DR register and output the MSBit on to the external MISO pin of the slave device.

The SS pin low state enables the slave device but the output of the MSBit onto the MISO pin does not take place until the first data transfer clock edge. When the CPHA bit is reset:

Data is latched on the occurrence of the first clock transition. The slave device does not have any way of knowing when that transition will occur; therefore, the slave device collision occurs when software attempts to write the DR register after its \overline{SS} pin has been pulled low.

For this reason, the \overline{SS} pin must be high, between each data byte transfer, to allow the CPU to write in the DR register without generating a write collision.

In Master mode

Collision in the master device is defined as a write of the DR register while the internal serial clock (SCK) is in the process of transfer.

The \overline{SS} pin signal must be always high on the master device.

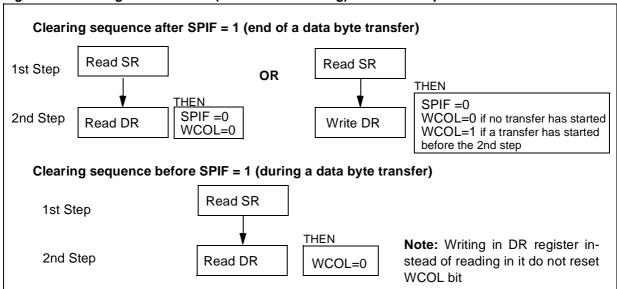
WCOL bit

The WCOL bit in the SR register is set if a write collision occurs.

No SPI interrupt is generated when the WCOL bit is set (the WCOL bit is a status flag only).

Clearing the WCOL bit is done through a software sequence (see Figure 41).

Figure 41. Clearing the WCOL bit (Write Collision Flag) Software Sequence



12.3.4.5 Master Mode Fault

Master mode fault occurs when the master device has its SS pin pulled low, then the MODF bit is set. Master mode fault affects the SPI peripheral in the following ways:

- The MODF bit is set and an SPI interrupt is generated if the SPIE bit is set.
- The SPE bit is reset. This blocks all output from the device and disables the SPI peripheral.
- The MSTR bit is reset, thus forcing the device into slave mode.

Clearing the MODF bit is done through a software sequence:

- A read or write access to the SR register while the MODF bit is set.
- 2. A write to the CR register.

Notes: To avoid any multiple slave conflicts in the case of a system comprising several MCUs, the SS pin must be pulled high during the clearing sequence of the MODF bit. The SPE and MSTR bits

may be restored to their original state during or after this clearing sequence.

Hardware does not allow the user to set the SPE and MSTR bits while the MODF bit is set except in the MODF bit clearing sequence.

In a slave device the MODF bit can not be set, but in a multi master configuration the device can be in slave mode with this MODF bit set.

The MODF bit indicates that there might have been a multi-master conflict for system control and allows a proper exit from system operation to a reset or default system state using an interrupt routine.

12.3.4.6 Overrun Condition

An overrun condition occurs when the master device has sent several data bytes and the slave device has not cleared the SPIF bit issuing from the previous data byte transmitted.

In this case, the receiver buffer contains the byte sent after the SPIF bit was last cleared. A read to the DR register returns this byte. All other bytes are lost.

This condition is not detected by the SPI peripheral.

12.3.4.7 Single Master and Multimaster Configurations

There are two types of SPI systems:

- Single Master System
- Multimaster System

Single Master System

A typical single master system may be configured. using an MCU as the master and four MCUs as slaves (see Figure 42).

The master device selects the individual slave devices by using four pins of a parallel port to control the four SS pins of the slave devices.

The \overline{SS} pins are pulled high during reset since the master device ports will be forced to be inputs at that time, thus disabling the slave devices.

Note: To prevent a bus conflict on the MISO line the master allows only one active slave device during a transmission.

Figure 42. Single Master Configuration

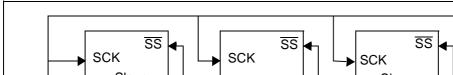
For more security, the slave device may respond to the master with the received data byte. Then the master will receive the previous byte back from the slave device if all MISO and MOSI pins are connected and the slave has not written its DR regis-

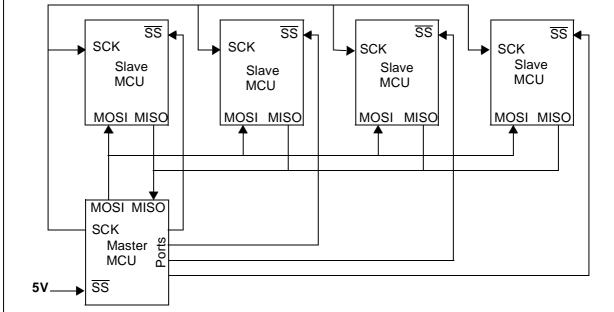
Other transmission security methods can use ports for handshake lines or data bytes with command fields.

Multi-master System

A multi-master system may also be configured by the user. Transfer of master control could be implemented using a handshake method through the I/O ports or by an exchange of code messages through the serial peripheral interface system.

The multi-master system is principally handled by the MSTR bit in the CR register and the MODF bit in the SR register.





12.3.5 Low Power Modes

Mode	Description
WAIT	No effect on SPI. SPI interrupt events cause the device to exit from WAIT mode.
HALT	SPI registers are frozen. In HALT mode, the SPI is inactive. SPI operation resumes when the MCU is woken up by an interrupt with "exit from HALT mode" capability.

12.3.6 Interrupts

Interrupt Event	Event Flag	Enable Control Bit	Exit from Wait	Exit from Halt
SPI End of Transfer Event	SPIF	SPIE	Yes	No
Master Mode Fault Event	MODF	SFIL	Yes	No

Note: The SPI interrupt events are connected to the same interrupt vector (see Interrupts chapter). They generate an interrupt if the corresponding Enable Control Bit is set and the interrupt mask in the CC register is reset (RIM instruction).

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SERIAL PERIPHERAL INTERFACE (Cont'd) 12.3.7 Register Description CONTROL REGISTER (CR)

Read/Write

Reset Value: 0000xxxx (0xh)



Bit 7 = **SPIE** Serial peripheral interrupt enable. This bit is set and cleared by software.

0: Interrupt is inhibited

1: An SPI interrupt is generated whenever SPIF=1 or MODF=1 in the SR register

Bit 6 = **SPE** Serial peripheral output enable.

This bit is set and cleared by software. It is also cleared by hardware when, in master mode, \overline{SS} =0 (see Section 12.3.4.5 "Master Mode Fault" on page 70).

0: I/O port connected to pins

1: SPI alternate functions connected to pins

The SPE bit is cleared by reset, so the SPI peripheral is not initially connected to the external pins.

Bit 5 = **SPR2** *Divider Enable*.

this bit is set and cleared by software and it is cleared by reset. It is used with the SPR[1:0] bits to set the baud rate. Refer to Table 15.

0: Divider by 2 enabled

1: Divider by 2 disabled

Bit 4 = MSTR Master.

This bit is set and cleared by software. It is also cleared by hardware when, in master mode, SS=0 (see Section 12.3.4.5 "Master Mode Fault" on page 70).

0: Slave mode is selected

 Master mode is selected, the function of the SCK pin changes from an input to an output and the functions of the MISO and MOSI pins are reversed.

Bit 3 = **CPOL** Clock polarity.

This bit is set and cleared by software. This bit determines the steady state of the serial Clock. The CPOL bit affects both the master and slave modes.

0: The steady state is a low value at the SCK pin.

1: The steady state is a high value at the SCK pin.

Bit 2 = CPHA Clock phase.

This bit is set and cleared by software.

- 0: The first clock transition is the first data capture edge.
- 1: The second clock transition is the first capture edge.

Bit 1:0 = **SPR[1:0]** Serial peripheral rate.

These bits are set and cleared by software. Used with the SPR2 bit, they select one of six baud rates to be used as the serial clock when the device is a master.

These 2 bits have no effect in slave mode.

Table 15. Serial Peripheral Baud Rate

Serial Clock	SPR2	SPR1	SPR0
f _{CPU} /4	1	0	0
f _{CPU} /8	0	0	0
f _{CPU} /16	0	0	1
f _{CPU} /32	1	1	0
f _{CPU} /64	0	1	0
f _{CPU} /128	0	1	1

SERIAL PERIPHERAL INTERFACE (Cont'd) STATUS REGISTER (SR)

Read Only

Reset Value: 0000 0000 (00h)

7							0
SPIF	WCOL	1	MODF	'	1	'	-

Bit 7 = **SPIF** Serial Peripheral data transfer flag. This bit is set by hardware when a transfer has been completed. An interrupt is generated if SPIE=1 in the CR register. It is cleared by a software sequence (an access to the SR register followed by a read or write to the DR register).

- Data transfer is in progress or has been approved by a clearing sequence.
- 1: Data transfer between the device and an external device has been completed.

Note: While the SPIF bit is set, all writes to the DR register are inhibited.

Bit 6 = WCOL Write Collision status.

This bit is set by hardware when a write to the DR register is done during a transmit sequence. It is cleared by a software sequence (see Figure 41).

0: No write collision occurred

1: A write collision has been detected

Bit 5 = Unused.

Bit 4 = **MODF** *Mode Fault flag.*

This bit is set by hardware when the \overline{SS} pin is pulled low in master mode (see Section 12.3.4.5 "Master Mode Fault" on page 70). An SPI interrupt can be generated if SPIE=1 in the CR register. This bit is cleared by a software sequence (An access to the SR register while MODF=1 followed by a write to the CR register).

0: No master mode fault detected

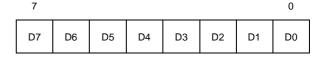
1: A fault in master mode has been detected

Bits 3-0 = Unused.

DATA I/O REGISTER (DR)

Read/Write

Reset Value: Undefined



The DR register is used to transmit and receive data on the serial bus. In the master device only a write to this register will initiate transmission/reception of another byte.

Notes: During the last clock cycle the SPIF bit is set, a copy of the received data byte in the shift register is moved to a buffer. When the user reads the serial peripheral data I/O register, the buffer is actually being read.

Warning:

A write to the DR register places data directly into the shift register for transmission.

A write to the DR register returns the value located in the buffer and not the contents of the shift register (See Figure 38).

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Table 16. SPI Register Map and Reset Values

Address (Hex.)	Register Label	7	6	5	4	3	2	1	0
0021h	SPIDR Reset Value	MSB x	x	x	х	х	х	х	LSB x
0022h	SPICR Reset Value	SPIE 0	SPE 0	SPR2 0	MSTR 0	CPOL x	CPHA x	SPR1 x	SPR0 x
0023h	SPISR Reset Value	SPIF 0	WCOL 0	0	MODF 0	0	0	0	0

12.4 I²C BUS INTERFACE (I2C)

12.4.1 Introduction

The I²C Bus Interface serves as an interface between the microcontroller and the serial I²C bus. It provides both multimaster and slave functions, and controls all I²C bus-specific sequencing, protocol, arbitration and timing. It supports fast I²C mode (400kHz).

12.4.2 Main Features

- Parallel-bus/I²C protocol converter
- Multi-master capability
- 7-bit/10-bit Addressing
- Transmitter/Receiver flag
- End-of-byte transmission flag
- Transfer problem detection

I²C Master Features:

- Clock generation
- I²C bus busy flag
- Arbitration Lost Flag
- End of byte transmission flag
- Transmitter/Receiver Flag
- Start bit detection flag
- Start and Stop generation

I²C Slave Features:

- Stop bit detection
- I²C bus busy flag
- Detection of misplaced start or stop condition
- Programmable I²C Address detection
- Transfer problem detection
- End-of-byte transmission flag
- Transmitter/Receiver flag

12.4.3 General Description

In addition to receiving and transmitting data, this interface converts it from serial to parallel format and vice versa, using either an interrupt or polled

handshake. The interrupts are enabled or disabled by software. The interface is connected to the I²C bus by a data pin (SDAI) and by a clock pin (SCLI). It can be connected both with a standard I²C bus and a Fast I²C bus. This selection is made by software.

Mode Selection

The interface can operate in the four following modes:

- Slave transmitter/receiver
- Master transmitter/receiver

By default, it operates in slave mode.

The interface automatically switches from slave to master after it generates a START condition and from master to slave in case of arbitration loss or a STOP generation, allowing then Multi-Master capability.

Communication Flow

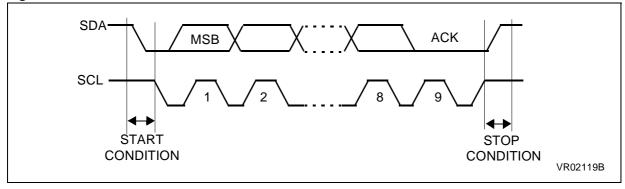
In Master mode, it initiates a data transfer and generates the clock signal. A serial data transfer always begins with a start condition and ends with a stop condition. Both start and stop conditions are generated in master mode by software.

In Slave mode, the interface is capable of recognising its own address (7 or 10-bit), and the General Call address. The General Call address detection may be enabled or disabled by software.

Data and addresses are transferred as 8-bit bytes, MSB first. The first byte(s) following the start condition contain the address (one in 7-bit mode, two in 10-bit mode). The address is always transmitted in Master mode.

A 9th clock pulse follows the 8 clock cycles of a byte transfer, during which the receiver must send an acknowledge bit to the transmitter. Refer to Figure 43.

Figure 43. I²C BUS Protocol



Acknowledge may be enabled and disabled by software.

The I²C interface address and/or general call address can be selected by software.

The speed of the I²C interface may be selected between Standard (0-100KHz) and Fast I²C (100-400KHz).

SDA/SCL Line Control

Transmitter mode: the interface holds the clock line low before transmission to wait for the microcontroller to write the byte in the Data Register.

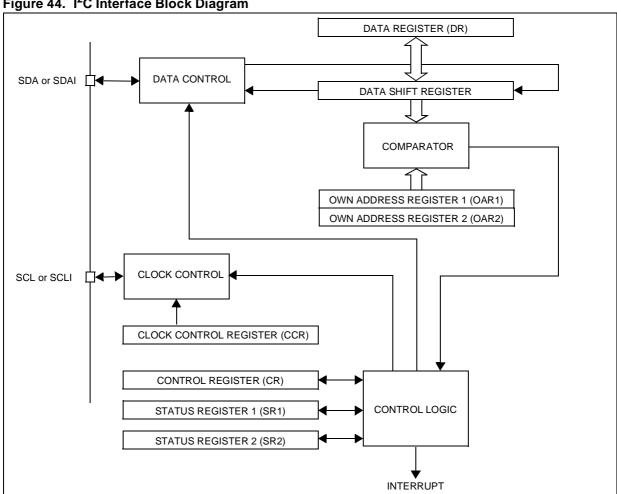
Receiver mode: the interface holds the clock line low after reception to wait for the microcontroller to read the byte in the Data Register.

The SCL frequency (F_{scl}) is controlled by a programmable clock divider which depends on the I²C bus mode.

When the I²C cell is enabled, the SDA and SCL ports must be configured as floating inputs. In this case, the value of the external pull-up resistor used depends on the application.

When the I²C cell is disabled, the SDA and SCL ports revert to being standard I/O port pins.





12.4.4 Functional Description

Refer to the CR, SR1 and SR2 registers in Section 12.4.7. for the bit definitions.

By default the I²C interface operates in Slave mode (M/SL bit is cleared) except when it initiates a transmit or receive sequence.

First the interface frequency must be configured using the FRi bits in the OAR2 register.

12.4.4.1 Slave Mode

As soon as a start condition is detected, the address is received from the SDA line and sent to the shift register; then it is compared with the address of the interface or the General Call address (if selected by software).

Note: In 10-bit addressing mode, the comparision includes the header sequence (11110xx0) and the two most significant bits of the address.

Header matched (10-bit mode only): the interface generates an acknowledge pulse if the ACK bit is set.

Address not matched: the interface ignores it and waits for another Start condition.

Address matched: the interface generates in sequence:

- Acknowledge pulse if the ACK bit is set.
- EVF and ADSL bits are set with an interrupt if the ITE bit is set.

Then the interface waits for a read of the SR1 register, **holding the SCL line low** (see Figure 45 Transfer sequencing EV1).

Next, in 7-bit mode read the DR register to determine from the least significant bit (Data Direction Bit) if the slave must enter Receiver or Transmitter mode.

In 10-bit mode, after receiving the address sequence the slave is always in receive mode. It will enter transmit mode on receiving a repeated Start condition followed by the header sequence with matching address bits and the least significant bit set (11110xx1).

Slave Receiver

Following the address reception and after SR1 register has been read, the slave receives bytes from the SDA line into the DR register via the internal shift register. After each byte the interface generates in sequence:

Acknowledge pulse if the ACK bit is set

 EVF and BTF bits are set with an interrupt if the ITE bit is set.

Then the interface waits for a read of the SR1 register followed by a read of the DR register, **holding the SCL line low** (see Figure 45 Transfer sequencing EV2).

Slave Transmitter

Following the address reception and after SR1 register has been read, the slave sends bytes from the DR register to the SDA line via the internal shift register.

The slave waits for a read of the SR1 register followed by a write in the DR register, **holding the SCL line low** (see Figure 45 Transfer sequencing EV3).

When the acknowledge pulse is received:

 The EVF and BTF bits are set by hardware with an interrupt if the ITE bit is set.

Closing slave communication

After the last data byte is transferred a Stop Condition is generated by the master. The interface detects this condition and sets:

 EVF and STOPF bits with an interrupt if the ITE bit is set.

Then the interface waits for a read of the SR2 register (see Figure 45 Transfer sequencing EV4).

Error Cases

 BERR: Detection of a Stop or a Start condition during a byte transfer. In this case, the EVF and the BERR bits are set with an interrupt if the ITE bit is set.

If it is a Stop then the interface discards the data, released the lines and waits for another Start condition.

If it is a Start then the interface discards the data and waits for the next slave address on the bus.

 AF: Detection of a non-acknowledge bit. In this case, the EVF and AF bits are set with an interrupt if the ITE bit is set.

Note: In both cases, SCL line is not held low; however, SDA line can remain low due to possible «0» bits transmitted last. It is then necessary to release both lines by software.

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How to release the SDA / SCL lines

Set and subsequently clear the STOP bit while BTF is set. The SDA/SCL lines are released after the transfer of the current byte.

12.4.4.2 Master Mode

To switch from default Slave mode to Master mode a Start condition generation is needed.

Start condition

Setting the START bit while the BUSY bit is cleared causes the interface to switch to Master mode (M/SL bit set) and generates a Start condition.

Once the Start condition is sent:

 The EVF and SB bits are set by hardware with an interrupt if the ITE bit is set.

Then the master waits for a read of the SR1 register followed by a write in the DR register with the Slave address, **holding the SCL line low** (see Figure 45 Transfer sequencing EV5).

Slave address transmission

Then the slave address is sent to the SDA line via the internal shift register.

In 7-bit addressing mode, one address byte is sent.

In 10-bit addressing mode, sending the first byte including the header sequence causes the following event:

 The EVF bit is set by hardware with interrupt generation if the ITE bit is set.

Then the master waits for a read of the SR1 register followed by a write in the DR register, **holding the SCL line low** (see Figure 45 Transfer sequencing EV9).

Then the second address byte is sent by the interface.

After completion of this transfer (and acknowledge from the slave if the ACK bit is set):

 The EVF bit is set by hardware with interrupt generation if the ITE bit is set.

Then the master waits for a read of the SR1 register followed by a write in the CR register (for example set PE bit), **holding the SCL line low** (see Figure 45 Transfer sequencing EV6).

Next the master must enter Receiver or Transmitter mode.

Note: In 10-bit addressing mode, to switch the master to Receiver mode, software must generate a repeated Start condition and resend the header sequence with the least significant bit set (11110xx1).

Master Receiver

Following the address transmission and after SR1 and CR registers have been accessed, the master receives bytes from the SDA line into the DR register via the internal shift register. After each byte the interface generates in sequence:

- Acknowledge pulse if if the ACK bit is set
- EVF and BTF bits are set by hardware with an interrupt if the ITE bit is set.

Then the interface waits for a read of the SR1 register followed by a read of the DR register, **holding the SCL line low** (see Figure 45 Transfer sequencing EV7).

To close the communication: before reading the last byte from the DR register, set the STOP bit to generate the Stop condition. The interface goes automatically back to slave mode (M/SL bit cleared).

Note: In order to generate the non-acknowledge pulse after the last received data byte, the ACK bit must be cleared just before reading the second last data byte.

Master Transmitter

Following the address transmission and after SR1 register has been read, the master sends bytes from the DR register to the SDA line via the internal shift register.

The master waits for a read of the SR1 register followed by a write in the DR register, **holding the SCL line low** (see Figure 45 Transfer sequencing EV8).

When the acknowledge bit is received, the interface sets:

EVF and BTF bits with an interrupt if the ITE bit is set.

To close the communication: after writing the last byte to the DR register, set the STOP bit to generate the Stop condition. The interface goes automatically back to slave mode (M/SL bit cleared).

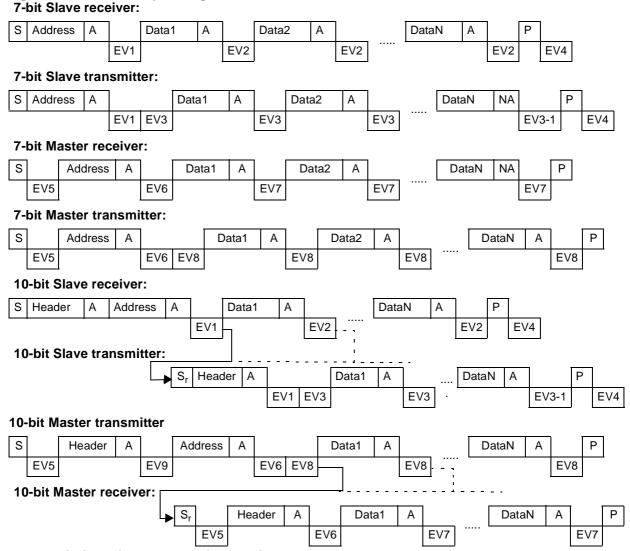
Error Cases

 BERR: Detection of a Stop or a Start condition during a byte transfer. In this case, the EVF and BERR bits are set by hardware with an interrupt if ITE is set.

- AF: Detection of a non-acknowledge bit. In this case, the EVF and AF bits are set by hardware with an interrupt if the ITE bit is set. To resume, set the START or STOP bit.
- ARLO: Detection of an arbitration lost condition.
 In this case the ARLO bit is set by hardware (with an interrupt if the ITE bit is set and the interface goes automatically back to slave mode (the M/SL bit is cleared).

Note: In all these cases, the SCL line is not held low; however, the SDA line can remain low due to possible «0» bits transmitted last. It is then necessary to release both lines by software.

Figure 45. Transfer Sequencing



Legend: S=Start, S_r = Repeated Start, P=Stop, A=Acknowledge, NA=Non-acknowledge, EVx=Event (with interrupt if ITE=1)

EV1: EVF=1, ADSL=1, cleared by reading SR1 register.

EV2: EVF=1, BTF=1, cleared by reading SR1 register followed by reading DR register.

EV3: EVF=1, BTF=1, cleared by reading SR1 register followed by writing DR register.

EV3-1: EVF=1, AF=1, BTF=1; AF is cleared by reading SR1 register. BTF is cleared by releasing the lines (STOP=1, STOP=0) or by writing DR register (DR=FFh). **Note:** If lines are released by STOP=1, STOP=0, the subsequent EV4 is not seen.

EV4: EVF=1, STOPF=1, cleared by reading SR2 register.

EV5: EVF=1, SB=1, cleared by reading SR1 register followed by writing DR register.

EV6: EVF=1, cleared by reading SR1 register followed by writing CR register (for example PE=1).

EV7: EVF=1, BTF=1, cleared by reading SR1 register followed by reading DR register.

EV8: EVF=1, BTF=1, cleared by reading SR1 register followed by writing DR register.

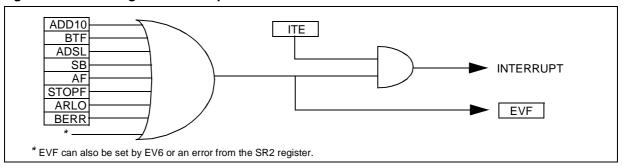
EV9: EVF=1, ADD10=1, cleared by reading SR1 register followed by writing DR register.

12.4.5 Low Power Modes

Mode	Description				
WAIT	No effect on I ² C interface. I ² C interrupts cause the device to exit from WAIT mode.				
HALT	I ² C registers are frozen. In HALT mode, the I ² C interface is inactive and does not acknowledge data on the bus. The I ² C interface resumes operation when the MCU is woken up by an interrupt with "exit from HALT mode" capability.				

12.4.6 Interrupts

Figure 46. Event Flags and Interrupt Generation



Interrupt Event	Event Flag	Enable Control Bit	Exit from Wait	Exit from Halt
10-bit Address Sent Event (Master mode)	ADD10		Yes	No
End of Byte Transfer Event	BTF		Yes	No
Address Matched Event (Slave mode)	ADSEL		Yes	No
Start Bit Generation Event (Master mode)	SB	ITE	Yes	No
Acknowledge Failure Event	AF	116	Yes	No
Stop Detection Event (Slave mode)	STOPF		Yes	No
Arbitration Lost Event (Multimaster configuration)	ARLO		Yes	No
Bus Error Event	BERR		Yes	No

Note: The I²C interrupt events are connected to the same interrupt vector (see Interrupts chapter). They generate an interrupt if the corresponding Enable Control Bit is set and the I-bit in the CC register is reset (RIM instruction).

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12.4.7 Register Description

I²C CONTROL REGISTER (CR)

Read / Write

Reset Value: 0000 0000 (00h)

7	_	_	_				0
0	0	PE	ENGC	START	ACK	STOP	ITE

Bit 7:6 = Reserved. Forced to 0 by hardware.

Bit 5 = **PE** Peripheral enable.

This bit is set and cleared by software.

- 0: Peripheral disabled
- 1: Master/Slave capability

Notes

- When PE=0, all the bits of the CR register and the SR register except the Stop bit are reset. All outputs are released while PE=0
- When PE=1, the corresponding I/O pins are selected by hardware as alternate functions.
- To enable the I²C interface, write the CR register
 TWICE with PE=1 as the first write only activates the interface (only PE is set).

Bit 4 = **ENGC** Enable General Call.

This bit is set and cleared by software. It is also cleared by hardware when the interface is disabled (PE=0). The 00h General Call address is acknowledged (01h ignored).

- 0: General Call disabled
- 1: General Call enabled

Bit 3 = **START** Generation of a Start condition. This bit is set and cleared by software. It is also cleared by hardware when the interface is disabled (PE=0) or when the Start condition is sent (with interrupt generation if ITE=1).

- In master mode:
 - 0: No start generation
 - 1: Repeated start generation
- In slave mode:
 - 0: No start generation
 - 1: Start generation when the bus is free

Bit 2 = ACK Acknowledge enable.

This bit is set and cleared by software. It is also cleared by hardware when the interface is disabled (PE=0).

- 0: No acknowledge returned
- 1: Acknowledge returned after an address byte or a data byte is received

Bit 1 = **STOP** Generation of a Stop condition.

This bit is set and cleared by software. It is also cleared by hardware in master mode. Note: This bit is not cleared when the interface is disabled (PE=0).

- In master mode:
 - 0: No stop generation
 - 1: Stop generation after the current byte transfer or after the current Start condition is sent. The STOP bit is cleared by hardware when the Stop condition is sent.
- In slave mode:
 - 0: No stop generation
 - 1: Release the SCL and SDA lines after the current byte transfer (BTF=1). In this mode the STOP bit has to be cleared by software.

Bit 0 = **ITE** Interrupt enable.

This bit is set and cleared by software and cleared by hardware when the interface is disabled (PE=0).

- 0: Interrupts disabled
- 1: Interrupts enabled

Refer to Figure 46 for the relationship between the events and the interrupt.

SCL is held low when the ADD10, SB, BTF or ADSL flags or an EV6 event (See Figure 45) is detected.

I²C BUS INTERFACE (Cont'd) I²C STATUS REGISTER 1 (SR1)

Read Only

Reset Value: 0000 0000 (00h)

7							0
EVF	ADD10	TRA	BUSY	BTF	ADSL	M/SL	SB

Bit 7 = **EVF** Event flag.

This bit is set by hardware as soon as an event occurs. It is cleared by software reading SR2 register in case of error event or as described in Figure 45. It is also cleared by hardware when the interface is disabled (PE=0).

0: No event

- 1: One of the following events has occurred:
 - BTF=1 (Byte received or transmitted)
 - ADSL=1 (Address matched in Slave mode while ACK=1)
 - SB=1 (Start condition generated in Master mode)
 - AF=1 (No acknowledge received after byte transmission)
 - STOPF=1 (Stop condition detected in Slave mode)
 - ARLO=1 (Arbitration lost in Master mode)
 - BERR=1 (Bus error, misplaced Start or Stop condition detected)
 - ADD10=1 (Master has sent header byte)
 - Address byte successfully transmitted in Master mode.

Bit 6 = **ADD10** 10-bit addressing in Master mode. This bit is set by hardware when the master has sent the first byte in 10-bit address mode. It is cleared by software reading SR2 register followed by a write in the DR register of the second address byte. It is also cleared by hardware when the peripheral is disabled (PE=0).

0: No ADD10 event occurred.

1: Master has sent first address byte (header)

Bit 5 = TRA Transmitter/Receiver.

When BTF is set, TRA=1 if a data byte has been transmitted. It is cleared automatically when BTF is cleared. It is also cleared by hardware after detection of Stop condition (STOPF=1), loss of bus

arbitration (ARLO=1) or when the interface is disabled (PE=0).

0: Data byte received (if BTF=1)

1: Data byte transmitted

Bit 4 = BUSY Bus busy.

This bit is set by hardware on detection of a Start condition and cleared by hardware on detection of a Stop condition. It indicates a communication in progress on the bus. This information is still updated when the interface is disabled (PE=0).

0: No communication on the bus

1: Communication ongoing on the bus

Bit 3 = **BTF** Byte transfer finished.

This bit is set by hardware as soon as a byte is correctly received or transmitted with interrupt generation if ITE=1. It is cleared by software reading SR1 register followed by a read or write of DR register. It is also cleared by hardware when the interface is disabled (PE=0).

- Following a byte transmission, this bit is set after reception of the acknowledge clock pulse. In case an address byte is sent, this bit is set only after the EV6 event (See Figure 45). BTF is cleared by reading SR1 register followed by writing the next byte in DR register.
- Following a byte reception, this bit is set after transmission of the acknowledge clock pulse if ACK=1. BTF is cleared by reading SR1 register followed by reading the byte from DR register.

The SCL line is held low while BTF=1.

0: Byte transfer not done

1: Byte transfer succeeded

Bit 2 = **ADSL** Address matched (Slave mode). This bit is set by hardware as soon as the received slave address matched with the OAR register content or a general call is recognized. An interrupt is generated if ITE=1. It is cleared by software reading SR1 register or by hardware when the interface is disabled (PE=0).

The SCL line is held low while ADSL=1.

0: Address mismatched or not received

1: Received address matched

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Bit 1 = M/SL Master/Slave.

This bit is set by hardware as soon as the interface is in Master mode (writing START=1). It is cleared by hardware after detecting a Stop condition on the bus or a loss of arbitration (ARLO=1). It is also cleared when the interface is disabled (PE=0).

0: Slave mode

1: Master mode

Bit 0 = **SB** Start bit (Master mode).

This bit is set by hardware as soon as the Start condition is generated (following a write START=1). An interrupt is generated if ITE=1. It is cleared by software reading SR1 register followed by writing the address byte in DR register. It is also cleared by hardware when the interface is disabled (PE=0).

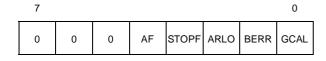
0: No Start condition

1: Start condition generated

I²C STATUS REGISTER 2 (SR2)

Read Only

Reset Value: 0000 0000 (00h)



Bit 7:5 = Reserved. Forced to 0 by hardware.

Bit 4 = AF Acknowledge failure.

This bit is set by hardware when no acknowledge is returned. An interrupt is generated if ITE=1. It is cleared by software reading SR2 register or by hardware when the interface is disabled (PE=0).

The SCL line is not held low while AF=1.

0: No acknowledge failure

1: Acknowledge failure

Bit 3 = **STOPF** Stop detection (Slave mode).

This bit is set by hardware when a Stop condition is detected on the bus after an acknowledge (if ACK=1). An interrupt is generated if ITE=1. It is cleared by software reading SR2 register or by hardware when the interface is disabled (PE=0).

The SCL line is not held low while STOPF=1.

0: No Stop condition detected

1: Stop condition detected

Bit 2 = **ARLO** Arbitration lost.

This bit is set by hardware when the interface loses the arbitration of the bus to another master. An interrupt is generated if ITE=1. It is cleared by software reading SR2 register or by hardware when the interface is disabled (PE=0).

After an ARLO event the interface switches back automatically to Slave mode (M/SL=0).

The SCL line is not held low while ARLO=1.

0: No arbitration lost detected

1: Arbitration lost detected

Bit 1 = **BERR** Bus error.

This bit is set by hardware when the interface detects a misplaced Start or Stop condition. An interrupt is generated if ITE=1. It is cleared by software reading SR2 register or by hardware when the interface is disabled (PE=0).

The SCL line is not held low while BERR=1.

0: No misplaced Start or Stop condition

1: Misplaced Start or Stop condition

Bit 0 = GCAL General Call (Slave mode).

This bit is set by hardware when a general call address is detected on the bus while ENGC=1. It is cleared by hardware detecting a Stop condition (STOPF=1) or when the interface is disabled (PE=0).

0: No general call address detected on bus

1: general call address detected on bus

I²C BUS INTERFACE (Cont'd) I²C CLOCK CONTROL REGISTER (CCR)

Read / Write

Reset Value: 0000 0000 (00h)

0 FM/SM CC6 CC5 CC4 CC3 CC2 CC1 CC0

Bit 7 = **FM/SM** Fast/Standard I^2C mode.

This bit is set and cleared by software. It is not cleared when the interface is disabled (PE=0). 0: Standard I²C mode

1: Fast I²C mode

Bit 6:0 = CC6-CC0 7-bit clock divider.

These bits select the speed of the bus (F_{SCL}) depending on the I^2C mode. They are not cleared when the interface is disabled (PE=0).

- Standard mode (FM/SM=0): $F_{SCL} \le 100kHz$

$$\mathsf{F}_{\mathsf{SCL}} = \mathsf{F}_{\mathsf{CPU}}/(2\mathsf{x}([\mathsf{CC6..CC0}] + 2))$$

- Fast mode (FM/SM=1): $F_{SCL} > 100kHz$

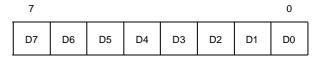
$$\mathsf{F}_{\mathsf{SCL}} = \mathsf{F}_{\mathsf{CPU}}/(3\mathsf{x}([\mathsf{CC6..CC0}] + 2))$$

Note: The programmed F_{SCL} assumes no load on SCL and SDA lines.

I²C DATA REGISTER (DR)

Read / Write

Reset Value: 0000 0000 (00h)



Bit 7:0 = **D7-D0** 8-bit Data Register.

These bits contain the byte to be received or transmitted on the bus.

- Transmitter mode: Byte transmission start automatically when the software writes in the DR reg-
- Receiver mode: the first data byte is received automatically in the DR register using the least significant bit of the address.

Then, the following data bytes are received one by one after reading the DR register.

I²C BUS INTERFACE (Cont'd) I²C OWN ADDRESS REGISTER (OAR1)

Read / Write

Reset Value: 0000 0000 (00h)

7							0
ADD7	ADD6	ADD5	ADD4	ADD3	ADD2	ADD1	ADD0

7-bit Addressing Mode

Bit 7:1 = ADD7-ADD1 Interface address.

These bits define the I²C bus address of the interface. They are not cleared when the interface is disabled (PE=0).

Bit 0 = ADDO Address direction bit.

This bit is don't care, the interface acknowledges either 0 or 1. It is not cleared when the interface is disabled (PE=0).

Note: Address 01h is always ignored.

10-bit Addressing Mode

Bit 7:0 = **ADD7-ADD0** Interface address.

These are the least significant bits of the I²C bus address of the interface. They are not cleared when the interface is disabled (PE=0).

I²C OWN ADDRESS REGISTER (OAR2)

Read / Write

Reset Value: 0100 0000 (40h)

7							0
FR1	FR0	0	0	0	ADD9	ADD8	0

Bit 7:6 = **FR1-FR0** Frequency bits.

These bits are set by software only when the interface is disabled (PE=0). To configure the interface to I^2C specifed delays select the value corresponding to the microcontroller frequency F_{CPU} .

F _{CPU} Range (MHz)	FR1	FR0
2.5 - 6	0	0
6 -10	0	1
10 - 14	1	0
14 - 24	1	1

Bit 5:3 = Reserved

Bit 2:1 = ADD9-ADD8 Interface address.

These are the most significant bits of the I^2C bus address of the interface (10-bit mode only). They are not cleared when the interface is disabled (PE=0).

Bit 0 = Reserved.

Table 17. I²C Register Map and Reset Values

Address (Hex.)	Register Label	7	6	5	4	3	2	1	0
0028h	I2CCR Reset Value	0	0	PE 0	ENGC 0	START 0	ACK 0	STOP 0	ITE 0
0029h	I2CSR1 Reset Value	EVF 0	ADD10 0	TRA 0	BUSY 0	BTF 0	ADSL 0	M/SL 0	SB 0
002Ah	I2CSR2 Reset Value	0	0	0	AF 0	STOPF 0	ARLO 0	BERR 0	GCAL 0
02Bh	I2CCCR Reset Value	FM/SM 0	CC6 0	CC5 0	CC4 0	CC3 0	CC2 0	CC1 0	CC0 0
02Ch	I2COAR1 Reset Value	ADD7 0	ADD6 0	ADD5 0	ADD4 0	ADD3 0	ADD2 0	ADD1 0	ADD0 0
002Dh	I2COAR2 Reset Value	FR1 0	FR0 1	0	0	0	ADD9 0	ADD8 0	0
002Eh	I2CDR Reset Value	MSB 0	0	0	0	0	0	0	LSB 0

12.5 8-BIT A/D CONVERTER (ADC)

12.5.1 Introduction

The on-chip Analog to Digital Converter (ADC) peripheral is a 8-bit, successive approximation converter with internal sample and hold circuitry. This peripheral has up to 16 multiplexed analog input channels (refer to device pin out description) that allow the peripheral to convert the analog voltage levels from up to 16 different sources.

The result of the conversion is stored in a 8-bit Data Register. The A/D converter is controlled through a Control/Status Register.

12.5.2 Main Features

- 8-bit conversion
- Up to 16 channels with multiplexed input
- Linear successive approximation
- Data register (DR) which contains the results
- Conversion complete status flag
- On/off bit (to reduce consumption)

The block diagram is shown in Figure 1.

12.5.3 Functional Description

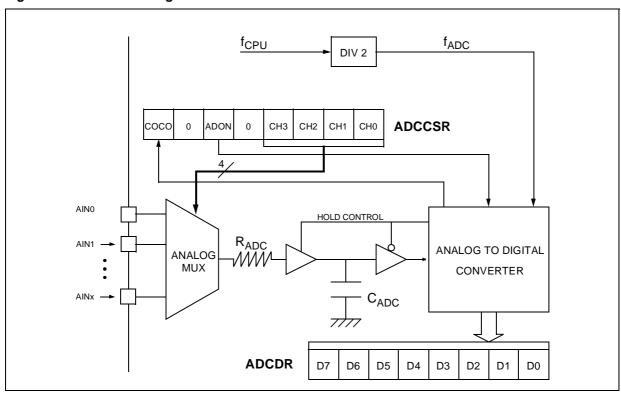
12.5.3.1 Analog Power Supply

 V_{DDA} and V_{SSA} are the high and low level reference voltage pins. In some devices (refer to device pin out description) they are internally connected to the V_{DD} and V_{SS} pins.

Conversion accuracy may therefore be impacted by voltage drops and noise in the event of heavily loaded or badly decoupled power supply lines.

See electrical characteristics section for more details.

Figure 47. ADC Block Diagram



8-BIT A/D CONVERTER (ADC) (Cont'd)

12.5.3.2 Digital A/D Conversion Result

The conversion is monotonic, meaning that the result never decreases if the analog input does not and never increases if the analog input does not.

If the input voltage (V_{AIN}) is greater than or equal to V_{DDA} (high-level voltage reference) then the conversion result in the DR register is FFh (full scale) without overflow indication.

If input voltage (V_{AIN}) is lower than or equal to V_{SSA} (low-level voltage reference) then the conversion result in the DR register is 00h.

The A/D converter is linear and the digital result of the conversion is stored in the ADCDR register. The accuracy of the conversion is described in the parametric section.

 R_{AIN} is the maximum recommended impedance for an analog input signal. If the impedance is too high, this will result in a loss of accuracy due to leakage and sampling not being completed in the alloted time.

12.5.3.3 A/D Conversion Phases

The A/D conversion is based on two conversion phases as shown in Figure 2:

- Sample capacitor loading [duration: t_{LOAD}] During this phase, the V_{AIN} input voltage to be measured is loaded into the C_{ADC} sample capacitor.
- A/D conversion [duration: t_{CONV}]
 During this phase, the A/D conversion is computed (8 successive approximations cycles) and the C_{ADC} sample capacitor is disconnected from the analog input pin to get the optimum analog to digital conversion accuracy.

While the ADC is on, these two phases are continuously repeated.

At the end of each conversion, the sample capacitor is kept loaded with the previous measurement load. The advantage of this behaviour is that it minimizes the current consumption on the analog pin in case of single input channel measurement.

12.5.3.4 Software Procedure

Refer to the control/status register (CSR) and data register (DR) in Section 0.1.6 for the bit definitions and to Figure 2 for the timings.

ADC Configuration

The total duration of the A/D conversion is 12 ADC clock periods $(1/f_{ADC}=2/f_{CPU})$.

The analog input ports must be configured as input, no pull-up, no interrupt. Refer to the «I/O ports» chapter. Using these pins as analog inputs does not affect the ability of the port to be read as a logic input.

In the CSR register:

 Select the CH[3:0] bits to assign the analog channel to be converted.

ADC Conversion

In the CSR register:

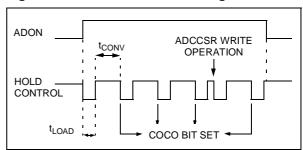
 Set the ADON bit to enable the A/D converter and to start the first conversion. From this time on, the ADC performs a continuous conversion of the selected channel.

When a conversion is complete

- The COCO bit is set by hardware.
- No interrupt is generated.
- The result is in the DR register and remains valid until the next conversion has ended.

A write to the CSR register (with ADON set) aborts the current conversion, resets the COCO bit and starts a new conversion.

Figure 48. ADC Conversion Timings



12.5.4 Low Power Modes

Mode	Description
WAIT	No effect on A/D Converter
HALT	A/D Converter disabled. After wakeup from Halt mode, the A/D Converter requires a stabilisation time before accurate conversions can be performed.

Note: The A/D converter may be disabled by resetting the ADON bit. This feature allows reduced power consumption when no conversion is needed and between single shot conversions.

12.5.5 Interrupts

None

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8-BIT A/D CONVERTER (ADC) (Cont'd)

12.5.6 Register Description

CONTROL/STATUS REGISTER (CSR)

Read/Write

Reset Value: 0000 0000 (00h)

7 0 COCO 0 ADON 0 CH3 CH2 CH1 CH0

Bit 7 = **COCO** Conversion Complete

This bit is set by hardware. It is cleared by software reading the result in the DR register or writing to the CSR register.

0: Conversion is not complete

1: Conversion can be read from the DR register

Bit 6 = **Reserved.** must always be cleared.

Bit 5 = **ADON** A/D Converter On This bit is set and cleared by software. 0: A/D converter is switched off

1: A/D converter is switched on

Bit 4 = **Reserved.** must always be cleared.

Bits 3:0 = **CH[3:0]** Channel Selection These bits are set and cleared by software. They select the analog input to convert.

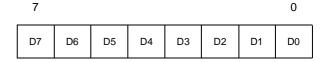
Channel Pin*	CH3	CH2	CH1	CH0
AIN0	0	0	0	0
AIN1	0	0	0	1
AIN2	0	0	1	0
AIN3	0	0	1	1
AIN4	0	1	0	0
AIN5	0	1	0	1
AIN6	0	1	1	0
AIN7	0	1	1	1
AIN8	1	0	0	0
AIN9	1	0	0	1
AIN10	1	0	1	0
AIN11	1	0	1	1
AIN12	1	1	0	0
AIN13	1	1	0	1
AIN14	1	1	1	0
AIN15	1	1	1	1

*Note: The number of pins AND the channel selection varies according to the device. Refer to the device pinout.

DATA REGISTER (DR)

Read Only

Reset Value: 0000 0000 (00h)



Bits 7:0 = **D[7:0]** Analog Converted Value This register contains the converted analog value in the range 00h to FFh.

Note: Reading this register reset the COCO flag.

8-BIT A/D CONVERTER (ADC) (Cont'd)

Table 18. ADC Register Map and Reset Values

Address (Hex.)	Register Label	7	6	5	4	3	2	1	0
0070h	ADCDR Reset Value	D7 0	D6 0	D5 0	D4 0	D3 0	D2 0	D1 0	D0 0
0071h	ADCCSR Reset Value	COCO 0	0	ADON 0	0	CH3 0	CH2 0	CH1 0	CH0 0

13 INSTRUCTION SET

13.1 ST7 ADDRESSING MODES

The ST7 Core features 17 different addressing modes which can be classified in 7 main groups:

Addressing Mode	Example
Inherent	nop
Immediate	ld A,#\$55
Direct	ld A,\$55
Indexed	ld A,(\$55,X)
Indirect	ld A,([\$55],X)
Relative	jrne loop
Bit operation	bset byte,#5

The ST7 Instruction set is designed to minimize the number of bytes required per instruction: To do

so, most of the addressing modes may be subdivided in two sub-modes called long and short:

- Long addressing mode is more powerful because it can use the full 64 Kbyte address space, however it uses more bytes and more CPU cycles.
- Short addressing mode is less powerful because it can generally only access page zero (0000h -00FFh range), but the instruction size is more compact, and faster. All memory to memory instructions use short addressing modes only (CLR, CPL, NEG, BSET, BRES, BTJT, BTJF, INC, DEC, RLC, RRC, SLL, SRL, SRA, SWAP)

The ST7 Assembler optimizes the use of long and short addressing modes.

Table 19. ST7 Addressing Mode Overview

Mode		Syntax	Destination/ Source	Pointer Address (Hex.)	Pointer Size (Hex.)	Length (Bytes)	
Inherent			nop				+ 0
Immediate			ld A,#\$55				+ 1
Short	Direct		ld A,\$10	00FF			+ 1
Long	Direct		ld A,\$1000	0000FFFF			+ 2
No Offset	Direct	Indexed	ld A,(X)	00FF			+ 0 (with X register) + 1 (with Y register)
Short	Direct	Indexed	ld A,(\$10,X)	001FE			+ 1
Long	Direct	Indexed	ld A,(\$1000,X)	0000FFFF			+ 2
Short	Indirect		ld A,[\$10]	00FF	00FF	byte	+ 2
Long	Indirect		ld A,[\$10.w]	0000FFFF	00FF	word	+ 2
Short	Indirect	Indexed	ld A,([\$10],X)	001FE	00FF	byte	+ 2
Long	Indirect	Indexed	ld A,([\$10.w],X)	0000FFFF	00FF	word	+ 2
Relative	Direct		jrne loop	PC-128/PC+127 ¹⁾			+ 1
Relative	Indirect		jrne [\$10]	PC-128/PC+127 ¹⁾	00FF	byte	+ 2
Bit	Direct		bset \$10,#7	00FF			+ 1
Bit	Indirect		bset [\$10],#7	00FF	00FF	byte	+ 2
Bit	Direct	Relative	btjt \$10,#7,skip	00FF			+ 2
Bit	Indirect	Relative	btjt [\$10],#7,skip	00FF	00FF	byte	+ 3

Note 1. At the time the instruction is executed, the Program Counter (PC) points to the instruction following JRxx.

ST7 ADDRESSING MODES (Cont'd)

13.1.1 Inherent

All Inherent instructions consist of a single byte. The opcode fully specifies all the required information for the CPU to process the operation.

Inherent Instruction	Function
NOP	No operation
TRAP	S/W Interrupt
WFI	Wait For Interrupt (Low Power Mode)
HALT	Halt Oscillator (Lowest Power Mode)
RET	Sub-routine Return
IRET	Interrupt Sub-routine Return
SIM	Set Interrupt Mask
RIM	Reset Interrupt Mask
SCF	Set Carry Flag
RCF	Reset Carry Flag
RSP	Reset Stack Pointer
LD	Load
CLR	Clear
PUSH/POP	Push/Pop to/from the stack
INC/DEC	Increment/Decrement
TNZ	Test Negative or Zero
CPL, NEG	1 or 2 Complement
MUL	Byte Multiplication
SLL, SRL, SRA, RLC, RRC	Shift and Rotate Operations
SWAP	Swap Nibbles

13.1.2 Immediate

Immediate instructions have two bytes, the first byte contains the opcode, the second byte contains the operand value.

Immediate Instruction	Function
LD	Load
СР	Compare
ВСР	Bit Compare
AND, OR, XOR	Logical Operations
ADC, ADD, SUB, SBC	Arithmetic Operations

13.1.3 Direct

In Direct instructions, the operands are referenced by their memory address.

The direct addressing mode consists of two submodes:

Direct (short)

The address is a byte, thus requires only one byte after the opcode, but only allows 00 - FF addressing space.

Direct (long)

The address is a word, thus allowing 64 Kbyte addressing space, but requires 2 bytes after the opcode.

13.1.4 Indexed (No Offset, Short, Long)

In this mode, the operand is referenced by its memory address, which is defined by the unsigned addition of an index register (X or Y) with an offset.

The indirect addressing mode consists of three sub-modes:

Indexed (No Offset)

There is no offset, (no extra byte after the opcode), and allows 00 - FF addressing space.

Indexed (Short)

The offset is a byte, thus requires only one byte after the opcode and allows 00 - 1FE addressing space.

Indexed (long)

The offset is a word, thus allowing 64 Kbyte addressing space and requires 2 bytes after the opcode.

13.1.5 Indirect (Short, Long)

The required data byte to do the operation is found by its memory address, located in memory (pointer).

The pointer address follows the opcode. The indirect addressing mode consists of two sub-modes:

Indirect (short)

The pointer address is a byte, the pointer size is a byte, thus allowing 00 - FF addressing space, and requires 1 byte after the opcode.

Indirect (long)

The pointer address is a byte, the pointer size is a word, thus allowing 64 Kbyte addressing space, and requires 1 byte after the opcode.

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ST7 ADDRESSING MODES (Cont'd)

13.1.6 Indirect Indexed (Short, Long)

This is a combination of indirect and short indexed addressing modes. The operand is referenced by its memory address, which is defined by the unsigned addition of an index register value (X or Y) with a pointer value located in memory. The pointer address follows the opcode.

The indirect indexed addressing mode consists of two sub-modes:

Indirect Indexed (Short)

The pointer address is a byte, the pointer size is a byte, thus allowing 00 - 1FE addressing space, and requires 1 byte after the opcode.

Indirect Indexed (Long)

The pointer address is a byte, the pointer size is a word, thus allowing 64 Kbyte addressing space, and requires 1 byte after the opcode.

Table 20. Instructions Supporting Direct, Indexed, Indirect and Indirect Indexed Addressing Modes

Long and Short Instructions	Function
LD	Load
СР	Compare
AND, OR, XOR	Logical Operations
ADC, ADD, SUB, SBC	Arithmetic Addition/subtraction operations
ВСР	Bit Compare

Short Instructions Only	Function
CLR	Clear
INC, DEC	Increment/Decrement
TNZ	Test Negative or Zero
CPL, NEG	1 or 2 Complement
BSET, BRES	Bit Operations
BTJT, BTJF	Bit Test and Jump Operations
SLL, SRL, SRA, RLC, RRC	Shift and Rotate Operations

SWAP	Swap Nibbles
CALL, JP	Call or Jump subroutine

13.1.7 Relative Mode (Direct, Indirect)

This addressing mode is used to modify the PC register value by adding an 8-bit signed offset to it.

Available Relative Direct/ Indirect Instructions	Function
JRxx	Conditional Jump
CALLR	Call Relative

The relative addressing mode consists of two submodes:

Relative (Direct)

The offset follows the opcode.

Relative (Indirect)

The offset is defined in memory, of which the address follows the opcode.

13.2 INSTRUCTION GROUPS

The ST7 family devices use an Instruction Set consisting of 63 instructions. The instructions may

be subdivided into 13 main groups as illustrated in the following table:

Load and Transfer	LD	CLR						
Stack operation	PUSH	POP	RSP					
Increment/Decrement	INC	DEC						
Compare and Tests	СР	TNZ	ВСР					
Logical operations	AND	OR	XOR	CPL	NEG			
Bit Operation	BSET	BRES						
Conditional Bit Test and Branch	BTJT	BTJF						
Arithmetic operations	ADC	ADD	SUB	SBC	MUL			
Shift and Rotates	SLL	SRL	SRA	RLC	RRC	SWAP	SLA	
Unconditional Jump or Call	JRA	JRT	JRF	JP	CALL	CALLR	NOP	RET
Conditional Branch	JRxx							
Interruption management	TRAP	WFI	HALT	IRET				
Code Condition Flag modification	SIM	RIM	SCF	RCF				

Using a pre-byte

The instructions are described with one to four bytes.

In order to extend the number of available opcodes for an 8-bit CPU (256 opcodes), three different prebyte opcodes are defined. These prebytes modify the meaning of the instruction they precede.

The whole instruction becomes:

PC-2 End of previous instruction

PC-1 Prebyte

PC Opcode

PC+1 Additional word (0 to 2) according to the number of bytes required to compute the effective address

These prebytes enable instruction in Y as well as indirect addressing modes to be implemented. They precede the opcode of the instruction in X or the instruction using direct addressing mode. The prebytes are:

- PDY 90 Replace an X based instruction using immediate, direct, indexed, or inherent addressing mode by a Y one.
- PIX 92 Replace an instruction using direct, direct bit, or direct relative addressing mode to an instruction using the corresponding indirect addressing mode. It also changes an instruction using X indexed addressing mode to an instruction using indirect X indexed addressing mode.
- PIY 91 Replace an instruction using X indirect indexed addressing mode by a Y one.

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INSTRUCTION GROUPS (Cont'd)

Mnemo	Description	Function/Example	Dst	Src	Н	I	N	Z	С
ADC	Add with Carry	A = A + M + C	Α	М	Н		N	Z	С
ADD	Addition	A = A + M	Α	М	Н		N	Z	С
AND	Logical And	A = A . M	Α	М			N	Z	
ВСР	Bit compare A, Memory	tst (A . M)	Α	М			N	Z	
BRES	Bit Reset	bres Byte, #3	М						
BSET	Bit Set	bset Byte, #3	М						
BTJF	Jump if bit is false (0)	btjf Byte, #3, Jmp1	М						С
BTJT	Jump if bit is true (1)	btjt Byte, #3, Jmp1	М						С
CALL	Call subroutine								
CALLR	Call subroutine relative								
CLR	Clear		reg, M				0	1	
СР	Arithmetic Compare	tst(Reg - M)	reg	М			N	Z	С
CPL	One Complement	A = FFH-A	reg, M				N	Z	1
DEC	Decrement	dec Y	reg, M				N	Z	
HALT	Halt					0			
IRET	Interrupt routine return	Pop CC, A, X, PC			Н	ı	N	Z	С
INC	Increment	inc X	reg, M				N	Z	
JP	Absolute Jump	jp [TBL.w]							
JRA	Jump relative always								
JRT	Jump relative								
JRF	Never jump	jrf *							
JRIH	Jump if ext. interrupt = 1								
JRIL	Jump if ext. interrupt = 0								
JRH	Jump if H = 1	H = 1 ?							
JRNH	Jump if H = 0	H = 0 ?							
JRM	Jump if I = 1	I = 1 ?							
JRNM	Jump if I = 0	I = 0 ?							
JRMI	Jump if N = 1 (minus)	N = 1 ?							
JRPL	Jump if N = 0 (plus)	N = 0 ?							
JREQ	Jump if Z = 1 (equal)	Z = 1 ?							
JRNE	Jump if Z = 0 (not equal)	Z = 0 ?							
JRC	Jump if C = 1	C = 1 ?							
JRNC	Jump if C = 0	C = 0 ?							
JRULT	Jump if C = 1	Unsigned <							
JRUGE	Jump if C = 0	Jmp if unsigned >=							
JRUGT	Jump if $(C + Z = 0)$	Unsigned >							

INSTRUCTION GROUPS (Cont'd)

Mnemo	Description	Function/Example	Dst	Src	Н	I	N	Z	С
JRULE	Jump if $(C + Z = 1)$	Unsigned <=							
LD	Load	dst <= src	reg, M	M, reg			N	Z	
MUL	Multiply	X,A = X * A	A, X, Y	X, Y, A	0				0
NEG	Negate (2's compl)	neg \$10	reg, M				N	Z	С
NOP	No Operation								
OR	OR operation	A = A + M	Α	М			N	Z	
POP	Pop from the Stack	pop reg	reg	М					
		pop CC	СС	М	Н	I	N	Z	С
PUSH	Push onto the Stack	push Y	М	reg, CC					
RCF	Reset carry flag	C = 0							0
RET	Subroutine Return								
RIM	Enable Interrupts	I = 0				0			
RLC	Rotate left true C	C <= Dst <= C	reg, M				N	Z	С
RRC	Rotate right true C	C => Dst => C	reg, M				N	Z	С
RSP	Reset Stack Pointer	S = Max allowed							
SBC	Subtract with Carry	A = A - M - C	Α	М			N	Z	С
SCF	Set carry flag	C = 1							1
SIM	Disable Interrupts	I = 1				1			
SLA	Shift left Arithmetic	C <= Dst <= 0	reg, M				N	Z	С
SLL	Shift left Logic	C <= Dst <= 0	reg, M				N	Z	С
SRL	Shift right Logic	0 => Dst => C	reg, M				0	Z	С
SRA	Shift right Arithmetic	Dst7 => Dst => C	reg, M				N	Z	С
SUB	Subtraction	A = A - M	Α	М			N	Z	С
SWAP	SWAP nibbles	Dst[74] <=> Dst[30]	reg, M				N	Z	
TNZ	Test for Neg & Zero	tnz lbl1					N	Z	
TRAP	S/W trap	S/W interrupt				1			
WFI	Wait for Interrupt					0			
XOR	Exclusive OR	A = A XOR M	Α	М			N	Z	

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14 ELECTRICAL CHARACTERISTICS

14.1 PARAMETER CONDITIONS

Unless otherwise specified, all voltages are referred to $\ensuremath{\text{V}_{SS}}.$

14.1.1 Minimum and Maximum values

Unless otherwise specified the minimum and maximum values are guaranteed in the worst conditions of ambient temperature, supply voltage and frequencies by tests in production on 100% of the devices with an ambient temperature at T_A =25°C and T_A = T_A max (given by the selected temperature range).

Data based on characterization results, design simulation and/or technology characteristics are indicated in the table footnotes and are not tested in production. Based on characterization, the minimum and maximum values refer to sample tests and represent the mean value plus or minus three times the standard deviation (mean $\pm 3\Sigma$).

14.1.2 Typical values

Unless otherwise specified, typical data are based on $T_A=25^{\circ}C$, $V_{DD}=5V$ (for the $4.5V \le V_{DD} \le 5.5V$ voltage range) and $V_{DD}=3.3V$ (for the $3V \le V_{DD} \le 4V$ voltage range). They are given only as design guidelines and are not tested.

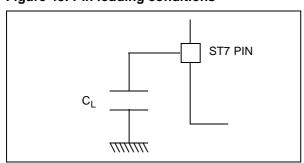
14.1.3 Typical curves

Unless otherwise specified, all typical curves are given only as design guidelines and are not tested.

14.1.4 Loading capacitor

The loading conditions used for pin parameter measurement are shown in Figure 49.

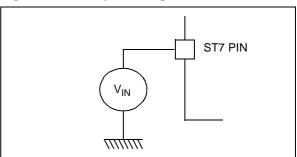
Figure 49. Pin loading conditions



14.1.5 Pin input voltage

The input voltage measurement on a pin of the device is described in Figure 50.

Figure 50. Pin input voltage



14.2 ABSOLUTE MAXIMUM RATINGS

Stresses above those listed as "absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these condi-

tions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

14.2.1 Voltage Characteristics

Symbol	Ratings	Maximum value	Unit
V _{DD} - V _{SS}	Supply voltage	6.5	V
V _{IN} 1) & 2)	Input voltage on any pin	V_{SS} -0.3 to V_{DD} +0.3	V
V _{ESD(HBM)}	Electro-static discharge voltage (Human Body Model) see Section 14.7.2 "Absolu		solute Elec-
V _{ESD(MM)}	Electro-static discharge voltage (Machine Model)	trical Sensitivity" on pag	e 114

14.2.2 Current Characteristics

Symbol	Ratings	Maximum value	Unit
I _{VDD}	Total current into V _{DD} power lines (source) 3)	80	
I _{VSS}	Total current out of V _{SS} ground lines (sink) 3)	80	
	Output current sunk by any standard I/O and control pin	25	
I _{IO}	Output current sunk by any high sink I/O pin	50	
	Output current source by any I/Os and control pin	- 25	m ^
	Injected current on ISPSEL pin	± 5	- mA
2) & 4)	Injected current on RESET pin	± 5	
I _{INJ(PIN)} 2) & 4)	Injected current on OSC1 and OSC2 pins	± 5	
	Injected current on any other pin 5) & 6)	± 5	
Σl _{INJ(PIN)} 2)	Total injected current (sum of all I/O and control pins) 5)	± 20	

14.2.3 Thermal Characteristics

Symbol	Ratings	Value	Unit
T _{STG}	Storage temperature range	-65 to +150	°C
TJ	Maximum junction temperature (see Section 15.2 "THERMAL CHARACTERISTICS" on	page 131)	

Notes:

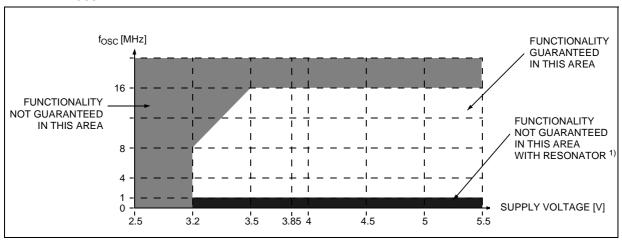
- 1. Directly connecting the $\overline{\text{RESET}}$ and I/O pins to V_{DD} or V_{SS} could damage the device if an unintentional internal reset is generated or an unexpected change of the I/O configuration occurs (for example, due to a corrupted program counter). To guarantee safe operation, this connection has to be done through a pull-up or pull-down resistor (typical: 4.7k Ω for RESET, 10k Ω for I/Os). Unused I/O pins must be tied in the same way to V_{DD} or V_{SS} according to their reset configuration.
- 2. When the current limitation is not possible, the V_{IN} absolute maximum rating must be respected, otherwise refer to $I_{INJ(PIN)}$ specification. A positive injection is induced by $V_{IN} > V_{DD}$ while a negative injection is induced by $V_{IN} < V_{SS}$.
- 3. All power (V_{DD}) and ground (V_{SS}) lines must always be connected to the external supply.
- 4. Negative injection disturbs the analog performance of the device. In particular, it induces leakage currents throughout the device including the analog inputs. To avoid undesirable effects on the analog functions, care must be taken:
- Analog input pins must have a negative injection less than 0.8 mA (assuming that the impedance of the analog voltage is lower than the specified limits)
- Pure digital pins must have a negative injection less than 1.6mA. In addition, it is recommended to inject the current as far as possible from the analog input pins.
- 5. When several inputs are submitted to a current injection, the maximum $\Sigma I_{\text{INJ(PIN)}}$ is the absolute sum of the positive and negative injected currents (instantaneous values). These results are based on characterisation with $\Sigma I_{\text{INJ(PIN)}}$ maximum current injection on four I/O port pins of the device.
- 6. True open drain I/O port pins do not accept positive injection.

14.3 OPERATING CONDITIONS

14.3.1 General Operating Conditions

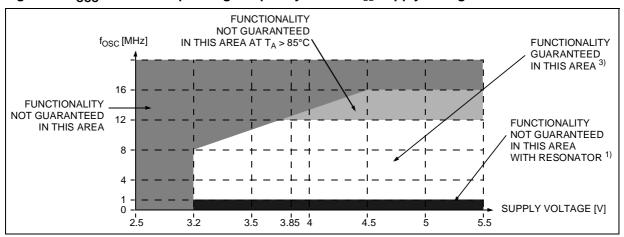
Symbol	Parameter	Conditions	Min	Max	Unit
V _{DD}	Supply voltage	see Figure 51 and Figure 52	3.2	5.5	V
fosc	External clock frequency	V _{DD} ≥3.5V for ROM devices		16	MHz
. ,		V _{DD} ≥3.2V	0 ¹⁾	8	
		1 Suffix Version	0	70	
		5 Suffix Version	-10	85	
T_A	Ambient temperature range	6 Suffix Version	-40	85	°C
		7 Suffix Version	-40	105	
		3 Suffix Version	-40	125	

Figure 51. f_{OSC} Maximum Operating Frequency Versus V_{DD} Supply Voltage for ROM devices $^{2)}$



OPERATING CONDITIONS (Cont'd)

Figure 52. f_{OSC} Maximum Operating Frequency Versus V_{DD} Supply Voltage for FLASH devices $^{2)}$



Notes:

- 1. Guaranteed by construction. A/D operation and resonator oscillator start-up are not guaranteed below 1MHz.
- 2. Operating conditions with T_A =-40 to +125°C.
- 3. FLASH programming tested in production at maximum T_A with two different conditions: V_{DD} =5.5V, f_{CPU} =8MHz and V_{DD} =3.2V, f_{CPU} =4MHz.

OPERATING CONDITIONS (Cont'd)

14.3.2 Operating Conditions with Low Voltage Detector (LVD)

Subject to general operating conditions for V_{DD}, f_{OSC}, and T_A.

Symbol	Parameter	Conditions	Min	Typ 1)	Max	Unit
V _{IT+}	Reset release threshold (V _{DD} rise)	High Threshold Med. Threshold Low Threshold	4.10 ²⁾ 3.75 ²⁾ 3.25 ²⁾	4.30 3.90 3.35	4.50 4.05 3.55	V
V _{IT-}	Reset generation threshold (V _{DD} fall)	High Threshold Med. Threshold Low Threshold ⁴⁾	3.85 ²⁾ 3.50 ²⁾ 3.00	4.05 3.65 3.10	4.30 3.95 3.35	V
V _{hyst}	LVD voltage threshold hysteresis	V _{IT+} -V _{IT-}	200	250	300	mV
Vt _{POR}	V _{DD} rise time rate ³⁾		0.2		50	V/ms
t _{g(VDD)}	Filtered glitch delay on V _{DD} ²⁾	Not detected by the LVD			40	ns

Figure 53. High LVD Threshold Versus V_{DD} and f_{OSC} for FLASH devices ³⁾

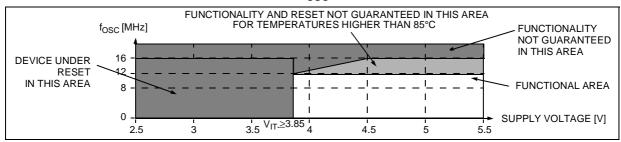


Figure 54. Medium LVD Threshold Versus V_{DD} and $f_{\mbox{OSC}}$ for FLASH devices $^{3)}$

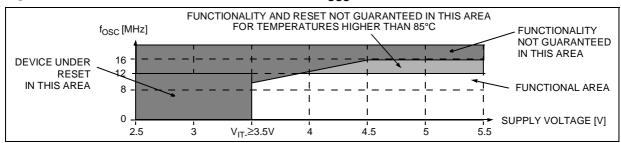
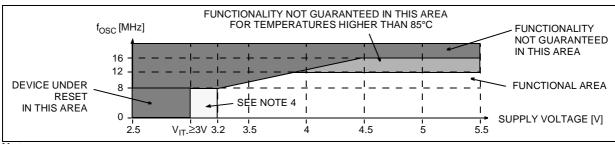


Figure 55. Low LVD Threshold Versus V_{DD} and f_{OSC} for FLASH devices $^{2)4)}$



Notes:

- 1. LVD typical data are based on T_A=25°C. They are given only as design guidelines and are not tested.
- 2. Data based on characterization results, not tested in production.
- 3. The V_{DD} rise time rate condition is needed to insure a correct device power-on and LVD reset. Not tested in production.
- 4. If the low LVD threshold is selected, when V_{DD} falls below 3.2V, (V_{DD} minimum operating voltage), the device is guaranteed to continue functioning until it goes into reset state. The specified V_{DD} min. value is necessary in the device power on phase, but during a power down phase or voltage drop the device will function below this min. level.

FUNCTIONAL OPERATING CONDITIONS (Cont'd)

Figure 56. High LVD Threshold Versus V_{DD} and f_{OSC} for ROM devices ²⁾

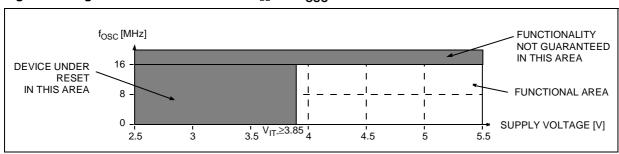


Figure 57. Medium LVD Threshold Versus V_{DD} and $f_{\mbox{OSC}}$ for ROM devices $^{2)}$

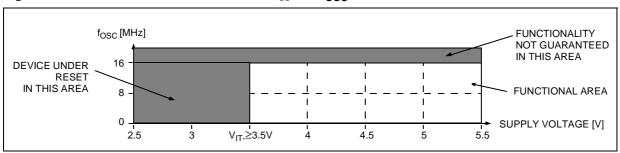
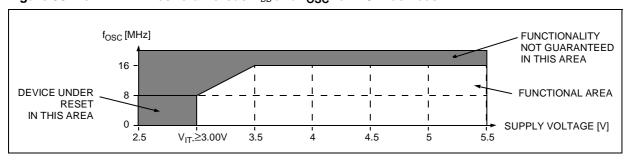


Figure 58. Low LVD Threshold Versus V_{DD} and f_{OSC} for ROM devices $^{2)3)}$



Notes

- 1. LVD typical data are based on T_A=25°C. They are given only as design guidelines and are not tested.
- 2. The minimum V_{DD} rise time rate is needed to insure a correct device power-on and LVD reset. Not tested in production.
- 3. If the low LVD threshold is selected, when V_{DD} falls below 3.2V, the device is guaranteed to be either functioning or under reset.

14.4 SUPPLY CURRENT CHARACTERISTICS

The following current consumption specified for the ST7 functional operating modes over temperature range does not take into account the clock source current consumption. To get the total device consumption, the two current values must be added (except for HALT mode for which the clock is stopped).

	Symbol	Parameter	Conditions	Max	Unit
ĺ	$\Delta I_{\text{DD}(\Delta Ta)}$	Supply current variation vs. temperature	Constant V _{DD} and f _{CPU}	10	%

14.4.1 RUN and SLOW Modes

Symbol	Parameter		Conditions	Typ ¹⁾	Max ²⁾	Unit
	Supply current in RUN mode ³⁾ (see Figure 59)	V5.5≥ _{O(}	f _{OSC} =1MHz, f _{CPU} =500kHz f _{OSC} =4MHz, f _{CPU} =2MHz f _{OSC} =16MHz, f _{CPU} =8MHz	500 1500 5600	900 2500 9000	
1	Supply current in SLOW mode ⁴⁾ (see Figure 60)	4.5V≤V _{DD} ≤5	f _{OSC} =1MHz, f _{CPU} =31.25kHz f _{OSC} =4MHz, f _{CPU} =125kHz f _{OSC} =16MHz, f _{CPU} =500kHz	150 250 670	450 550 1250	^
I _{DD}	Supply current in RUN mode ³⁾ (see Figure 59)	2V≤V _{DD} ≤3.6V	f _{OSC} =1MHz, f _{CPU} =500kHz f _{OSC} =4MHz, f _{CPU} =2MHz f _{OSC} =16MHz, f _{CPU} =8MHz	300 970 3600	550 1350 4500	μΑ
	Supply current in SLOW mode ⁴⁾ (see Figure 60)	3.2V≤V _[f _{OSC} =1MHz, f _{CPU} =31.25kHz f _{OSC} =4MHz, f _{CPU} =125kHz f _{OSC} =16MHz, f _{CPU} =500kHz	100 170 420	250 300 700	

Figure 59. Typical I_{DD} in RUN vs. f_{CPU}

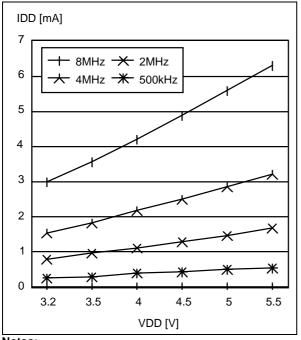
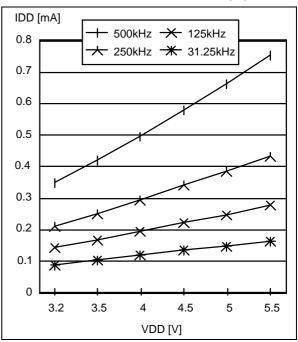


Figure 60. Typical I_{DD} in SLOW vs. f_{CPU}



Notes:

- 1. Typical data are based on TA=25°C, V_{DD} =5V (4.5V \leq V $_{DD}$ \leq 5.5V range) and VDD=3.4V (3.2V \leq V $_{DD}$ \leq 3.6V range).
- 2. Data based on characterization results, tested in production at V_{DD} max. and f_{CPU} max.
- 3. CPU running with memory access, all I/O pins in input mode with a static value at V_{DD} or V_{SS} (no load), all peripherals in reset state; clock input (OSC1) driven by external square wave, CSS and LVD disabled.
- 4. SLOW mode selected with f_{CPU} based on f_{OSC} divided by 32. All I/O pins in input mode with a static value at V_{DD} or V_{SS} (no load), all peripherals in reset state; clock input (OSC1) driven by external square wave, CSS and LVD disabled.

SUPPLY CURRENT CHARACTERISTICS (Cont'd)

14.4.2 WAIT and SLOW WAIT Modes

Symbol	Parameter		Conditions	Typ ¹⁾	Max ²⁾	Unit
	Supply current in WAIT mode ³⁾ (see Figure 61)	′≤V _{DD} ≤5.5V	f _{OSC} =1MHz, f _{CPU} =500kHz f _{OSC} =4MHz, f _{CPU} =2MHz f _{OSC} =16MHz, f _{CPU} =8MHz	150 560 2200	280 900 3000	
1	Supply current in SLOW WAIT mode ⁴⁾ (see Figure 62)	4.5V≤V _□	f _{OSC} =1MHz, f _{CPU} =31.25kHz f _{OSC} =4MHz, f _{CPU} =125kHz f _{OSC} =16MHz, f _{CPU} =500kHz	20 90 340	70 190 850	μА
I _{DD}	Supply current in WAIT mode ³⁾ (see Figure 61)	≤V _{DD} ≤3.6V	f _{OSC} =1MHz, f _{CPU} =500kHz f _{OSC} =4MHz, f _{CPU} =2MHz f _{OSC} =16MHz, f _{CPU} =8MHz	90 350 1370	200 550 1900	μΛ
	Supply current in SLOW WAIT mode ⁴⁾ (see Figure 62)	3.2V≤V _[f _{OSC} =1MHz, f _{CPU} =31.25kHz f _{OSC} =4MHz, f _{CPU} =125kHz f _{OSC} =16MHz, f _{CPU} =500kHz	10 50 200	20 80 350	

Figure 61. Typical I_{DD} in WAIT vs. f_{CPU}

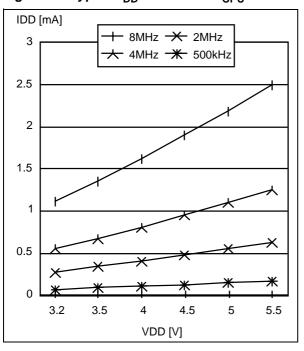
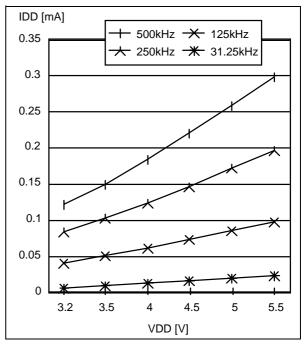


Figure 62. Typical I_{DD} in SLOW-WAIT vs. f_{CPU}



Notes:

- 1. Typical data are based on T_A=25°C, V_DD=5V (4.5V \leq V_DD \leq 5.5V range) and V_DD=3.4V (3.2V \leq V_DD \leq 3.6V range).
- 2. Data based on characterization results, tested in production at V_{DD} max. and f_{CPU} max.
- 3. All I/O pins in input mode with a static value at V_{DD} or V_{SS} (no load), all peripherals in reset state; clock input (OSC1) driven by external square wave, CSS and LVD disabled.
- 4. SLOW-WAIT mode selected with f_{CPU} based on f_{OSC} divided by 32. All I/O pins in input mode with a static value at V_{DD} or V_{SS} (no load), all peripherals in reset state; clock input (OSC1) driven by external square wave, CSS and LVD disabled.

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SUPPLY CURRENT CHARACTERISTICS (Cont'd)

14.4.3 HALT Mode

Symbol	Parameter	C	onditions	Typ ¹⁾	Max	Unit
		\/ E E\/	-40°C≤T _A ≤+85°C		10	
	Supply current in HALT mode ²⁾	V _{DD} =5.5V	-40°C≤T _A ≤+125°C	0	150	^
IDD	Supply current in HALT mode	V _{DD} =3.6V	-40°C≤T _A ≤+85°C	U	6	μΑ
		v _{DD} =3.6v	-40°C≤T _A ≤+125°C		100	

14.4.4 Supply and Clock Managers

The previous current consumption specified for the ST7 functional operating modes over temperature range does not take into account the clock source current consumption. To get the total device consumption, the two current values must be added (except for HALT mode).

Symbol	Parameter	Conditions	Typ 1)	Max 3)	Unit
	Supply current of internal RC oscillator		500	750	
	Supply current of external RC oscillator 4)		525	750	
I _{DD(CK)}	Supply current of resonator oscillator 4) & 5)	LP: Low power oscillator MP: Medium power oscillator MS: Medium speed oscillator HS: High speed oscillator	200 300 450 700	400 550 750 1000	μΑ
	Clock security system supply current		150	350	
I _{DD(LVD)}	LVD supply current	HALT mode	100	150	

14.4.5 On-Chip Peripherals

Symbol	Parameter	Co	nditions	Тур	Unit
L	16-bit Timer supply current ⁶⁾	f	V _{DD} =3.4V	50	
IDD(TIM)	To-bit Timer supply current	f _{CPU} =8MHz	V _{DD} =5.0V	150	
l	SPI supply current ⁷⁾	f _{CPU} =8MHz	V _{DD} =3.4V	250	
I _{DD(SPI)}	or r supply current		V _{DD} =5.0V	350	μA
l	I ² C supply current ⁸⁾	f _{CPU} =8MHz	V _{DD} =3.4V	250	μΑ
IDD(I2C)	To supply culterit		V _{DD} =5.0V	350	
l==/.==	I _{DD(ADC)} ADC supply current when converting ⁹⁾ f _A	f _{ADC} =4MHz	V _{DD} =3.4V	800	
IDD(ADC)	ADO Supply current when converting	ADC-4MI	V _{DD} =5.0V	1100	

Notes:

- 1. Typical data are based on T_A=25°C.
- 2. All I/O pins in input mode with a static value at V_{DD} or V_{SS} (no load), CSS and LVD disabled. Data based on characterization results, tested in production at V_{DD} max. and f_{CPU} max.
- 3. Data based on characterization results, not tested in production.
- 4. Data based on characterization results done with the external components specified in Section 14.5.3 and Section 14.5.4, not tested in production.
- 5. As the oscillator is based on a current source, the consumption does not depend on the voltage.
- 6. Data based on a differential I_{DD} measurement between reset configuration (timer counter running at $f_{CPU}/4$) and timer counter stopped (selecting external clock capability). Data valid for one timer.
- 7. Data based on a differential I_{DD} measurement between reset configuration and a permanent SPI master communication (data sent equal to 55h).
- 8. Data based on a differential I_{DD} measurement between reset configuration and I2C peripheral enabled (PE bit set).
- 9. Data based on a differential I_{DD} measurement between reset configuration and continuous A/D conversions.

14.5 CLOCK AND TIMING CHARACTERISTICS

Subject to general operating conditions for V_{DD} , f_{OSC} , and T_A .

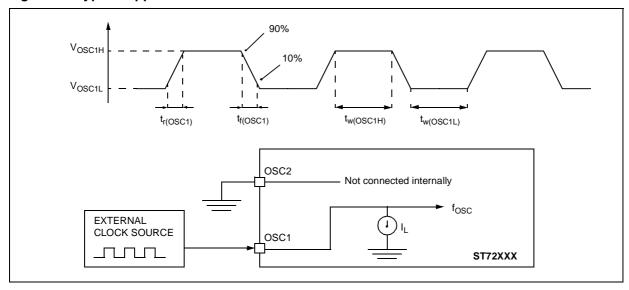
14.5.1 General Timings

Symbol	Parameter	Conditions	Min	Typ ¹⁾	Max	Unit
t	Instruction cycle time		2	3	12	t _{CPU}
^t c(INST)	instruction cycle time	f _{CPU} =8MHz	250	375	1500	ns
+	Interrupt reaction time ²⁾		10		22	t _{CPU}
^t ∨(IT)	$t_{V(IT)} = \Delta t_{C(INST)} + 10$	f _{CPU} =8MHz	1.25		2.75	μs

14.5.2 External Clock Source

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OSC1H}	OSC1 input pin high level voltage		$0.7xV_{DD}$		V_{DD}	\/
V _{OSC1L}	OSC1 input pin low level voltage		V _{SS}		0.3xV _{DD}	V
$t_{w(OSC1H)}$ $t_{w(OSC1L)}$	OSC1 high or low time ³⁾	see Figure 63	15			ns
$t_{r(OSC1)}$ $t_{f(OSC1)}$	OSC1 rise or fall time ³⁾				15	113
ΙL	OSCx Input leakage current	V _{SS} ≤V _{IN} ≤V _{DD}			±1	μΑ

Figure 63. Typical Application with an External Clock Source



Notes:

- 1. Data based on typical application software.
- 2. Time measured between interrupt event and interrupt vector fetch. $\Delta t_{\text{c(INST)}}$ is the number of t_{CPU} cycles needed to finish the current instruction execution.
- 3. Data based on design simulation and/or technology characteristics, not tested in production.

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CLOCK AND TIMING CHARACTERISTICS (Cont'd)

14.5.3 Crystal and Ceramic Resonator Oscillators

The ST7 internal clock can be supplied with four different Crystal/Ceramic resonator oscillators. All the information given in this paragraph are based on characterization results with specified typical external components. In the application, the resonator and the load capacitors have to be placed as

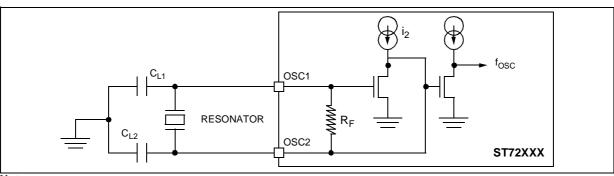
close as possible to the oscillator pins in order to minimize output distortion and start-up stabilization time. Refer to the crystal/ceramic resonator manufacturer for more details (frequency, package, accuracy...).

Symbol	Parameter	Conditions		Min	Max	Unit
		LP: Low powe	r oscillator	1	2	
f	Oscillator Frequency 3)	MP: Medium p	ower oscillator	>2	4	MHz
fosc	Oscillator Frequency	MS: Medium s	peed oscillator	>4	8	IVIITZ
		HS: High spee	ed oscillator	>8	16	
R _F	Feedback resistor			20	40	kΩ
	Pagammandad laad canacitanga yar	R _S =200Ω	LP oscillator	38	56	
C _{L1}	Recommended load capacitance versus equivalent serial resistance of the	$R_S=200\Omega$	MP oscillator	32	46	nE
C_{L2}	· •	$R_S=200\Omega$	MS oscillator	18	26	pF
LZ	crystal or ceramic resonator (R _S)	$R_S=100\Omega$	HS oscillator	15	21	
		V _{DD} =5V	LP oscillator	40	100	
i ₂	OSC2 driving current	$V_{IN}=V_{SS}$	MP oscillator	110	190	
	OSC2 driving current		MS oscillator	180	360	μΑ
			HS oscillator	400	700	

14.5.3.1 Typical Crystal Resonators

Option Byte Config.		Reference	Freq.	Characteristic ¹⁾	C _{L1} [pF]		t _{SU(osc)} [ms] ²⁾
LP		S-200-30-30/50	2MHz	Δf_{OSC} =[±30ppm _{25°C} ,±30ppm _{ΔTa}], Typ. R _S =200 Ω	33	34	10~15
MP	ICH	SS3-400-30-30/30	4MHz	Δf_{OSC} =[±30ppm _{25°C} ,±30ppm _{ΔTa}], Typ. R _S =60 Ω	33	34	7~10
MS	JAU	SS3-800-30-30/30	8MHz	Δf_{OSC} =[±30ppm _{25°C} ,±30ppm _{ΔTa}], Typ. R _S =25 Ω	33	34	2.5~3
HS	,	SS3-1600-30-30/30	16MHz	Δf_{OSC} =[±30ppm _{25°C} ,±30ppm _{ΔTa}], Typ. R _S =15 Ω	33	34	1~1.5

Figure 64. Typical Application with a Crystal Resonator



Notes:

- 1. Resonator characteristics given by the crystal manufacturer.
- 2. $t_{SU(OSC)}$ is the typical oscillator start-up time measured between V_{DD} =2.8V and the fetch of the first instruction (with a quick V_{DD} ramp-up from 0 to 5V (<50 μ s).
- $\overline{3}$. The oscillator selection can be optimized in terms of supply current using an high quality resonator with small R_S value. Refer to crystal manufacturer for more details.

CLOCK AND TIMING CHARACTERISTICS (Cont'd)

14.5.3.2 Typical Ceramic Resonators

Symbol	Parameter	Conditions		Тур	Unit
	Ceramic resonator start-up time	LP	2MHz	4.2	mc
		MP	4MHz	2.1	
^I SU(osc)	Ceramic resonator start-up time	MS	8MHz	1.1	ms
		HS	16MHz	0.7	

 $t_{SU(OSC)}$ is the typical oscillator start-up time measured between V_{DD} =2.8V and the fetch of the first instruction (with a quick V_{DD} ramp-up from 0 to 5V (<50 μ s).

Table 21. Typical Ceramic Resonators for General Purpose Applications

Option Byte Config.	f _{OSC} (MHz)	Resonator Part Number ¹	C _{L1} [pF] ³	C _{L2} [pF] ³	R _{FEXT} [kΩ]	R_D [k Ω]
	1	CSB1000J	100	100		3.3
LP		CSBF1000J	100	100		3.3
LF	2	CSTS0200MG06		(47)	Open	
		CSTCC2.00MG0H6				
	2	CSTS0200MG06				
MP	2	CSTCC2.00MG0H6				
IVIF	4	CSTS0400MG06				
	4	CSTCC4.00MG0H6	(47)			
	4	CSTS0400MG06	(47)			
MS	4	CSTCC4.00MG0H6				
IVIO	8	CSTS0800MG06			Ореп	
	O	CSTCC8.00MG0H6				
	8	CSTS0800MG06				0
	0	CSTCC8.00MG0H6				
	10	CSTS1000MG03	(15)	(15)		
		CSTCC10.0MG	(15)			
	12	CST12.0MTW	30	30	-	
HS		CSTCV12.0MTJ0C4	(22)	(22)		
	16 ²	CSA16.00MXZ040	15	15		
		CST16.00MXW0C3	(15)	(15)		
		CSACV16.00MXJ040	15	15		
		CSTCV16.00MXJ0C3	(15)	(15)	10	
		CSACW1600MX03	10	10		

Notes:

- 1. Murata Ceralock (refer to Table 23 for correlation factor)
- 2. V_{DD} 4.5 to 5.5V
- 3. Values in parentheses refer to the capacitors integrated in the resonator

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CLOCK AND TIMING CHARACTERISTICS (Cont'd)

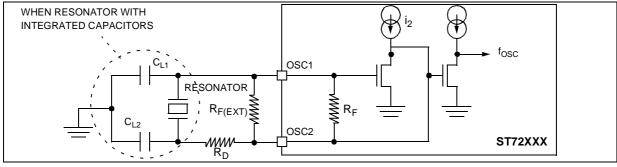
Table 22. Typical Ceramic Resonators for Automotive Applications

Option Byte Config.	f _{OSC} (MHz)	Resonator Part Number ¹	C _{L1} [pF] ³	C _{L2} [pF] ³	R _{FEXT} [kΩ]	R_{D} [k Ω]
	1	CSB1000JA	100	100		3.3
LP		CSBF1000JA				3.3
	2	CSTS0200MGA06		(47)	Open	
		CSTCC2.00MGA0H6				
	2	CSTS0200MGA06				
MP		CSTCC2.00MGA0H6				
IVIP	4	CSTS0400MGA06				
	4	CSTCC4.00MGA0H6	(47)			
	4	CSTS0400MGA06	(47)			
MS		CSTCC4.00MGA0H6				0
IVIO	8	CSTS0800MGA06				
		CSTCC8.00MGA0H6				
	8	CSTS0800MGA06				U
	0	CSTCC8.00MGA0H6				
	10	CSTS1000MGA03	(15)	(1E)		
	10	CSTCC10.0MGA	(15)	(15)		
HS	12	CST12.0MTWA	30	30		
пъ	12	CSTCS12.0MTA	(30)	(30)		
		CSA16.00MXZA040	15	15		
	16 ²	CST16.00MXWA0C3	(15)	(15)		
	16-	CSACV16.00MXA040Q	15	15	10	
		CSTCV16.00MXA0H3Q	(15)	(15)	10	

Notes:

- 1. Murata Ceralock (refer to Table 23 for correlation factor)
- 2. V_{DD} 4.5 to 5.5V
- 3. Values in parentheses refer to the capacitors integrated in the resonator

Figure 65. Typical Application with Ceramic Resonator



Notes

- 1. Resonator characteristics given by the ceramic resonator manufacturer.
- 2. $t_{SU(OSC)}$ is the typical oscillator start-up time measured between V_{DD} =2.8V and the fetch of the first instruction (with a quick V_{DD} ramp-up from 0 to 5V (<50 μ s).
- 3. The oscillator selection can be optimized in terms of supply current using an high quality resonator with small R_S value. Refer to ceramic resonator manufacturer for more details.

CLOCK AND TIMING CHARACTERISTICS (Cont'd)

Table 23. Ceramic Resonator Frequency Correlation Factor¹

Option Byte Config.	Resonator ¹⁾	Corre- lation %	Refer- ence IC		
	CSB1000J	+0.03	4069UBE		
LP	CSTS0200MG06	-0.16			
	CSTCC2.00MG0H6	-0.10			
	CSTS0200MG06	-0.15			
	CSTCC2.00MG0H6	-0.14	74HCU04		
MP	CSTS0400MG06	0.00			
	CSTS0400MGA06	-0.01			
	CSTCC4.00MG0H6	-0.02			
	CSTS0200MG06	-0.15			
	CSTCC2.00MG0H6	-0.14			
MS	CSTS0400MG06	0.00	74HCU04		
IVIS	CSTS0400MGA06	-0.01	74110004		
	CSTCC4.00MG0H6	-0.02			
	CSTS0200MG06	-0.15			

Option Byte Config.	Resonator ¹⁾	Corre- lation %	Refer- ence IC
	CSTS0800MG06	+0.10	
	CSTS0800MGA06	+0.07	74HCU04
	CSTCC8.00MG0H6	+0.09	
	CSTS1000MG03	+0.34	4069UBP
	CSTCC10.0MG	+0.75	4069UBE
HS	CST12.0MTW	+0.45	4069UBE
110	CSTCV12.0MTJ0C4	+0.30	40H004
	CSTCS12.0MTA	+0.50	4069UBE
	CSA16.00MXZ040	+0.10	
	CSACV16.00MXJ040	+0.09	74HCU04
	CSACW1600MX03	+0.03	7 71 10 004
	CSACV16.00MXA040Q	+0.09	

Notes:

1. See Table 21 and Table 22 for ceramic resonator values.

CLOCK CHARACTERISTICS (Cont'd)

14.5.4 RC Oscillators

The ST7 internal clock can be supplied with an RC oscillator. This oscillator can be used with internal or external components (selectable by option byte).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
	Internal RC oscillator frequency 1)	see Figure 67	3.60		5.10	MHz
†osc	External RC oscillator frequency 2)		1		14	IVIITIZ
	Internal RC Oscillator Start-up Time 3)			2.0		
	External RC Oscillator Start-up Time 3)	R_{EX} =47 $K\Omega$, C_{EX} ="0"pF		1.0		
t _{SU(OSC)}		R_{EX} =47 $K\Omega$, C_{EX} =100pF		6.5		ms
		R_{EX} =10K Ω , C_{EX} =6.8pF		0.7		
		R_{EX} =10K Ω , C_{EX} =470pF		3.0		
R _{EX}	Oscillator external resistor 4)	see Figure 68	10		47	ΚΩ
C _{EX}	Oscillator external capacitor	See i igule oo	0 ⁵⁾		470	pF

Figure 66. Typical Application with RC oscillator

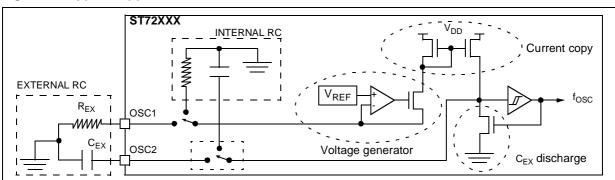


Figure 67. Typical Internal RC Oscillator

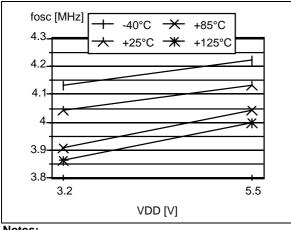
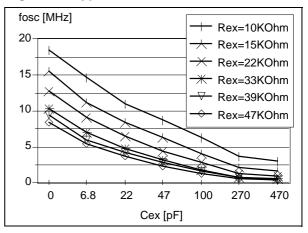


Figure 68. Typical External RC Oscillator



Notes:

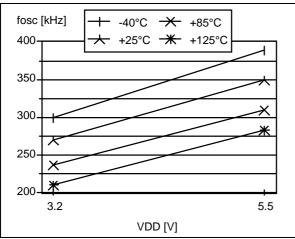
- 1. Data based on characterization results.
- 2. Guaranteed frequency range with the specified C_{EX} and R_{EX} ranges taking into account the device process variation. Data based on design simulation.
- 3. Data based on characterization results done with V_{DD} nominal at 5V, not tested in production.
- 4. R_{EX} must have a positive temperature coefficient (ppm/°C), carbon resistors should therefore not be used.
- 5. Important: when no external C_{EX} is applied, the capacitance to be considered is the global parasitic capacitance which is subject to high variation (package, application...). In this case, the RC oscillator frequency tuning has to be done by trying out several resistor values.

CLOCK CHARACTERISTICS (Cont'd)

14.5.5 Clock Security System (CSS)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f _{SFOSC} Safe Oscillator Frequence	Safa Oscillator Fraguency 1)	T _A =25°C, V _{DD} =5.0V	250	340	550	kHz
	Sale Oscillator Frequency	T _A =25°C, V _{DD} =3.4V	190	260	450	KI IZ
f _{GFOSC}	Glitch Filtered Frequency 2)			30		MHz

Figure 69. Typical Safe Oscillator Frequencies



Note:

- 1. Data based on characterization results, tested in production between 90KHz and 600KHz.
- 2. Filtered glitch on the $f_{\mbox{OSC}}$ signal. See functional description in Section 7.5 on page 23 for more details.

14.6 MEMORY CHARACTERISTICS

Subject to general operating conditions for V_{DD} , f_{OSC} , and T_A unless otherwise specified.

14.6.1 RAM and Hardware Registers

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{RM}	Data retention mode 1)	HALT mode (or RESET)	1.6			V

14.6.2 FLASH Program Memory

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{A(prog)}	Programming temperature range ²⁾		0	25	70	°C
+	Programming time for 1~16 bytes 3)	T _A =+25°C		8	25	ms
^L prog	Programming time for 4 or 8kBytes	T _A =+25°C		2.1	6.4	sec
t _{ret}	Data retention 5)	T _A =+55°C ⁴⁾	20			years
N _{RW}	Write erase cycles 5)	T _A =+25°C	100			cycles

Notes:

- 1. Minimum V_{DD} supply voltage without losing data stored in RAM (in HALT mode or under RESET) or in hardware registers (only in HALT mode). Guaranteed by construction, not tested in production.
- 2. Data based on characterization results, tested in production at $T_A=25$ °C.
- 3. Up to 16 bytes can be programmed at a time for a 4kBytes FLASH block (then up to 32 bytes at a time for an 8k device)
- 4. The data retention time increases when the $T_{\mbox{\scriptsize A}}$ decreases.
- 5. Data based on reliability test results and monitored in production.

14.7 EMC CHARACTERISTICS

Susceptibility tests are performed on a sample basis during product characterization.

14.7.1 Functional EMS

(Electro Magnetic Susceptibility)

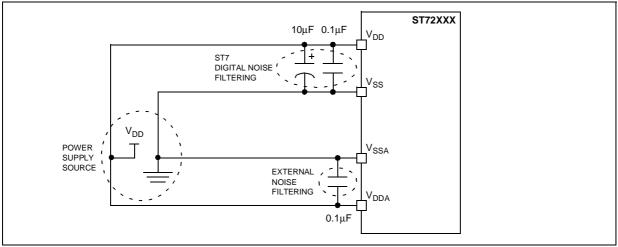
Based on a simple running application on the product (toggling 2 LEDs through I/O ports), the product is stressed by two electro magnetic events until a failure occurs (indicated by the LEDs).

- ESD: Electro-Static Discharge (positive and negative) is applied on all pins of the device until a functional disturbance occurs. This test conforms with the IEC 1000-4-2 standard.
- FTB: A Burst of Fast Transient voltage (positive and negative) is applied to V_{DD} and V_{SS} through a 100pF capacitor, until a functional disturbance occurs. This test conforms with the IEC 1000-4-4 standard.

A device reset allows normal operations to be resumed.

Symbol	Parameter	Parameter Conditions		Pos 1)	Unit
V _{FESD}	Voltage limits to be applied on any I/O pin to induce a functional disturbance	V _{DD} =5V, T _A =+25°C, f _{OSC} =8MHz conforms to IEC 1000-4-2	-1	1	
V _{FFTB}	Fast transient voltage burst limits to be applied through 100pF on V _{DD} and V _{DD} pins to induce a functional disturbance	V _{DD} =5V, T _A =+25°C, f _{OSC} =8MHz conforms to IEC 1000-4-4	-4	4	kV

Figure 70. EMC Recommended star network power supply connection 2)



Notes:

- 1. Data based on characterization results, not tested in production.
- 2. The suggested μ and 0.1 μ F decoupling capacitors on the power supply lines are proposed as a good price vs. EMC performance tradeoff. They have to be put as close as possible to the device power supply pins. Other EMC recommendations are given in other sections (I/Os, RESET, OSCx pin characteristics).

14.7.2 Absolute Electrical Sensitivity

Based on three different tests (ESD, LU and DLU) using specific measurement methods, the product is stressed in order to determine its performance in terms of electrical sensitivity. For more details, refer to the AN1181 ST7 application note.

14.7.2.1 Electro-Static Discharge (ESD)

Electro-Static Discharges (3 positive then 3 negative pulses separated by 1 second) are applied to the pins of each sample according to each pin combination. The sample size depends of the number of supply pins of the device (3 parts*(n+1) supply pin). Two models are usually simulated: Human Body Model and Machine Model. This test conforms to the JESD22-A114A/A115A standard. See Figure 71 and the following test sequences.

Human Body Model Test Sequence

- C_L is loaded through S1 by the HV pulse generator.
- S1 switches position from generator to R.
- A discharge from C_L through R (body resistance) to the ST7 occurs.
- S2 must be closed 10 to 100ms after the pulse delivery period to ensure the ST7 is not left in charge state. S2 must be opened at least 10ms prior to the delivery of the next pulse.

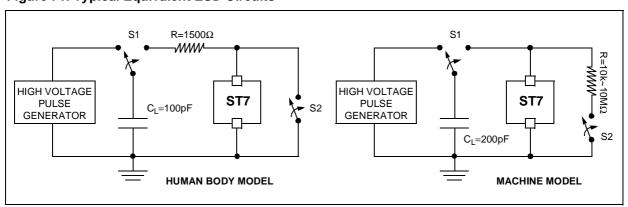
Machine Model Test Sequence

- C_L is loaded through S1 by the HV pulse generator.
- S1 switches position from generator to ST7.
- A discharge from C_I to the ST7 occurs.
- S2 must be closed 10 to 100ms after the pulse delivery period to ensure the ST7 is not left in charge state. S2 must be opened at least 10ms prior to the delivery of the next pulse.
- R (machine resistance), in series with S2, ensures a slow discharge of the ST7.

Absolute Maximum Ratings

Symbol	Ratings	Conditions	Maximum value 1)	Unit
V _{ESD(HBM)}	Electro-static discharge voltage (Human Body Model)	T _A =+25°C	2000	V
V _{ESD(MM)}	Electro-static discharge voltage (Machine Model)	T _A =+25°C	200	V

Figure 71. Typical Equivalent ESD Circuits



Notes:

1. Data based on characterization results, not tested in production.

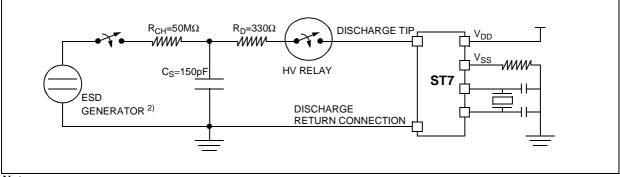
14.7.2.2 Static and Dynamic Latch-Up

- LU: 3 complementary static tests are required on 10 parts to assess the latch-up performance. A supply overvoltage (applied to each power supply pin), a current injection (applied to each input, output and configurable I/O pin) and a power supply switch sequence are performed on each sample. This test conforms to the EIA/ JESD 78 IC latch-up standard. For more details, refer to the AN1181 ST7 application note.
- DLU: Electro-Static Discharges (one positive then one negative test) are applied to each pin of 3 samples when the micro is running to assess the latch-up performance in dynamic mode. Power supplies are set to the typical values, the oscillator is connected as near as possible to the pins of the micro and the component is put in reset mode. This test conforms to the IEC1000-4-2 and SAEJ1752/3 standards and is described in Figure 72. For more details, refer to the AN1181 ST7 application note.

Electrical Sensitivities

Symbol	Parameter	Conditions	Class 1)
LU	Static latch-up class	T _A =+25°C T _A =+85°C	A A
DLU	Dynamic latch-up class	V_{DD} =5.5V, f_{OSC} =4MHz, T_A =+25°C	A

Figure 72. Simplified Diagram of the ESD Generator for DLU



Notes:

- 1. Class description: A Class is an STMicroelectronics internal specification. All its limits are higher than the JEDEC specifications, that means when a device belongs to Class A it exceeds the JEDEC standard. B Class strictly covers all the JEDEC criteria (international standard).
- 2. Schaffner NSG435 with a pointed test finger.

14.7.3 ESD Pin Protection Strategy

To protect an integrated circuit against Electro-Static Discharge the stress must be controlled to prevent degradation or destruction of the circuit elements. The stress generally affects the circuit elements which are connected to the pads but can also affect the internal devices when the supply pads receive the stress. The elements to be protected must not receive excessive current, voltage or heating within their structure.

An ESD network combines the different input and output ESD protections. This network works, by allowing safe discharge paths for the pins subjected to ESD stress. Two critical ESD stress cases are presented in Figure 73 and Figure 74 for standard pins and in Figure 75 and Figure 76 for true open drain pins.

Standard Pin Protection

To protect the output structure the following elements are added:

- A diode to V_{DD} (3a) and a diode from V_{SS} (3b)
- A protection device between V_{DD} and V_{SS} (4) To protect the input structure the following elements are added:
 - A resistor in series with the pad (1)

 - A diode to $\rm V_{DD}$ (2a) and a diode from $\rm V_{SS}$ (2b) A protection device between $\rm V_{DD}$ and $\rm V_{SS}$ (4)

Figure 73. Positive Stress on a Standard Pad vs. V_{SS}

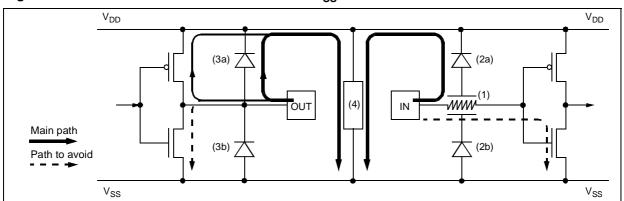
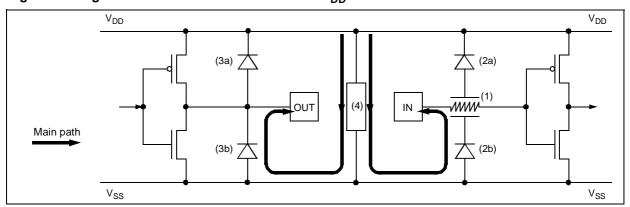


Figure 74. Negative Stress on a Standard Pad vs. V_{DD}



True Open Drain Pin Protection

The centralized protection (4) is not involved in the discharge of the ESD stresses applied to true open drain pads due to the fact that a P-Buffer and diode to V_{DD} are not implemented. An additional local protection between the pad and V_{SS} (5a & 5b) is implemented to completely absorb the positive ESD discharge.

Multisupply Configuration

When several types of ground (V_{SS} , V_{SSA} , ...) and power supply (V_{DD} , V_{DDA} , ...) are available for any reason (better noise immunity...), the structure shown in Figure 77 is implemented to protect the device against ESD.

Figure 75. Positive Stress on a True Open Drain Pad vs. V_{SS}

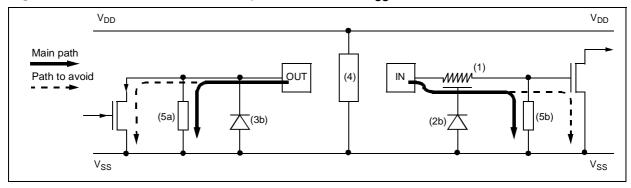


Figure 76. Negative Stress on a True Open Drain Pad vs. V_{DD}

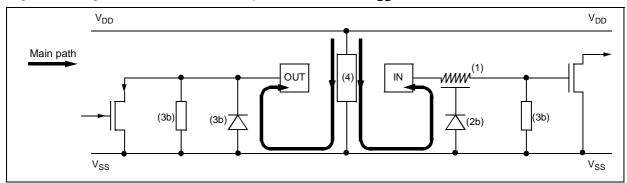
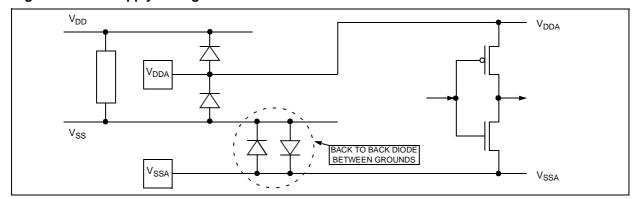


Figure 77. Multisupply Configuration



14.8 I/O PORT PIN CHARACTERISTICS

14.8.1 General Characteristics

Subject to general operating conditions for V_{DD} , f_{OSC} , and T_A unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ ¹⁾	Max	Unit
V_{IL}	Input low level voltage 2)					$0.3xV_{DD}$	V
V _{IH}	Input high level voltage 2)			$0.7xV_{DD}$			V
V _{hys}	Schmitt trigger voltage hysteresis 3)				400		mV
ΙL	Input leakage current	V _{SS} \leq V _{IN} \leq V	$V_{SS} \leq V_{IN} \leq V_{DD}$			±1	Λ
I _S	Static current consumption 4)	Floating inp	ut mode			200	μΑ
D	Weak pull-up equivalent resistor 5)	V _{IN} =V _{SS}	V _{DD} =5V	62	120	250	kΩ
R _{PU}	weak pull-up equivalent resistor	VIN-VSS	V _{DD} =3.4V	170	200	300	NS2
C _{IO}	I/O pin capacitance		•		5		pF
t _{f(IO)out}	Output high to low level fall time 6)	C _L =50pF Between 10% and 90%			25		ns
t _{r(IO)out}	Output low to high level rise time 6)				25		115
t _{w(IT)in}	External interrupt pulse time 7)			1			t _{CPU}

Figure 78. Two typical Applications with unused I/O Pin

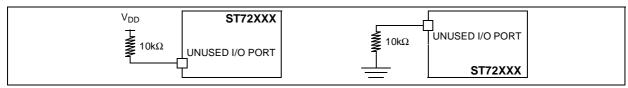
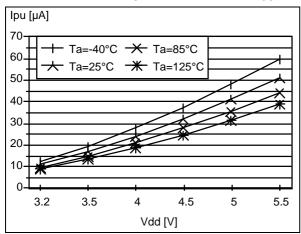


Figure 79. Typical I_{PU} vs. V_{DD} with V_{IN}=V_{SS}



Notes:

- 1. Unless otherwise specified, typical data are based on $T_A=25$ °C and $V_{DD}=5$ V.
- 2. Data based on characterization results, not tested in production.
- 3. Hysteresis voltage between Schmitt trigger switching levels. Based on characterization results, not tested.
- 4. Configuration not recommended, all unused pins must be kept at a fixed voltage: using the output mode of the I/O for example or an external pull-up or pull-down resistor (see Figure 78). Data based on design simulation and/or technology characteristics, not tested in production.
- 5. The R_{PU} pull-up equivalent resistor is based on a resistive transistor (corresponding I_{PU} current characteristics described in Figure 79). This data is based on characterization results, tested in production at V_{DD} max.
- 6. Data based on characterization results, not tested in production.
- 7. To generate an external interrupt, a minimum pulse width has to be applied on an I/O port pin configured as an external interrupt source.

I/O PORT PIN CHARACTERISTICS (Cont'd)

14.8.2 Output Driving Current

Subject to general operating conditions for V_{DD} , f_{OSC} , and T_A unless otherwise specified.

Symbol	Parameter		Conditions	Min	Max	Unit
	Output low level voltage for a standard I/O pin when 8 pins are sunk at same time		I_{IO} =+5mA T_{A} ≤85°C T_{A} ≥85°C		1.3 1.5	
V _{OL} 1)	(see Figure 80 and Figure 83)		I_{IO} =+2mA T_A ≤85°C T_A ≥85°C		0.65 0.75	
VOL /		=2N	I_{IO} =+20mA, T_A ≤85°C T_A ≥85°C		1.5 1.7	V
		V _{DD} =	I_{IO} =+8mA T_A ≤85°C T_A ≥85°C		0.75 0.85	V
V _{OH} ²⁾	Output high level voltage for an I/O pin		I_{IO} =-5mA, $T_A \le 85$ °C $T_A \ge 85$ °C	V _{DD} -1.6 V _{DD} -1.7		
	when 4 pins are sourced at same time (see Figure 82 and Figure 85)		I_{IO} =-2mA T_A \leq 85°C T_A \geq 85°C			

Figure 80. Typical V_{OL} at V_{DD}=5V (standard)

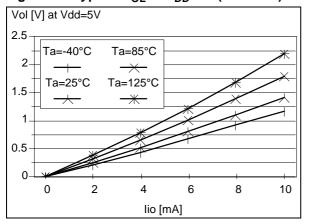


Figure 81. Typical V_{OL} at V_{DD}=5V (high-sink)

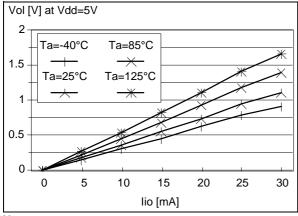
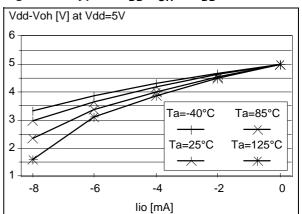


Figure 82. Typical V_{DD} - V_{OH} at V_{DD} =5V



Notes:

^{1.} The I_{IO} current sunk must always respect the absolute maximum rating specified in Section 14.2.2 and the sum of I_{IO} (I/O ports and control pins) must not exceed I_{VSS} .

^{2.} The I_{IO} current sourced must always respect the absolute maximum rating specified in Section 14.2.2 and the sum of I_{IO} (I/O ports and control pins) must not exceed I_{VDD} . True open drain I/O pins does not have V_{OH} .

I/O PORT PIN CHARACTERISTICS (Cont'd)

Figure 83. Typical V_{OL} vs. V_{DD} (standard I/Os)

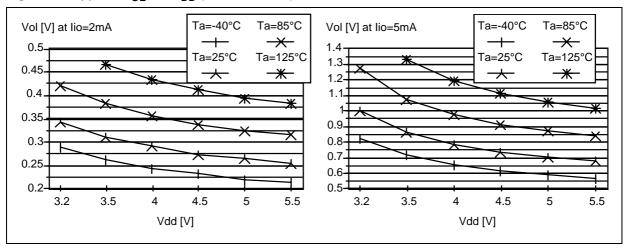


Figure 84. Typical V_{OL} vs. V_{DD} (high-sink I/Os)

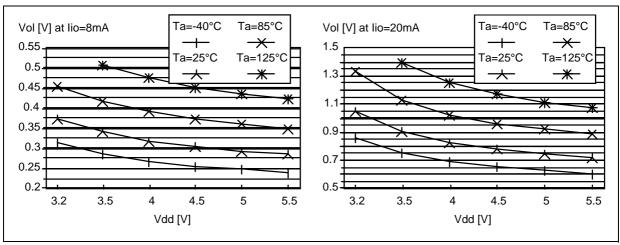
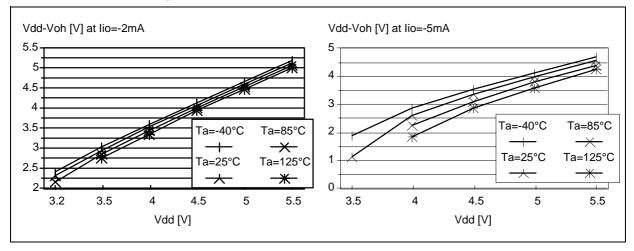


Figure 85. Typical V_{DD} - V_{OH} vs. V_{DD}



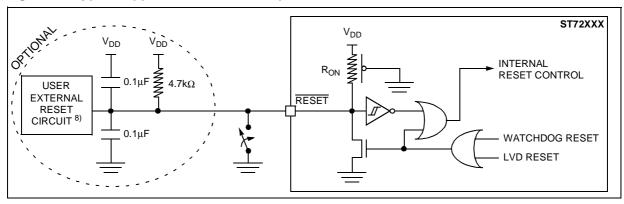
14.9 CONTROL PIN CHARACTERISTICS

14.9.1 Asynchronous RESET Pin

Subject to general operating conditions for V_{DD} , f_{OSC} , and T_A unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ ¹⁾	Max	Unit	
V _{IL}	Input low level voltage 2)					$0.3xV_{DD}$	V	
V _{IH}	Input high level voltage 2)			$0.7xV_{DD}$				
V _{hys}	Schmitt trigger voltage hysteresis 3)				400		mV	
V _{OL}	Output low level voltage 4)	V _{DD} =5V	I _{IO} =+5mA		0.68	0.95	V	
VOL	(see Figure 88, Figure 89)		I _{IO} =+2mA		0.28	0.45	V	
R _{ON}	Weak pull-up equivalent resistor 5)	\	\/ -\/	$V_{DD}=5V$ $V_{DD}=3.4V$	20	40	60	kΩ
NON	weak pull-up equivalent resistor	V _{IN} =V _{SS}	V _{DD} =3.4V	80	100	120	KS2	
t(DOTL)	Generated reset pulse duration	External p			6		1/f _{SFOSC}	
tw(RSTL)out	Generated reset pulse duration	internal reset sources			30		μs	
t _{h(RSTL)in}	External reset pulse hold time ⁶⁾			20			μs	
t _{g(RSTL)in}	Filtered glitch duration ⁷⁾					100	ns	

Figure 86. Typical Application with RESET pin 8)



Notes:

- Unless otherwise specified, typical data are based on T_A=25°C and V_{DD}=5V.
- 2. Data based on characterization results, not tested in production.
- 3. Hysteresis voltage between Schmitt trigger switching levels. Based on characterization results, not tested.
- 4. The I_{IO} current sunk must always respect the absolute maximum rating specified in Section 14.2.2 and the sum of I_{IO} (I/O ports and control pins) must not exceed I_{VSS} .
- 5. The R_{ON} pull-up equivalent resistor is based on a resistive transistor (corresponding I_{ON} current characteristics described in Figure 87). This data is based on characterization results, not tested in production.
- $\underline{6}$. To guarantee the reset of the device, a minimum pulse has to be applied to $\overline{\text{RESET}}$ pin. All short pulses applied on RESET pin with a duration below $t_{h(RSTL)in}$ can be ignored.
- 7. The reset network (the resistor and two capacitors) protects the device against parasitic resets, especially in a noisy environments.
- 8. The output of the external reset circuit must have an open-drain output to drive the ST7 reset pad. Otherwise the device can be damaged when the ST7 generates an internal reset (LVD or watchdog).

CONTROL PIN CHARACTERISTICS (Cont'd)

Figure 87. Typical I_{ON} vs. V_{DD} with V_{IN} = V_{SS}

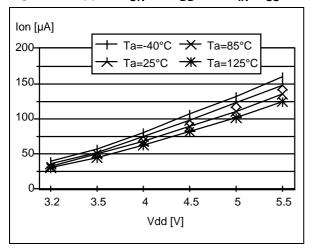


Figure 88. Typical V_{OL} at V_{DD} =5V (\overline{RESET})

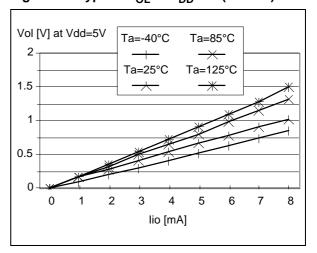
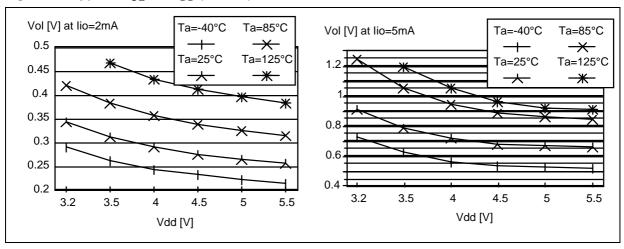


Figure 89. Typical V_{OL} vs. V_{DD} (RESET)



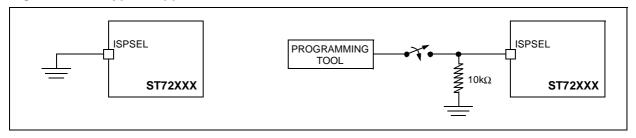
CONTROL PIN CHARACTERISTICS (Cont'd)

14.9.2 ISPSEL Pin

Subject to general operating conditions for V_{DD} , f_{OSC} , and T_A unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit
V_{IL}	Input low level voltage 1)		V_{SS}	0.2	V
V _{IH}	Input high level voltage 1)		V _{DD} -0.1	12.6	V
Ι _L	Input leakage current	V _{IN} =V _{SS}		±1	μΑ

Figure 90. Two typical Applications with ISPSEL Pin $^{2)}$



Notes:

- 1. Data based on design simulation and/or technology characteristics, not tested in production.
- 2. When the ISP Remote mode is not required by the application ISPSEL pin must be tied to V_{SS} .

14.10 TIMER PERIPHERAL CHARACTERISTICS

Subject to general operating conditions for $\rm V_{DD}, \rm f_{OSC},$ and $\rm T_A$ unless otherwise specified.

Refer to I/O port characteristics for more details on the input/output alternate function characteristics (output compare, input capture, external clock, PWM output...).

14.10.1 Watchdog Timer

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{w(WDG)}	Watchdog time-out duration		12,288		786,432	t _{CPU}
	Watchady lime-out duration	f _{CPU} =8MHz	1.54		98.3	ms

14.10.2 16-Bit Timer

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{w(ICAP)in}	Input capture pulse time		1			t _{CPU}
t(D)((A)	PWM resolution time		2			t _{CPU}
t _{res} (PWM)	r www resolution time	f _{CPU} =8MHz	250			ns
f _{EXT}	Timer external clock frequency		0		f _{CPU} /4	MHz
f _{PWM}	PWM repetition rate		0		f _{CPU} /4	MHz
Res _{PWM}	PWM resolution				16	bit

14.11 COMMUNICATION INTERFACE CHARACTERISTICS

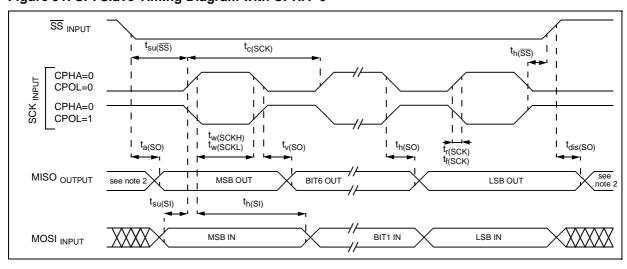
14.11.1 SPI - Serial Peripheral Interface

Subject to general operating conditions for $\rm V_{DD}, f_{OSC},$ and $\rm T_A$ unless otherwise specified.

Refer to I/O port characteristics for more details on the input/output alternate function characteristics (SS, SCK, MOSI, MISO).

Symbol	Parameter	Conditions	Min	Max	Unit		
f _{SCK}	SPI clock frequency	Master f _{CPU} =8MHz	f _{CPU} /128 0.0625	f _{CPU} /4 2	MHz		
1/t _{c(SCK)}	of Follock frequency	Slave f _{CPU} =8MHz	0	f _{CPU} /2 4	IVII IZ		
$t_{r(SCK)}$ $t_{f(SCK)}$	SPI clock rise and fall time		see I/O p	see I/O port pin descriptio			
t _{su(SS)}	SS setup time	Slave	120				
t _{h(SS)}	SS hold time	Slave	120				
t _{w(SCKH)}	SCK high and low time	Master Slave	100 90				
t _{su(MI)}	Data input setup time	Master Slave	100 100				
t _{h(MI)}	Data input hold time	Master Slave	100 100		ns		
t _{a(SO)}	Data output access time	Slave	0	120			
t _{dis(SO)}	Data output disable time	Slave		240			
t _{v(SO)}	Data output valid time	Slave (after enable edge)		120			
t _{h(SO)}	Data output hold time	- Slave (alter eriable edge)	0				
t _{v(MO)}	Data output valid time	Master (before capture edge)	0.25	_	t		
t _{h(MO)}	Data output hold time	- master (before capture edge)	0.25		t _{CPU}		

Figure 91. SPI Slave Timing Diagram with CPHA=0 3)



Notes:

- 1. Data based on design simulation and/or characterisation results, not tested in production.
- 2. When no communication is on-going the data output line of the SPI (MOSI in master mode, MISO in slave mode) has its alternate function capability released. In this case, the pin status depends on the I/O port configuration.
- 3. Measurement points are done at CMOS levels: 0.3xV_{DD} and 0.7xV_{DD}.

COMMUNICATION INTERFACE CHARACTERISTICS (Cont'd)

Figure 92. SPI Slave Timing Diagram with CPHA=11)

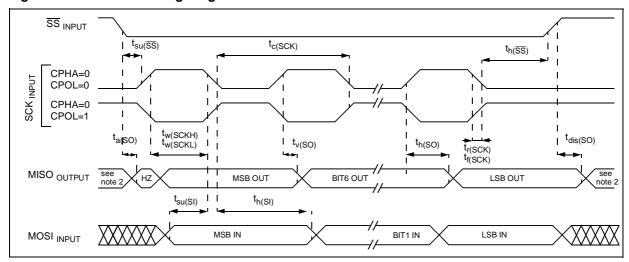
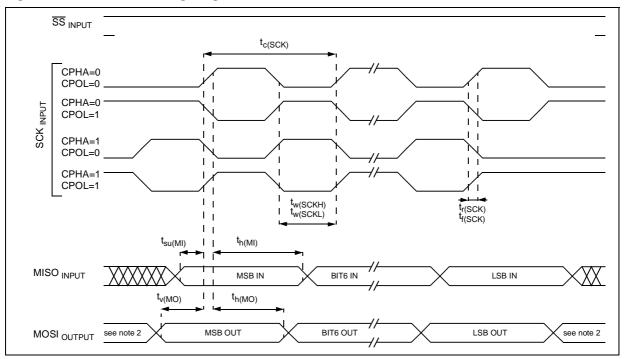


Figure 93. SPI Master Timing Diagram 1)



Notes:

- 1. Measurement points are done at CMOS levels: $0.3 \mathrm{xV}_{\mathrm{DD}}$ and $0.7 \mathrm{xV}_{\mathrm{DD}}$.
- 2. When no communication is on-going the data output line of the SPI (MOSI in master mode, MISO in slave mode) has its alternate function capability released. In this case, the pin status depends of the I/O port configuration.

COMMUNICATION INTERFACE CHARACTERISTICS (Cont'd)

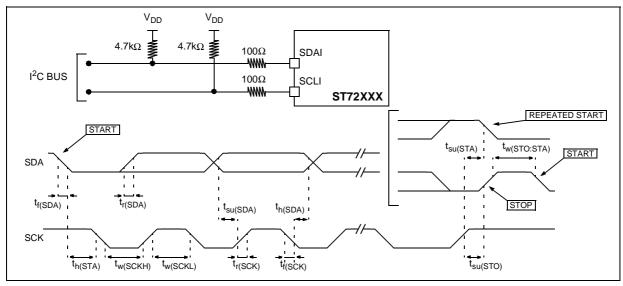
14.11.2 I²C - Inter IC Control Interface

Subject to general operating conditions for $\rm V_{DD}, \rm f_{OSC},$ and $\rm T_A$ unless otherwise specified.

Refer to I/O port characteristics for more details on the input/output alternate function characteristics (SDAI and SCLI). The ST7 I²C interface meets the requirements of the Standard I²C communication protocol described in the following table.

Cumbal	Devemates	Standard	mode I ² C	Fast mo	ode I ² C	Unit	
Symbol	Parameter	Min 1)	Max 1)	Min ¹⁾	Max 1)	Oille	
t _{w(SCLL)}	SCL clock low time	4.7		1.3		6	
t _{w(SCLH)}	SCL clock high time	4.0		0.6		μs	
t _{su(SDA)}	SDA setup time	250		100			
t _{h(SDA)}	SDA data hold time	0 3)		0 ²⁾	900 ³⁾		
$t_{r(SDA)} \ t_{r(SCL)}$	SDA and SCL rise time		1000	20+0.1C _b	300	ns	
$t_{f(SDA)} \ t_{f(SCL)}$	SDA and SCL fall time		300	20+0.1C _b	300		
t _{h(STA)}	START condition hold time	4.0		0.6		2	
t _{su(STA)}	Repeated START condition setup time	4.7		0.6		μs	
t _{su(STO)}	STOP condition setup time	4.0		0.6		ns	
t _{w(STO:STA)}	STOP to START condition time (bus free)	4.7		1.3		ms	
C _b	Capacitive load for each bus line		400		400	pF	

Figure 94. Typical Application with I²C Bus and Timing Diagram 4)



Notes:

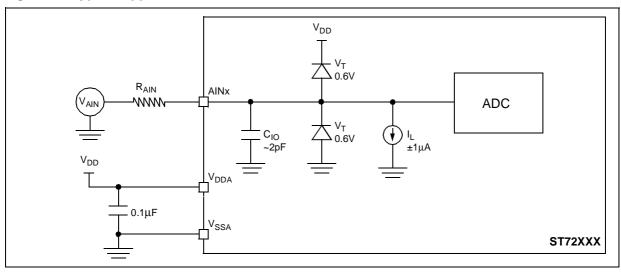
- 1. Data based on standard I²C protocol requirement, not tested in production.
- 2. The device must internally provide a hold time of at least 300ns for the SDA signal in order to bridge the undefined region of the falling edge of SCL.
- 3. The maximum hold time of the START condition has only to be met if the interface does not stretch the low period of SCL signal.
- 4. Measurement points are done at CMOS levels: $0.3xV_{DD}$ and $0.7xV_{DD}$.

14.12 8-BIT ADC CHARACTERISTICS

Subject to general operating conditions for V_{DD} , f_{OSC} , and T_A unless otherwise specified.

Symbol	Parameter	Conditions	Min Typ 1) Max			Unit
f _{ADC}	ADC clock frequency			MHz		
V _{AIN}	Conversion range voltage 2)		V _{SSA}	V		
R _{AIN}	External input resistor				10 ³⁾	kΩ
C _{ADC}	Internal sample and hold capacitor			6		pF
t _{STAB}	Stabilization time after ADC enable		0 4)			
	Conversion time (Sample+Hold)	f _{CPU} =8MHz, f _{ADC} =4MHz	3		μs	
t _{ADC}	- Sample capacitor loading time - Hold conversion time	1 (CPU-5 12, 1ADC-1111112		4 8		1/f _{ADC}

Figure 95. Typical Application with ADC



Notes:

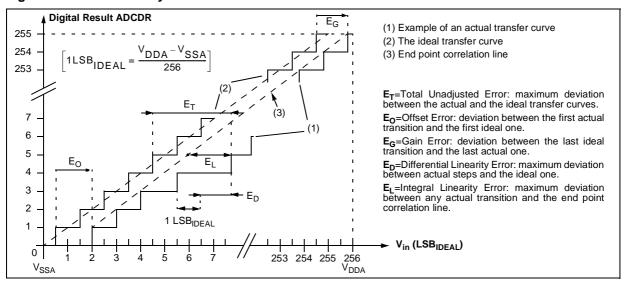
- 1. Unless otherwise specified, typical data are based on $T_A=25^{\circ}C$ and $V_{DD}-V_{SS}=5V$. They are given only as design guidelines and are not tested.
- 2. When V_{DDA} and V_{SSA} pins are not available on the pinout, the ADC refer to V_{DD} and V_{SS} .
- 3. Any added external serial resistor will downgrade the ADC accuracy (especially for resistance greater than $10k\Omega$). Data based on characterization results, not tested in production.
- 4. The stabilization time of the AD converter is masked by the first t_{LOAD} . The first conversion after the enable is then always valid.

8-BIT ADC CHARACTERISTICS (Cont'd)

ADC Accuracy

Symbol	Parameter	V _{DD} =5V f _{CPU} =1N	, ²⁾ ⁄IHz	V _{DD} =5.0 f _{CPU} =8M	V, ³⁾ 1Hz	V _{DD} =3.3 f _{CPU} =8N	BV, ³⁾ MHz	Unit	
		Min	Max	Min	Max	Min	Max		
E _T	Total unadjusted error 1)		2.0		2.0		2.0		
E _O	Offset error 1)		1.5		1.5		1.5		
E _G	Gain Error 1)		1.5		1.5		1.5	LSB	
E _D	Differential linearity error 1)		1.5		1.5		1.5		
E _L	Integral linearity error 1)		1.5		1.5		1.5		

Figure 96. ADC Accuracy Characteristics



Notes:

1. ADC Accuracy vs. Negative Injection Current:

For I_{INJ} =0.8mA, the typical leakage induced inside the die is 1.6 μ A and the effect on the ADC accuracy is a loss of 1 LSB for each 10K Ω increase of the external analog source impedance. This effect on the ADC accuracy has been observed under worst-case conditions for injection:

- negative injection
- injection to an Input with analog capability, adjacent to the enabled Analog Input
- at 5V V_{DD} supply, and worst case temperature.
- 2. Data based on characterization results with $T_A=25$ °C.
- 3. Data based on characterization results over the whole temperature range.

15 PACKAGE CHARACTERISTICS

15.1 PACKAGE MECHANICAL DATA

Figure 97. 32-Pin Shrink Plastic Dual In Line Package

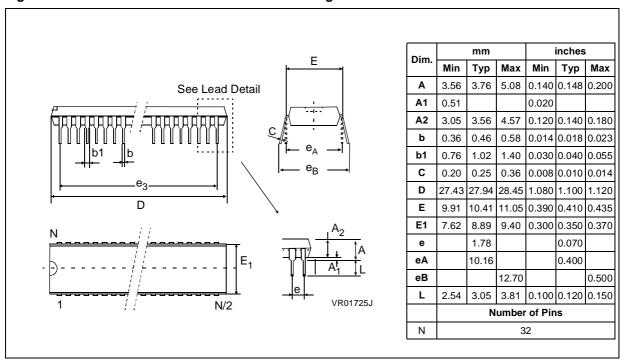
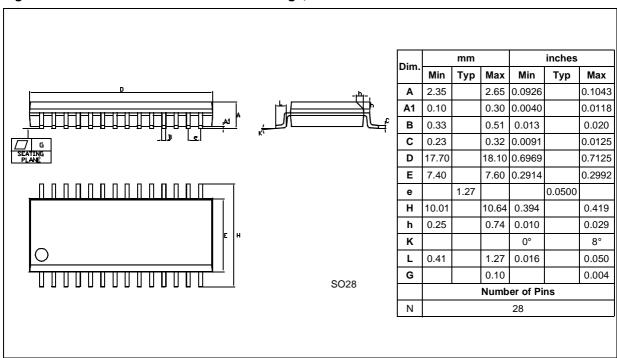


Figure 98. 28-Pin Plastic Small Outline Package, 300-mil Width



15.2 THERMAL CHARACTERISTICS

Symbol	Ratings	Value	Unit
R _{thJA}	Package thermal resistance (junction to ambient) SDIP32 SO28	60 75	°C/W
P _D	Power dissipation 1)	500	mW
T _{Jmax}	Maximum junction temperature ²⁾	150	°C

Notes:

^{1.} The power dissipation is obtained from the formula $P_D = P_{INT} + P_{PORT}$ where P_{INT} is the chip internal power ($I_{DD} \times V_{DD}$) and P_{PORT} is the port power dissipation determined by the user.

^{2.} The average chip-junction temperature can be obtained from the formula $T_J = T_A + P_D x$ RthJA.

15.3 SOLDERING AND GLUEABILITY INFORMATION

Recommended soldering information given only as design guidelines in Figure 99 and Figure 100.

Recommended glue for SMD plastic packages dedicated to molding compound with silicone:

Heraeus: PD945, PD955Loctite: 3615, 3298

Figure 99. Recommended Wave Soldering Profile (with 37% Sn and 63% Pb)

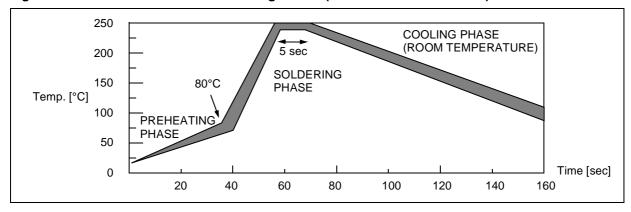
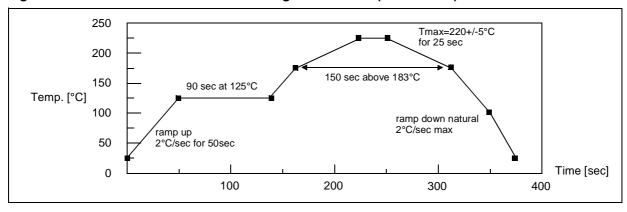


Figure 100. Recommended Reflow Soldering Oven Profile (MID JEDEC)



16 DEVICE CONFIGURATION AND ORDERING INFORMATION

Each device is available for production in user programmable versions (FLASH) as well as in factory coded versions (ROM). FLASH devices are shipped to customers with a default content (FFh), while ROM factory coded parts contain the code supplied by the customer. This implies that FLASH devices have to be configured by the customer using the Option Bytes while the ROM devices are factory-configured.

16.1 OPTION BYTES

The two option bytes allow the hardware configuration of the microcontroller to be selected.

The option bytes have no address in the memory map and can be accessed only in programming mode (for example using a standard ST7 programming tool). The default content of the FLASH is fixed to FFh.

In masked ROM devices, the option bytes are fixed in hardware by the ROM code (see option list).

USER OPTION BYTE 0

Bit 7:2 = **Reserved**, must always be 1.

Bit 1 = **EXTIT** External Interrupt Configuration. This option bit allows the external interrupt mapping to be configured as shown in Table 24.

Table 24. External Interrupt Configuration

External IT0	External IT1	EXTIT
Ports PA7-PA0	Ports PB7-PB0 Ports PC5-PC0	1
Ports PA7-PA0 Ports PC5-PC0	Ports PB7-PB0	0

Bit 0 = FMP Full memory protection.

This option bit enables or disables external access to the internal program memory (read-out protection). Clearing this bit causes the erasing (to 00h) of the whole memory (including the option byte).

0: Program memory not read-out protected

1: Program memory read-out protected

USER OPTION BYTE 1

Bit 7 = CFC Clock filter control on/off

This option bit enables or disables the clock filter (CF) features.

0: Clock filter enabled

1: Clock filter disabled

Bit 6:4 = OSC[2:0] Oscillator selection

These three option bits can be used to select the main oscillator as shown in Table 25.

Bit 3:2 = LVD[1:0] Low voltage detection selection These option bits enable the LVD block with a selected threshold as shown in Table 26.

Bit 1 = **WDG HALT** *Watchdog and halt mode* This option bit determines if a RESET is generated when entering HALT mode while the Watchdog is active.

0: No Reset generation when entering Halt mode

1: Reset generation when entering Halt mode

Bit 0 = **WDG SW** *Hardware or software watchdog* This option bit selects the watchdog type.

0: Hardware (watchdog always enabled)

1: Software (watchdog to be enabled by software)

Table 25. Main Oscillator Configuration

Selected Oscillator	OSC2	OSC1	OSC0
External Clock (Stand-by)	1	1	1
~4 MHz Internal RC	1	1	0
1~14 MHz External RC	1	0	Х
Low Power Resonator (LP)	0	1	1
Medium Power Resonator (MP)	0	1	0
Medium Speed Resonator (MS)	0	0	1
High Speed Resonator (HS)	0	0	0

Table 26. LVD Threshold Configuration

Configuration	LVD1	LVD0
LVD Off	1	1
Highest Voltage Threshold (~4.50V)	1	0
Medium Voltage Threshold (~4.05V)	0	1
Lowest Voltage Threshold (~3.45V)	0	0

		USER OPTION BYTE 0									USE	R OPT	ION BY	/TE 1		
	7							0	7							0
			Rese	erved			EXTIT	FMP	CFC	OSC 2	OSC 1	OSC 0	LVD1	LVD0	WDG HALT	WDG SW
Default Value	1	1	1	1	1	1	1	0	1	1	1	0	1	1	1	1

16.2 DEVICE ORDERING INFORMATION AND TRANSFER OF CUSTOMER CODE

Customer code is made up of the ROM contents and the list of the selected options (if any). The ROM contents are to be sent on diskette, or by electronic means, with the S19 hexadecimal file generated by the development tool. All unused bytes must be set to FFh.

The selected options are communicated to STMicroelectronics using the correctly completed OPTION LIST appended.

The STMicroelectronics Sales Organization will be pleased to provide detailed information on contractual points.

Figure 101. ROM Factory Coded Device Types

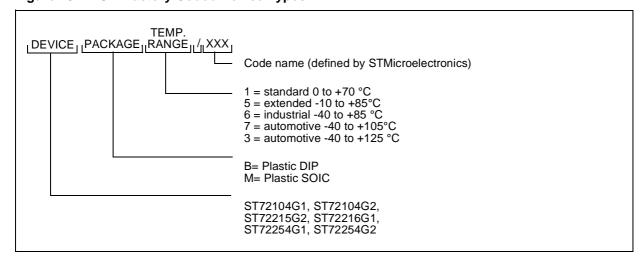
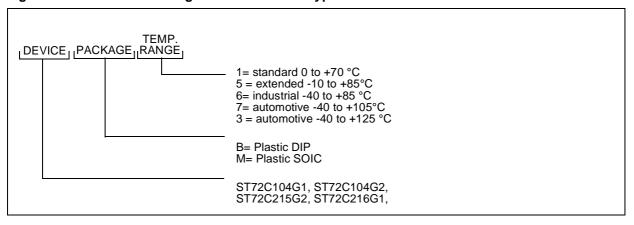


Figure 102. FLASH User Programmable Device Types



TRANSFER OF CUSTOMER CODE (Cont'd)

	[]:	ST72104G1 (4KB) ST72104G2 (8KB)	[] ST72215G2 (4KB)	
Phone No Reference Device: Package: Marking: [] S	[]:	ST72104G1 (4KB) ST72104G2 (8KB)	[] ST72215G2 (4KB)	
Package: Marking: []S	[]:	ST72104G1 (4KB) ST72104G2 (8KB)	[] ST72215G2 (4KB)	
Marking: []S			[] ST72216G1 (8KB)	[] ST72254G1 (4KB) [] ST72254G2 (8KB)
		SO28 SDIP32	[] Tape & Reel	[] Tube
	tandard Markii pecial Marking	SO28 (max. 13 (
		ters are letters, digi	5 Chars.): ts, '.', '-', '/' and spaces or r other marking details if	nly. Please consult your lo-
External Interrup		•	Port A, IT1 interrupt vect Port A & C, IT1 interrupt	
Temperature Rai	•	0°C to + 70°C - 40°C to + 85°C	[]-10°C to +85°C []-40°C to +105°C	[] - 40°C to + 125°C
Clock Source Se	ection: []		[] LP: Low power resona [] MP: Medium power re [] MS: Medium speed re [] HS: High speed reson	esonator (2 to 4 MHz) esonator (4 to 8 MHz)
	[]	RC Network:	[] Internal [] External	ator (6 to 10 mil2)
	[]	External Clock		
Clock Security S	/stem: []	Disabled	[] Enabled	
Watchdog Select Halt when Watch		Software Activation Reset	[] Hardware Activatio [] No reset	n
Readout Protecti	on: []	Disabled	[] Enabled	
LVD Reset	[]	Disabled	[] Med	hest threshold dium threshold vest threshold
Comments:				
Supply Operating	Range in the ap	oplication:		

16.3 DEVELOPMENT TOOLS

STmicroelectronics offers a range of hardware and software development tools for the ST7 microcontroller family. Full details of tools available for the ST7 from third party manufacturers can be obtain from the STMicroelectronics Internet site:

http://mcu.st.com.

Third Party Tools

- ACTUM
- BP
- COSMIC
- CMX
- DATA I/O
- HITEX
- HIWARE
- ISYSTEM
- KANDA
- LEAP

Tools from these manufacturers include C compliers, emulators and gang programmers.

STMicroelectronics Tools

Three types of development tool are offered by ST, all of them connect to a PC via a parallel (LPT) port: see Table 27 and Table 28 for more details.

Table 27. STMicroelectronics Tool Features

	In-Circuit Emulation	Programming Capability ¹⁾	Software Included	
ST7 Development Kit	Yes. (Same features as HDS2 emulator but without logic analyzer)	Yes (DIP packages only)	ST7 CD ROM with: - ST7 Assembly toolchain - STVD7 and WGDB7 powerful	
ST7 HDS2 Emulator	Yes, powerful emulation features including trace/ logic analyzer	No	Source Level Debugger for Win 3.1, Win 95 and NT — C compiler demo versions	
ST7 Programming Board	No	Yes (All packages)	 ST Realizer for Win 3.1 and W 95. Windows Programming Tools for Win 3.1, Win 95 and NT 	

Table 28. Dedicated STMicroelectronics Development Tools

Supported Products	ST7 Development Kit	ST7 HDS2 Emulator	ST7 Programming Board
ST72254G1, ST72C254G1 ST72254G2, ST72C254G2 ST72215G2, ST72C215G2 ST72216G1, ST72C216G1 ST72104G1, ST72C104G1, ST72104G2, ST72C104G2	ST7MDT1-DVP2	ST7MDT1-EMU2B	ST7MDT1-EPB2/EU ST7MDT1-EPB2/US ST7MDT1-EPB2/UK

Note

1. In-Situ Programming (ISP) interface for FLASH devices.

DEVELOPMENT TOOLS (Cont'd)

16.3.1 PACKAGE/SOCKET FOOTPRINT PROPOSAL

Table 29. Suggested List of SDIP32 Socket Types

Package / Probe		Adaptor / Socket Reference	Same Footprint	Socket Type
SDIP32 EMU PROBE	TEXTOOL	232-1291-00	Х	Textool

Table 30. Suggested List of SO28 Socket Types

Package / Probe	Adaptor / Socket Reference		Same Footprint	Socket Type
SO28	ENPLAS	OTS-28-1.27-04		Open Top
	YAMAICHI	IC51-0282-334-1		Clamshell
EMU PROBE	Adapter from SO28 to	SDIP32 footprint (delivered with emulator)	Х	SMD to SDIP

16.4 ST7 APPLICATION NOTES

PROGRAMMING AND TOOLS AN985 EXECUTING CODE IN ST7 RAM AN986 USING THE ST7 INDIRECT ADDRESSING MODE AN987 ST7 IN-CIRCUIT PROGRAMMING AN988 STARTING WITH ST7 ASSEMBLY TOOL CHAIN AN989 STARTING WITH ST7 ASSEMBLY TOOL CHAIN AN989 STARTING WITH ST7 ASSEMBLY TOOL CHAIN AN989 STARTING WITH ST7 HIWARE C AN1039 ST7 MATH UTILITY ROUTINES AN1064 WRITING OPTIMIZED HIWARE C LANGUAGE FOR ST7 AN1106 TRANSLATING ASSEMBLY CODE FROM HOS TO ST7 EXAMPLE DRIVERS AN969 ST7 SCI COMMUNICATION BETWEEN THE ST7 AND A PC AN970 ST7 SPI COMMUNICATION BETWEEN THE ST7 AND A PC AN970 ST7 SPI COMMUNICATION BETWEEN THE ST7 AND E PROM AN971 ST7 FC COMMUNICATION BETWEEN THE ST7 AND E PROM AN972 ST7 SOFTWARE SPI MASTER COMMUNICATION WITH A PC USING ST72251 16-BIT TIMER AN974 REAL TIME CLOCK WITH THE ST7 TIMER OUTPUT COMPARE AN976 DRIVING A BUZZER USING THE ST7 PWM FUNCTION AN979 DRIVING AN ANALOG KEYBOARD WITH THE ST7 ADC AN980 ST7 KEYPAD DECODING TECHNIQUES, IMPLEMENTING WAKE-UP ON KEYSTROKE AN1017 USING THE ST7 USB MICROCONTROLLER AN1041 USING ST7 PWM SIGNAL TO GENERATE ANALOG OUTPUT (SINUSOID) AN1042 ST7 ROUTINE FOR ITE SLAVE MODE MANAGEMENT FOR ST7 MCUS AN1043 ST7 SOFTWARE FOR SLAVE MODE MANAGEMENT AN1044 MULTIPLE INTERRUPT SOURCES MANAGEMENT FOR ST7 MCUS AN1045 ST7 SOFTWARE IMPLEMENTATION OF PIC BUS MASTER AN1046 ST7 UART EMULATION SOFTWARE AN1047 MANAGING RECEPTION ERRORS WITH THE ST7 SCI PERIPHERAL AN1048 ST7 SOFTWARE IMPLEMENTATION OF PIC BUS MASTER AN1049 ST7 THE PROTE PROTEON OF PIC BUS MASTER AN1040 ST7 SOFTWARE IMPLEMENTATION OF PIC BUS MASTER AN1041 MULTIPLE INTERRUPT SOURCES MANAGEMENT FOR ST7 MCUS AN1043 ST7 SOFTWARE IMPLEMENTATION OF PIC BUS MASTER AN1044 MULTIPLE INTERRUPT SOURCES MANAGEMENT FOR ST7 MCUS AN1045 ST7 SOFTWARE IMPLEMENTATION OF PIC BUS MASTER AN1046 ST7 UART EMULATION SOFTWARE AN1047 MANAGING RECEPTION ERRORS WITH THE ST7 SCI PERIPHERAL AN1048 ST7 SOFTWARE LOD DRIVER AN1049 PWM MANAGEMENT FOR BLDC MOTOR DRIVES USING THE ST72141 AN1148 USING THE ST7263 KIT TO IMPLEMENT A USB GAME PAD AN1180 USING THE ST7263 FOR DESIG	IDENTIFICATION	DESCRIPTION
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AN1150 BENCHMARK ST72 VS PC16	AN990	
	AN1086	ST7 / ST10U435 CAN-do SOLUTIONS FOR CAR MULTIPLEXING
AN1151 PERFORMANCE COMPARISON BETWEEN ST72254 & PC16F8		
	AN1151	PERFORMANCE COMPARISON BETWEEN ST72254 & PC16F8

16.5 TO GET MORE INFORMATION

To get the latest information on this product please use the ST web server: http://mcu.st.com/

17 SUMMARY OF CHANGES

Description of the changes between the current release of the specification and the previous one.

Re	Main changes	Date
2	Added one temperature range (-10°C to +85°C)	Nov-00

Mataa.	
Notes:	

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